







MCT8315A

ZHCSPQ7A - DECEMBER 2022 - REVISED APRIL 2023

MCT8315A 高速无传感器梯形控制集成 FET BLDC 驱动器

1 特性

- 采用集成无传感器电机控制算法的三相 BLDC 电机 驱动器
 - 无代码高速梯形控制
 - 支持高达 3kHz (电气频率)
 - 非常短的启动时间 (< 50ms)
 - 快速减速 (< 150ms)
 - 支持 120° 或 150° 调制,以改善声学性能
 - 通过正向重新同步和反向驱动支持风力机
 - 模拟,PWM,频率或基于 I²C 的速度输入
 - 主动消磁支持减少功率损耗
 - 可配置的电机启动和停止选项
 - 闭合速度/电源环路选项
 - 抗电压浪涌 (AVS) 保护可防止电机减速期间出现 直流总线电压尖峰
- 4.5V 至 35V 工作电压 (绝对最大值 40V)
- 高输出电流能力:4A 峰值
- 低 MOSFET 导通状态电阻
 - T_A = 25°C 时的 R_{DS(ON)} (HS + LS): 240mΩ(典型值)
- 低功耗睡眠模式
 - V_{VM} = 24V、T_A = 25°C 时为 5µA(最大值)
- 速度环路精度:3% 使用内部时钟,1% 使用外部时
- 用于存储器件配置的客户可配置非易失性存储器 (EEPROM)
- 支持高达 100kHz 的 PWM 频率,以支持低电感电
- 不需要外部电流检测电阻;使用内置电流检测功能
- 内置 3.3V, 20mA LDO 稳压器
- 内置 3.3V/5V、170mA 降压稳压器
- 专用 DRVOFF 引脚以禁用(高阻态)输出
- 展频和压摆率,用于降低 EMI
- 整套集成保护特性
 - 电源欠压锁定 (UVLO)
 - 电源过压保护 (**OVP**)
 - 电机锁定检测(5种不同类型)
 - 过流保护 (OCP)
 - 热警告和热关断 (OTW/TSD)
 - 故障条件指示引脚 (nFAULT)
 - 可选择通过 I²C 接口进行故障诊断

2 应用

- 无刷直流 (BLDC) 电机模块
- 机器人真空吸水电机
- 电机周期燃油泵
- 电器风扇和泵
- 汽车风扇和风机

• CPAP 呼吸机

3 说明

MCT8315A 为需要高速运行(高达 3kHz 电气)或极 快启动速度(<50ms)的客户提供了一个单芯片无代 码无传感器梯形解决方案,此解决方案适用于需要高达 4A 峰值电流的 12V 至 24V 无刷直流电机。 MCT8315A 集成了三个 ½ 桥, 具有 40V 的绝对最大 电压和 240m Ω 的低 $R_{DS(ON)}$ (高边 + 低边 FET)。 MCT8315A 集成了电源管理电路,包括可用于为外部 电路供电的电压可调节降压稳压器 (3.3V/5V, 170mA)和LDO(3.3V,20mA)。

无传感器梯形控制可通过非易失性 EEPROM 中的寄存 器设置实现高度可配置 (电机启动/停止行为、故障处 理、闭环操作),从而允许器件在配置完毕后独立运 行。MCT8315A 器件通过 PWM 信号、模拟电压、可 变频率方波或 I²C 指令接收速度命令。MCT8315A 集 成多种保护特性,旨在出现故障事件时保护该器件、电 机和系统。

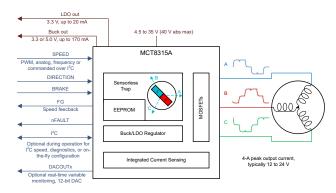
器件信息(1)

器件型号	封装	封装尺寸(标称值)
MCT8315A1V	VQFN (40)	7.00mm x 5.00mm

(1) 如需了解所有可用封装,请参阅数据表末尾的可订购产品附 录。

参考文档:

- 参考 MCT8315A 调优指南
- 请参阅 MCT8315A EVM GUI



简化原理图



Table of Contents

1 特性	1	7.6 EEPROM access and I ² C interface	73
2 应用		7.7 EEPROM (Non-Volatile) Register Map	79
, 3 说明		7.8 RAM (Volatile) Register Map	130
4 Revision History		8 Application and Implementation	147
5 Pin Configuration and Functions		8.1 Application Information	147
6 Specifications		8.2 Typical Applications	147
6.1 Absolute Maximum Ratings		9 Power Supply Recommendations	155
6.2 ESD Ratings		9.1 Bulk Capacitance	155
6.3 Recommended Operating Conditions		10 Layout	156
6.4 Thermal Information.		10.1 Layout Guidelines	
6.5 Electrical Characteristics		10.2 Layout Example	157
6.6 Characteristics of the SDA and SCL bus for		10.3 Thermal Considerations	158
Standard and Fast mode	12	11 Device and Documentation Support	1 <mark>5</mark> 9
6.7 Typical Characteristics		11.1 支持资源	159
7 Detailed Description		11.2 Trademarks	159
7.1 Overview		11.3 静电放电警告	159
7.2 Functional Block Diagram		11.4 术语表	159
7.3 Feature Description		12 Mechanical, Packaging, and Orderable	
7.4 Device Functional Modes		Information	159
7.5 External Interface		12.1 Tape and Reel Information	
		•	

4 Revision History

CI	changes from Revision * (December 2022) to Revision A (April 2023)	Page
•	Updated I ² C Data Word section to clarify default I ² C Target ID	7
	Updated CRC Byte Calculation section with CRC initial value	

Product Folder Links: MCT8315A

5 Pin Configuration and Functions

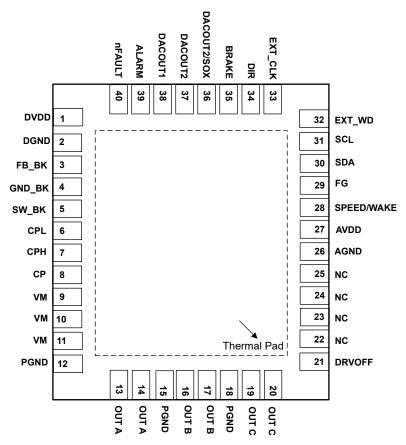


图 5-1. MCT8315A, 40-Pin VQFN With Exposed Thermal Pad, Top View

表 5-1. Pin Functions

PIN	40-pin Package	TYPE ⁽¹⁾	DESCRIPTION
NAME	MCT8315A		
AGND	26	GND	Device analog ground. Refer Layout Guidelines for connection recommendation.
ALARM	39	0	Alarm signal : push-pull output. Pulled logic high during fault condition, if enabled. If ALARM pin is not used, leave it floating.
AVDD	27	PWR O	3.3-V internal regulator output. Connect a X5R or X7R, 1-µF, 6.3-V ceramic capacitor between the AVDD and AGND pins. This regulator can source up to 20 mA for external circuits.
BRAKE	35	I	High → brake the motor Low → normal operation If BRAKE pin is not used, connect to AGND directly. If BRAKE pin is used to brake the motor, use an external 100-kΩ pull-down resistor (to AGND).
СР	8	PWR	Charge pump output. Connect a X5R or X7R, 1-µF, 16-V ceramic capacitor between the CP and VM pins.
СРН	7	PWR	Charge pump switching node. Connect a X5R or X7R, 47-nF, ceramic capacitor between the
CPL	6	PWR	CPH and CPL pins. TI recommends a capacitor voltage rating at least twice the normal operating voltage of the device.
DACOUT1	38	0	DAC output DACOUT1
DACOUT2	37	0	DAC output DACOUT2



表 5-1. Pin Functions (continued)

PIN	40-pin Package	TYPE ⁽¹⁾	DESCRIPTION		
NAME	MCT8315A				
DACOUT2/S OX	36	0	Multi-purpose pin: DAC output when configured as DACOUT2 CSA output when configured as SOX		
DGND	2	GND	Device digital ground. Refer Layout Guidelines for connection recommendation.		
DIR	34	I	Direction of motor spinning; When low, phase driving sequence is OUT A \rightarrow OUT B \rightarrow OUT C When high, phase driving sequence is OUT A \rightarrow OUT C \rightarrow OUT B If DIR pin is not used, connect to AGND or AVDD directly (depending on phase driving sequence needed). If DIR pin is used for changing motor spin direction, use an external 100-k Ω pull-down resistor (to AGND).		
DRVOFF	21	I	Coast (Hi-Z) all six MOSFETs.		
DVDD	1	PWR	1.5-V internal regulator output. Connect a X5R or X7R, 2.2-µF, 6.3-V ceramic capacitor between the DVDD and DGND pins.		
EXT_CLK	33	1	External clock reference input in external clock reference mode.		
EXT_WD	32	I	External watchdog input.		
FB_BK	3	PWR I/O	Feedback for buck regulator. Connect to buck regulator output after the inductor/resistor.		
FG	29	0	Motor speed indicator : open-drain output; requires an external pull-up resistor to 1.8-V to 5.0-V.		
GND_BK	4	GND	Buck regulator ground. Refer Layout Guidelines for connection recommendation.		
NC	22, 23, 24, 25	-	No connection. Leave these pins floating.		
nFAULT	40	0	Fault indicator: open drain output. Pulled logic low during fault condition; requires an external pull-up resistor to 1.8-V to 5.0-V.		
OUTA	13, 14	PWR O	Half-bridge output A		
OUTB	16, 17	PWR O	Half-bridge output B		
OUTC	19, 20	PWR O	Half-bridge output C		
PGND	12, 15, 18	GND	Device power ground. Refer Layout Guidelines for connection recommendation.		
SCL	31	I	I ² C clock input		
SDA	30	I/O	I ² C data line		
SPEED/ WAKE	28	I	Device speed input; supports analog, frequency or PWM signals. The speed pin input can be configured through SPD_CTRL_MODE.		
SW_BK	5	PWR	Buck switch node. Connect this pin to an inductor or resistor.		
VM	9, 10, 11	PWR I	Device and motor power supply. Connect to motor supply voltage; bypass to PGND with a 0.1-µF capacitor plus one bulk capacitor. TI recommends a capacitor voltage rating at least twice the normal operating voltage of the device.		
Thermal pad		GND	Connect to AGND		

⁽¹⁾ I = input, O = output, GND = ground, PWR = power, NC = no connect

6 Specifications

6.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)(1)

	MIN	MAX	UNIT
Power supply pin voltage (VM)	- 0.3	40	V
Voltage difference between ground pins (GND_BK, DGND, PGND, AGND)	- 0.3	0.3	V
Charge pump voltage (CPH, CP)	- 0.3	V _{VM} + 6	V
Charge pump negative switching pin voltage (CPL)	- 0.3	V _{VM} +0.3	V
Switching node pin voltage (SW_BK)	- 0.3	V _{VM} +0.3	V
Analog regulators pin voltage (AVDD)	- 0.3	4	V
Analog regulators pin voltage (DVDD)	- 0.3	1.7	V
Logic pin input voltage (BRAKE, DRVOFF, DIR, EXT_CLK, EXT_WD, SCL, SDA, SPEED)	- 0.3	6	V
Open drain pin output voltage (nFAULT, FG)	- 0.3	6	V
Output pin voltage (OUTA, OUTB, OUTC)	- 1	V _{VM} + 1	V
Ambient temperature, T _A	- 40	125	°C
Junction temperature, T _J	- 40	150	°C
Storage tempertaure, T _{stg}	- 65	150	°C

⁽¹⁾ Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime

6.2 ESD Ratings

				VALUE	UNIT
	1	Electrostatic	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2000	V
'	V(ESD)	discharge	Charged device model (CDM), per JEDEC specification JS-002 ⁽²⁾	±750	V

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating ambient temperature range (unless otherwise noted)

			MIN	NOM	MAX	UNIT
V_{VM}	Power supply voltage	V_{VM}	4.5	24	35	V
I _{OUT} (1)	Peak output winding current	OUTA, OUTB, OUTC			4	Α
V _{IN_LOGIC}	Logic input voltage	BRAKE, DRVOFF, DIR, EXT_CLK, EXT_WD, SPEED, SDA, SCL	- 0.1		5.5	V
V _{OD}	Open drain pullup voltage	nFAULT, FG	- 0.1		5.5	V
I _{OD}	Open drain output current capability	nFAULT, FG			5	mA
T _A	Operating ambient temperature		- 40		125	°C
TJ	Operating junction temperature		- 40		150	°C

(1) Power dissipation and thermal limits must be observed

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.4 Thermal Information

		MCT8315A	
	THERMAL METRIC ⁽¹⁾	RGF (VQFN)	UNIT
		40 Pins	
R _{0 JA}	Junction-to-ambient thermal resistance	28	°C/W
R _{θ JC(top)}	Junction-to-case (top) thermal resistance	16.7	°C/W
R _{θ JB}	Junction-to-board thermal resistance	8.9	°C/W
Ψлт	Junction-to-top characterization parameter	1.8	°C/W
ΨЈВ	Junction-to-board characterization parameter	8.9	°C/W
R _{θ JC(bot)}	Junction-to-case (bottom) thermal resistance	3.5	°C/W

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Electrical Characteristics

 T_J = -40° C to +150°C, V_{VM} = 4.5 to 35 V (unless otherwise noted). Typical limits apply for T_A = 25°C, V_{VM} = 24 V

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER	SUPPLIES				-	
	VM close mode current	V _{VM} > 6 V, V _{SPEED} = 0, T _A = 25 °C		3	5	μA
I_{VMQ}	VM sleep mode current	V _{SPEED} = 0, T _A = 125 °C		3.5	7	μA
I _{VMS}		$V_{VM} \geqslant$ 12 V, Standby Mode, DRVOFF = High, T_A = 25 °C, L_{BK} = 47 uH, C_{BK} = 22 μF		8	16	mA
	VM standby mode current	V_{VM} > 6 V, Standby Mode, DRVOFF = High, T_A = 25 °C, R_{BK} = 22 Ω , C_{BK} = 22 μ F		25	29	mA
		$V_{VM} \geqslant$ 12 V, Standby Mode, DRVOFF = High, L_{BK} = 47 uH, C_{BK} = 22 μF		8	16.5	mA
		V_{VM} > 6 V, Standby Mode, DRVOFF = High, R_{BK} = 22 Ω , C_{BK} = 22 μ F		25	29	mA
	VM operating mode current	V_{VM} > 6 V, V_{SPEED} > V_{EX_SL} , PWM_FREQ_OUT = 10000b (25 kHz), T_A = 25 °C, L_{BK} = 47 uH, C_{BK} = 22 μF, No Motor Connected		11	18	mA
ı		V_{VM} > 6 V, V_{SPEED} > V_{EX_SL} , PWM_FREQ_OUT = 10000b (25 kHz), T_A = 25 °C, R_{BK} = 22 Ω , C_{BK} = 22 μ F, No Motor Connected		27	30.5	mA
I _{VM}		$\begin{aligned} &V_{VM} > 6 \text{ V, } V_{SPEED} > V_{EX_SL}, \\ &PWM_FREQ_OUT = 10000b \text{ (25 kHz),} \\ &L_{BK} = 47 \text{ uH, } C_{BK} = 22 \mu\text{F, No Motor} \\ &Connected \end{aligned}$		11	17	mA
		V_{VM} > 6 V, V_{SPEED} > V_{EX_SL} , PWM_FREQ_OUT = 10000b (25 kHz), R_{BK} = 22 Ω , C_{BK} = 22 μ F, No Motor Connected		28	30.5	mA
V _{AVDD}	Analog regulator voltage	$0~\text{mA} \leqslant I_{\text{AVDD}} \leqslant 20~\text{mA}$	3.125	3.3	3.465	V
I _{AVDD}	External analog regulator load				20	mA
V_{DVDD}	Digital regulator voltage		1.4	1.55	1.65	V
V _{VCP}	Charge pump regulator voltage	VCP with respect to VM	4.0	4.7	5.5	V

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

	PARAMETER	less otherwise noted). Typical limits apply for TEST CONDITIONS	MIN	TYP	MAX	UNIT
BUCK RE	GULATOR	-				
		V_{VM} > 6 V, 0 mA \leqslant I_{BK} \leqslant 170 mA, BUCK_SEL = 00b	3.1	3.3	3.5	V
		V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 170 mA, BUCK_SEL = 01b	4.6	5.0	5.4	V
V_{BK}	Buck regulator average voltage (L_{BK} = 47 μ H, C_{BK} = 22 μ F)	V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 170 mA, BUCK_SEL = 10b	3.7	4.0	4.3	V
		V_{VM} > 6.7 V, 0 mA \leqslant I_{BK} \leqslant 170 mA, BUCK_SEL = 11b	5.2	5.7	6.2	V
		V_{VM} < 6.0 V (BUCK_SEL = 00b, 01b, 10b, 11b), 0 mA \leq I _{BK} \leq 170 mA	I _E	V _{VM} - sk*(R _{LBK} +2) ¹		V
		V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 20 mA, BUCK_SEL = 00b	3.1	3.3	3.5	V
		V_{VM} > 6 V, 0 mA \leq I _{BK} \leq 20 mA, BUCK_SEL = 01b	4.6	5.0	5.4	V
V_{BK}	Buck regulator average voltage (L_{BK} = 22 μH , C_{BK} = 22 μF)	V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 20 mA, BUCK_SEL = 10b	3.7	4.0	4.3	V
		V_{VM} > 6.7 V, 0 mA \leqslant I _{BK} \leqslant 20 mA, BUCK_SEL = 11b	5.2	5.7	6.2	V
		V_{VM} < 6.0 V (BUCK_SEL = 00b, 01b, 10b, 11b), 0 mA \leq I _{BK} \leq 20 mA	I _E	V _{VM} - s _K *(R _{LBK} +2) ¹		V
		V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 10 mA, BUCK_SEL = 00b	3.1	3.3	3.5	V
	Buck regulator average voltage (R_{BK} = 22 Ω , C_{BK} = 22 μF)	V_{VM} > 6 V, 0 mA \leq I _{BK} \leq 10 mA, BUCK_SEL = 01b	4.6	5.0	5.4	V
V_{BK}		V_{VM} > 6 V, 0 mA \leq I_{BK} \leq 10 mA, BUCK_SEL = 10b	3.7	4.0	4.3	V
		V_{VM} > 6.7 V, 0 mA \leq I _{BK} \leq 10 mA, BUCK_SEL = 11b	5.2	5.7	6.2	V
		V_{VM} < 6.0 V (BUCK_SEL = 00b, 01b, 10b, 11b), 0 mA \leq I_{BK} \leq 10 mA	-	V _{VM} - _{BK} *(R _{BK} +2)		V
		V_{VM} > 6 V, 0 mA \leq I _{BK} \leq 170 mA, Buck regulator with inductor, L _{BK} = 47 uH, C _{BK} = 22 μ F	- 100		100	mV
V_{BK_RIP}		V_{VM} > 6 V, 0 mA \leq I _{BK} \leq 20 mA, Buck regulator with inductor, L _{BK} = 22 uH, C _{BK} = 22 µF	- 100		100	mV
		V_{VM} > 6 V, 0 mA \leq I _{BK} \leq 10 mA, Buck regulator with resistor; R _{BK} = 22 Ω , C _{BK} = 22 μ F	- 100		100	mV



	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		L _{BK} = 47 uH, C _{BK} = 22 μF, BUCK_PS_DIS = 1b			170	mA
		L _{BK} = 47 uH, C _{BK} = 22 μF, BUCK_PS_DIS = 0b			170 - I _{AVDD}	mA
1	External buck regulator load	L _{BK} = 22 uH, C _{BK} = 22 μF, BUCK_PS_DIS = 1b			20	mA
f _{SW_BK} E V _{BK_UV} E V _{BK_UV} E I _{BK_CL} E I _{BK_CCP} E t _{BK_RETRY} C DRIVER OUTF	External buck regulator load	L _{BK} = 22 uH, C _{BK} = 22 μF, BUCK_PS_DIS = 0b			20 - I _{AVDD}	mA
		R_{BK} = 22 Ω , C_{BK} = 22 μ F, BUCK_PS_DIS = 1b			10	mA
		R_{BK} = 22 Ω , C_{BK} = 22 μ F, BUCK_PS_DIS = 0b			10 - I _{AVDD}	mA
	Duelt as audates auditables for automate	Regulation Mode	20		535	kHz
SW_BK	Buck regulator switching frequency	Linear Mode	20		535	kHz
		V _{BK} rising, BUCK_SEL = 00b	2.7	2.8	2.95	V
		V _{BK} falling, BUCK_SEL = 00b	2.5	2.6	2.7	V
		V _{BK} rising, BUCK_SEL = 01b	4.3	4.4	4.55	V
.,	Buck regulator undervoltage lockout	V _{BK} falling, BUCK_SEL = 01b	4.1	4.2	4.36	V
VBK_UV		V _{BK} rising, BUCK_SEL = 10b	2.7	2.8	2.95	V
		V _{BK} falling, BUCK_SEL = 10b	2.5	2.6	2.7	V
		V _{BK} rising, BUCK_SEL = 11b	4.3	4.4	4.55	V
		V _{BK} falling, BUCK_SEL = 11b	4.1	4.2	4.36	V
	Buck regulator undervoltage lockout hysteresis	Rising to falling threshold, BUCK_SEL = 00b	90	200	400	mV
. /		Rising to falling threshold, BUCK_SEL = 01b	90	200	400	mV
VBK_UV_HYS		Rising to falling threshold, BUCK_SEL = 10b	90	200	400	mV
		Rising to falling threshold, BUCK_SEL =11b	90	200	400	mV
	Buck regulator current limit threshold	BUCK_CL = 0b	360	600	910	mA
BK_CL		BUCK_CL = 1b	80	150	250	mA
I _{BK_OCP}	Buck regulator over current protection trip point		2	3	4	Α
t _{BK_RETRY}	Over current protection retry time		0.7	1	1.3	ms
DRIVER OU	ITPUTS					
		V _{VM} > 6 V, I _{OUT} = 1 A, T _A = 25°C		240	260	mΩ
D	Total MOSFET on resistance (High-side	V _{VM} < 6 V, I _{OUT} = 1 A, T _A = 25°C		250	270	mΩ
KDS(ON)	+ Low-side)	V _{VM} > 6 V, I _{OUT} = 1 A, T _J = 150 °C		360	400	mΩ
		V _{VM} < 6 V, I _{OUT} = 1 A, T _J = 150 °C		370	415	mΩ
		V _{VM} = 24 V, SLEW_RATE = 00b	13	25	45	V/µs
25	Phase pin slew rate switching low to high	V _{VM} = 24 V, SLEW_RATE = 01b	30	50	80	V/µs
SK	$R_{BK} = 22 \ \Omega, C_{BK} = 22 \ \mu F, BUCK_PS_DIS = 0b$ $Regulation Mode Linear Mode$ $V_{BK} \text{ rising, BUCK_SEL} = 00b$ $V_{BK} \text{ falling, BUCK_SEL} = 00b$ $V_{BK} \text{ falling, BUCK_SEL} = 01b$ $V_{BK} \text{ falling, BUCK_SEL} = 01b$ $V_{BK} \text{ falling, BUCK_SEL} = 10b$ $V_{BK} \text{ falling, BUCK_SEL} = 11b$ $V_{BK} \text{ falling, BUCK_SEL} = 10b$ $V_{BK} \text{ falling, BUCK_SEL} = 10b$ $V_{BK} \text{ falling, BUCK_SEL} = 11b$ $V_{BK} \text{ falling threshold, BUC}$ $01b$ $Rising to falling threshold, BUC}$ $10b$ $Rising to falling threshold, BUC}$ $10b$ $Rising to falling threshold, BUC}$ $10b$ $Rising to falling threshold, BUC}$	V _{VM} = 24 V, SLEW_RATE = 10b	80	125	185	V/µs
		V _{VM} = 24 V, SLEW_RATE = 11b	130	200	280	V/µs
»K		1				
		V _{VM} = 24 V, SLEW_RATE = 00b	14	25	45	V/µs
fsw_bk Vbk_uv Vbk_uv_hys Ibk_cl Ibk_ocp tbk_retry DRIVER OUT	Phase pin slew rate switching high to low		30	25 50	45 80	V/µs V/µs
	Phase pin slew rate switching high to low (Falling from 80 % to 20 %)					

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		V _{VM} = 24 V, SR = 25 V/μs		1800	3000	ns
	Output dead time (high to low / low to	V _{VM} = 24 V, SR = 50 V/μs		1100	1400	ns
DEAD	high)	V _{VM} = 24 V, SR = 125 V/μs		650	850	ns
		V _{VM} = 24 V, SR = 200 V/μs		500	550	ns
SPEED INP	UT - PWM MODE				I	
f PWM	PWM input frequency		0.01		100	kHz
		f _{PWM} = 0.01 to 0.35 kHz	11	12	13	bits
		f _{PWM} = 0.35 to 2 kHz	11	13	14	bits
		f _{PWM} = 2 to 3.5 kHz	11	11.5	12	bits
		f _{PWM} = 3.5 to 7 kHz	12 13 13.5	bits		
Res _{PWM}	PWM input resolution	f _{PWM} = 7 to 14 kHz	11	12	12.5	bits
		f _{PWM} = 14 to 29.2 kHz	10	11.5	12	bits
		f _{PWM} = 29.3 to 60 kHz	9	10.5	11	bits
		f _{PWM} = 60 to 100 kHz	8	9	10	bits
SPEED INP	│ UT - ANALOG MODE					
/ _{ANA_FS}	Analog full-speed voltage		2.95	3	3.05	V
V _{ANA_RES}	Analog voltage resolution			732		μ V
	UT - FREQUENCY MODE					
_	PWM input frequency range	Duty cycle = 50%	3		32767	Hz
FPWM_FREQ		Duty Cycle - 30 %			32707	1 12
SLEEF WIOL	J	SPD CTRL MODE = 00b (analog				
V _{EN_SL}	Analog voltage to enter sleep mode	mode)			40	mV
V _{EX_SL}	Analog voltage to exit sleep mode	SPD_CTRL_MODE = 00b (analog mode)	2.2			V
DET_ANA	Time needed to detect wake up signal on SPEED pin	SPD_CTRL_MODE = 00b (analog mode) V _{SPEED} > V _{EX_SL}	0.5	1	1.5	μs
WAKE	Wakeup time from sleep mode	V _{SPEED} > V _{EX_SL} to DVDD voltage available, SPD_CTRL_MODE = 00b (analog mode)		3	5	ms
EX_SL_DR_A	Time taken to drive motor after exiting from sleep state	SPD_CTRL_MODE = 00b (analog mode) V _{SPEED} > V _{EX_SL} , ISD detection disabled			30	ms
DET_PWM	Time needed to detect wake up signal on SPEED pin	SPD_CTRL_MODE = 01b (PWM mode), V _{SPEED} > V _{IH}	0.5	1	1.5	μS
WAKE_PWM	Wakeup time from sleep mode	V _{SPEED} > V _{IH} to DVDD voltage available, SPD_CTRL_MODE = 01b (PWM mode) or 11b (Frequency mode)		3	5	ms
EX_SL_DR_P	Time taken to drive motor after wakeup from sleep state	SPD_CTRL_MODE = 01b (PWM mode) V _{SPEED} > V _{IH} , ISD detection disabled			30	ms
		SPD_CTRL_MODE = 00b (analog mode) V _{SPEED} < V _{EN_SL} , SLEEP_TIME = 00b or 01b	0.5	1	2	ms
DET_SL_ANA	Time needed to detect sleep command, analog mode	eded to detect sleep command, SPD_CTRL_MODE = 00b (analog mode) Veneza < Veneza SI FEP_TIME = 14 20	26	ms		
		SPD_CTRL_MODE = 00b (analog mode) V _{SPEED} < V _{EN_SL} , SLEEP_TIME = 11b	140	200	260	ms



	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
		SPD_CTRL_MODE = 01b (PWM mode) or 11b (Frequency mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 00b	0.035	0.05	0.065	ms
t	Time needed to detect sleep command,	SPD_CTRL_MODE = 01b (PWM mode) or 11b (Frequency mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 01b	0.14	0.2	0.26	ms
t _{DET_SL_PWM}	PWM or frequency mode	SPD_CTRL_MODE = 01b (PWM mode) or 11b (Frequency mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 10b	14	20	26	ms
	0	SPD_CTRL_MODE = 01b (PWM mode) or 11b (Frequency mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 11b	140	200	260	ms
t _{EN_SL}	Time needed to stop driving motor after detecting sleep command	$V_{SPEED} < V_{EN_SL}$ (analog mode) or $V_{SPEED} < V_{IL}$ (PWM mode) (and SPEED_CTRL = 0 (I ² C mode))		1	2	ms
STANDBY M	IODE					
t _{EX_SB_DR_} A NA	Time taken to drive motor after exiting standby mode, analog mode	SPD_CTRL_MODE = 00b (analog mode), V _{SPEED} > V _{EX_SB} , ISD detection disabled			6	ms
t _{EX_SB_DR_P} WM	Time taken to drive motor after exiting standby mode, PWM mode	SPD_CTRL_MODE = 01b (PWM mode) V _{SPEED} > V _{IH} , ISD detection disabled			6	ms
t _{DET_SB_ANA}	Time needed to detect standby mode, analog mode	SPD_CTRL_MODE = 00b (analog mode), V _{SPEED} < V _{EN_SB}	0.5	1	2	ms
		SPD_CTRL_MODE = 01b (PWM mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 00b	0.035	0.05	0.065	ms
•	Time needed to detect standby	SPD_CTRL_MODE = 01b (PWM mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 01b	0.14	0.035 0.05 0.065 0.14 0.2 0.26 14 20 26	0.26	ms
t _{DET_} SB_PWM	command, PWM/ mode	SPD_CTRL_MODE = 01b (PWM mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 10b	14		ms	
		SPD_CTRL_MODE = 01b (PWM mode), V _{SPEED} < V _{IL} , SLEEP_TIME = 11b	140	200	260	ms
t _{DET_SB_FRE} Q	Time needed to detect standby mode, Frequency mode	SPD_CTRL_MODE = 11b (Frequency mode), V _{SPEED} < V _{IL}		4000		ms
t _{DET_SB_DIG}	Time needed to detect standby mode, I ² C mode	SPD_CTRL_MODE = 10b (I ² C mode), SPEED_CTRL = 0b		1	2	ms
t _{EN_SB}	Time needed to stop driving motor after detecting standby command	All speed input modes		1	2	ms
LOGIC-LEVE	EL INPUTS (BRAKE, DIR, EXT_CLK, EX	r_WD, SPEED)			·	
V_{IL}	Input logic low voltage	AVDD = 3 to 3.6 V			0.25*AV DD	V
V _{IH}	Input logic high voltage	AVDD = 3 to 3.6 V	0.65*AV DD			V
V _{HYS}	Input hysteresis		50	500	800	mV
I _{IL}	Input logic low current	AVDD = 3 to 3.6 V	-0.15		0.15	μΑ
l _{IH}	Input logic high current	AVDD = 3 to 3.6 V	-0.3		0	μΑ
R _{PD_SPEED}	Input pulldown resistance	SPEED pin To GND	0.6	1	1.4	$M\Omega$
OPEN-DRAI	N OUTPUTS (nFAULT, FG)					
V _{OL}	Output logic low voltage	I _{OD} = -5 mA			0.4	V
l _{OZ}	Output logic high current	V _{OD} = 3.3 V	0		0.5	μA
I ² C Serial Int			0.5		0.3*AVD	
V _{I2C_L}	Input logic low voltage		-0.5		D	V

www.ti.com.cn

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V _{I2C_H}	Input logic high voltage		0.7*AVD D		5.5	V
V _{I2C_HYS}	Hysteresis		0.05*AV DD			V
V _{I2C_OL}	Output logic low voltage	Open-drain at 2mA sink current	0		0.4	V
I _{I2C_OL}	Output logic low current	V _{I2C_OL} = 0.6V			6	mA
I _{I2C_IL}	Input current on SDA and SCL		-10 ²		10 ²	μΑ
C _i	Capacitance for SDA and SCL				10	pF
t .	Output fall time from V _{I2C_H} (min) to	Standard Mode			250 ³	ns
t _{of}	V _{I2C_L} (max)	Fast Mode			250 ³	ns
t _{SP}	Pulse width of spikes that must be suppressed by the input filter	Fast Mode	0		50 ⁴	ns
OSCILLATO	DR .					
·		EXT_CLK_CONFIG = 000b		8		kHz
		EXT_CLK_CONFIG = 001b		16		kHz
		EXT_CLK_CONFIG = 010b		32		kHz
f	External clock reference	EXT_CLK_CONFIG = 011b		64		kHz
foscref	External clock reference	EXT_CLK_CONFIG = 100b		128		kHz
		EXT_CLK_CONFIG = 101b		256		kHz
		EXT_CLK_CONFIG = 110b		512		kHz
		EXT_CLK_CONFIG = 111b		1024		kHz
EEPROM					'	
EE _{Prog}	Programming voltage		1.35	1.5	1.65	V
	Retention	T _A = 25 ℃		100		Years
EE _{RET}		T _J = -40 to 150 ℃	10			Years
		T _J = -40 to 150 ℃	1000			Cycles
EE _{END}	Endurance	T _J = -40 to 85 °C	20000			Cycles
PROTECTION	ON CIRCUITS					•
		VM rising	4.3	4.4	4.51	V
V_{UVLO}	Supply under voltage lockout (UVLO)	VM falling	4.1	4.2	4.3	V
V _{UVLO_HYS}	Supply under voltage lockout hysteresis	Rising to falling threshold	110	200	350	mV
t _{UVLO}	Supply under voltage deglitch time		3	5	7	μs
		Supply rising, OVP_EN = 1, OVP_SEL = 0	32.5	34	35	V
	Supply over voltage protection (OVP) threshold	Supply falling, OVP_EN = 1, OVP_SEL = 0	31.8	33	34.3	V
V _{OVP}		Supply rising, OVP_EN = 1, OVP_SEL = 1	20	22	23	V
		Supply falling, OVP_EN = 1, OVP_SEL = 1	19	21	22	V
	Supply over voltage protection hysteresis	Rising to falling threshold, OVP_SEL = 1	0.9	1	1.1	V
V _{OVP_HYS}		Rising to falling threshold, OVP_SEL = 0	0.7	0.8	0.9	V
t _{OVP}	Supply over voltage deglitch time		2.5	5	7	μs
	Charge pump under voltage lockout	Supply rising	2.25	2.5	2.75	V
V_{CPUV}	(above VM)	Supply falling	2.2	2.4	2.6	V
V _{CPUV_HYS}	Charge pump UVLO hysteresis	Rising to falling threshold	65	100	150	mV

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V	Analog regulator (AVDD) under voltage	Supply rising	2.7	2.85	3	V
V _{AVDD_UV}	lockout	Supply falling	2.5	2.65	2.8	V
V _{AVDD} _ uv_hys	Analog regulator under voltage lockout hysteresis	Rising to falling threshold	180	200	240	mV
	Over current protection trip point	OCP_LVL = 0b	5.5	9	12	Α
I _{OCP}	Over current protection trip point	OCP_LVL = 1b	9	13	18	Α
		OCP_DEG = 00b	0.02	0.2	0.4	μs
	Over current protection deglitch time	OCP_DEG = 01b	0.2	0.6	1.2	μs
t _{OCP}		OCP_DEG = 10b	0.5	1.2	1.8	μs
		OCP_DEG = 11b	0.9	1.6	2.5	μs
.	Over current protection retry time	OCP_RETRY = 0	4	5	6	ms
t _{RETRY}		OCP_RETRY = 1	425	500	575	ms
T _{OTW}	Thermal warning temperature	Die temperature (T _J)	135	145	155	°C
T _{OTW_HYS}	Thermal warning hysteresis	Die temperature (T _J)	20	25	30	°C
T _{TSD_BUCK}	Thermal shutdown temperature (Buck)	Die temperature (T _J)	170	180	190	°C
T _{TSD_BUCK_} HYS	Thermal shutdown hysteresis (Buck)	Die temperature (T _J)	20	25	30	°C
T _{TSD}	Thermal shutdown temperature (FET)	Die temperature (T _J)	165	175	185	°C
T _{TSD_HYS}	Thermal shutdown hysteresis (FET)	Die temperature (T _J)	20	25	30	°C

- (1) R_{LBK} is resistance of inductor L_{BK}.
- (2) If AVDD is switched off, I/O pins must not obstruct the SDA and SCL lines.
- (3) The maximum tf for the SDA and SCL bus lines (300 ns) is longer than the specified maximum tof for the output stages (250 ns). This allows series protection resistors (Rs) to be connected between the SDA/SCL pins and the SDA/SCL bus lines without exceeding the maximum specified tf.
- (4) Input filters on the SDA and SCL inputs suppress noise spikes of less than 50 ns.

6.6 Characteristics of the SDA and SCL bus for Standard and Fast mode

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	NOM MAX	UNIT		
Standard-mode							
f _{SCL}	SCL clock frequency		0	100	kHz		
t _{HD_STA}	Hold time (repeated) START condition	After this period, the first clock pulse is generated	4		μs		
t _{LOW}	LOW period of the SCL clock		4.7		μs		
t _{HIGH}	HIGH period of the SCL clock		4		μs		
t _{SU_STA}	Set-up time for a repeated START condition		4.7		μs		
t _{HD_DAT}	Data hold time ⁽²⁾	I2C bus devices	0 (3)	(4)	μs		
t _{SU_DAT}	Data set-up time		250		ns		
t _r	Rise time for both SDA and SCL signals			1000	ns		
t _f	Fall time of both SDA and SCL signals (3) (6) (7) (8)			300	ns		
t _{SU_STO}	Set-up time for STOP condition		4		μs		
t _{BUF}	Bus free time between STOP and START condition		4.7		μs		
C _b	Capacitive load for each bus line (9)			400	pF		
t _{VD_DAT}	Data valid time (10)			3.45 (4)	μs		
t _{VD_ACK}	Data valid acknowledge time (11)			3.45 (4)	μs		

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

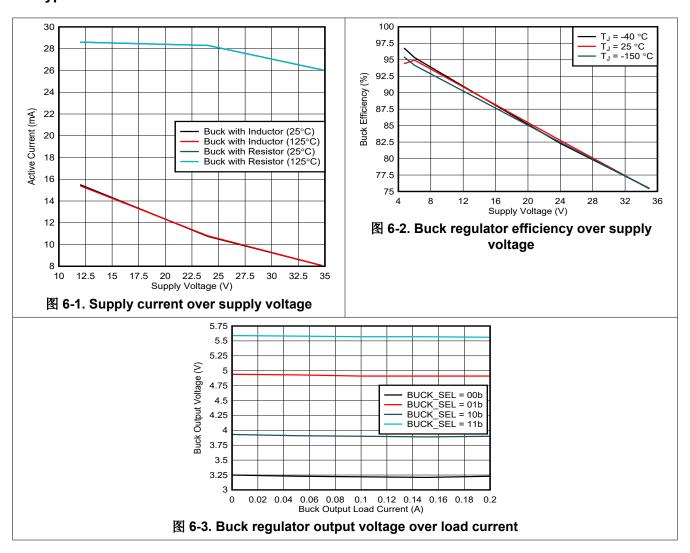
over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	NOM	MAX	UNIT
V _{nL}	Noise margin at the LOW level	For each connected device (including hysteresis)	0.1*AVD D			V
V_{nh}	Noise margin at the HIGHlevel	For each connected device (including hysteresis)	0.2*AVD D			V
Fast-mo	de					
f _{SCL}	SCL clock frequency		0		400	KHz
t _{HD_STA}	Hold time (repeated) START condition	After this period, the first clock pulse is generated	0.6			μs
t _{LOW}	LOW period of the SCL clock		1.3			μs
t _{HIGH}	HIGH period of the SCL clock		0.6			μs
t _{SU_STA}	Set-up time for a repeated START condition		0.6			μs
t _{HD_DAT}	Data hold time ⁽²⁾		0 (3)		(4)	μs
t _{SU_DAT}	Data set-up time		100 (5)			ns
t _r	Rise time for both SDA and SCL signals		20		300	ns
t _f	Fall time of both SDA and SCL signals (3) (6) (7) (8)		20 x (AVDD/ 5.5V)		300	ns
t _{SU_STO}	Set-up time for STOP condition		0.6			μs
t _{BUF}	Bus free time between STOP and START condition		1.3			μs
C _b	Capacitive load for each bus line (9)				400	pF
t _{VD_DAT}	Data valid time (10)				0.9 (4)	μs
t _{VD_ACK}	Data valid acknowledge time (11)				0.9 (4)	μs
V _{nL}	Noise margin at the LOW level	For each connected device (including hysteresis)	0.1*AVD D			V
V_{nh}	Noise margin at the HIGHlevel	For each connected device (including hysteresis)	0.2*AVD D			V
		1	_1			

- (1) All values referred to $V_{IH(min)}$ (0.3 V_{DD}) and $V_{IL(max)}$ levels
- (2) t_{HD DAT} is the data hold time that is measured from the falling edge of SCL, applies to data in transmission and the acknowledge.
- (3) A device must internally provide a hold time of at least 300 ns for the SDA signal (with respect to the V_{IH(min)} of the SCL signal) to bridge the undefined region of the falling edge of SCL.
- (4) The maximum t_{HD_DAT} could be 3.45 μs and .9 μs for Standard-mode and Fast-mode, but must be less than the maximum of t_{VD_DAT} or t_{VD_ACK} by a transition time. This maximum must only be met if the device does not stretch the LOW period (t_{LOW}) of the SCL signal. If the clock stretched the SCL, the data must be valid by the set-up time before it releases the clock.
- (5) A Fast-mode I2C-bus device can be used in a Standard-mode I2C-bus system, but the requirement t_{SU_DAT} 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line t_{r(max)} + t_{SU_DAT} = 1000 + 250 = 1250 ns (according to the Standard-mode I2C-bus specification) before the SCL line is released. Also the acknowledge timing must meet this set-up time.
- (6) If mixed with HS-mode devices, faster fall times according to Table 10 are allowed.
- (7) The maximum t_f for the SDA and SCL bus lines is specified at 300 ns. The maximum fall time for the SDA output stage t_f is specified at 250 ns. This allows series protection resistors to be connected in between the SDA and the SCL pins and the SDA/SCL bus lines without exceeding the maximum specified t_f.
- (8) In Fast-mode Plus, fall time is specified the same for both output stage and bus timing. If series resistors are used, designers should allow for this when considering bus timing.
- (9) The maximum bus capacitance allowable may vary from the value depending on the actual operating voltage and frequency of the application.
- (10) $t_{VD\ DAT}$ = time for data signal from SCL LOW to SDA output (HIGH or LOW, depending on which one is worse).
- (11) t_{VD}ACK = time for Acknowledgement signal from SCL LOW to SDA output (HIGH or LOW, depending on which one is worse).



6.7 Typical Characteristics



7 Detailed Description

7.1 Overview

The MCT8315A provides a single-chip, code-free sensorless trapezoidal solution for customers requiring high speed operation (up to 3 kHz electrical speed) or very fast start-up time (< 50ms) for 12- to 24-V brushless-DC motors requiring up to 4-A peak phase currents.

The MCT8315A integrates three $\frac{1}{2}$ -bridges with 40-V absolute maximum capability and a low $R_{DS(ON)}$ of 240-m Ω (high-side + low-side FETs) to enable high power drive capability. Current is sensed using integrated current sensing circuits which eliminate the need for external current sense resistors. Power management features including an output voltage-adjustable buck regulator and 3.3-V LDO generate the necessary voltage rails for the device and can also be used to power external circuits.

Sensorless trapezoidal control is highly configurable through register settings ranging from motor start-up behavior to closed loop operation. Register settings can be stored in non-volatile EEPROM, which allows the device to operate stand-alone once it has been configured. MCT8315A allows for a high level of monitoring; variables like duty cycle, motor speed, DC bus power can be displayed and observed as an analog output via two 12-bit DACs. This feature provides an effective method to tune speed loops as well as motor acceleration. The device can receive a speed command through a PWM signal, analog voltage, frequency input or I²C instruction.

In-built protection features include power-supply under voltage lockout (UVLO), charge-pump under voltage lockout (CPUV), over current protection (OCP), AVDD under voltage lockout (AVDD_UV), buck regulator UVLO, motor lock detection and over temperature warning and shutdown (OTW and TSD). Fault events are indicated by the nFAULT pin with detailed fault information available in the registers.

The MCT8315A device is available in a 0.5-mm pin pitch, VQFN surface-mount package. The VQFN package size is 7 mm × 5 mm with a height of 1 mm.



7.2 Functional Block Diagram

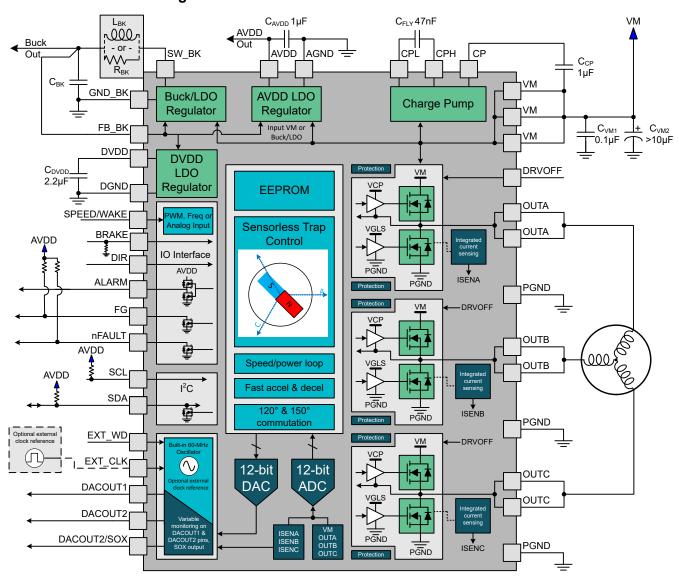


图 7-1. MCT8315A Functional Block Diagram

7.3 Feature Description

7.3.1 Output Stage

The MCT8315A consists of integrated 240-m Ω (combined high-side and low-side FETs' on-state resistance) NMOS FETs connected in a three-phase bridge configuration. A doubler charge pump provides the proper gate-bias voltage to the high-side NMOS FETs across a wide operating voltage range in addition to providing 100% duty-cycle support. An internal linear regulator provides the gate-bias voltage for the low-side MOSFETs.

7.3.2 Device Interface

MCT8315A supports I²C interface to provide end application design with adequate flexibility. MCT8315A allows controlling the motor operation and system through BRAKE, DIR, DRVOFF, EXT_CLK, EXT_WD and SPEED/WAKE pins. MCT8315A also provides different signals for monitoring internal variables, speed, fault and phase current feedback through DACOUT1, DACOUT2, FG, nFAULT, ALARM and SOX pins.

7.3.2.1 Interface - Control and Monitoring

Motor Control Signals

- When BRAKE pin is driven 'High', MCT8315A enters brake state. Low-side braking (see Low-Side Braking) is
 implemented during this brake state. MCT8315A decreases output speed to value defined by
 BRAKE_DUTY_THRESHOLD before entering brake state. As long as BRAKE is driven 'High', MCT8315A
 stays in brake state. Brake pin input can be overwritten by configuring BRAKE INPUT over the I²C interface.
- The DIR pin decides the direction of motor spin; when driven 'High', the sequence is OUT A → OUT C →
 OUT B, and when driven 'Low', the sequence is OUT A → OUT B → OUT C. DIR pin input can be overwritten
 by configuring DIR_INPUT over the I²C interface.
- When DRVOFF pin is driven 'High', MCT8315A stops driving the motor by turning OFF all MOSFETs (coast state). When DRVOFF is driven 'Low', MCT8315A returns to normal state of operation, as if it was restarting the motor (see DRVOFF Functionality). DRVOFF does not cause the device to go to sleep or standby mode; the digital core is still active. Entry and exit from sleep or standby condition is controlled by SPEED pin.
- SPEED/WAKE pin is used to control motor speed and to wake up MCT8315A from sleep mode. SPEED pin can be configured to accept PWM, frequency or analog input signals. It is used to enter and exit from sleep and standby mode (see 表 7-3).

External Oscillator and Watchdog Signals

- EXT_CLK pin can be used to provide an external clock reference (see External Clock Source).
- EXT_WD pin can be used to provide an external watchdog signal (see External Watchdog).

Output Signals

- DACOUT1 outputs internal variable defined by address in register DACOUT1_VAR_ADDR. DACOUT1 is refreshed every PWM cycle (see DAC outputs).
- DACOUT2 outputs internal variable defined by address in register DACOUT2_VAR_ADDR. DACOUT2 is refreshed every PWM cycle (see DAC outputs).
- FG pin provides pulses which are proportional to motor speed (see FG Configuration).
- nFAULT (active low) pin provides fault status in device or motor operation.
- ALARM pin, if enabled using ALARM_PIN_EN, provides fault status in device or motor operation. When
 ALARM pin is enabled, report only faults are reported only on ALARM pin (as logic high) and not reported on
 nFAULT pin (as logic low). When ALARM pin is enabled, actionable faults are reported on ALARM pin (as
 logic high) as well as on nFAULT pin (as logic low). When ALARM pin is disabled, it is in Hi-Z state and all
 faults (actionable and report only) are reported on nFAULT as logic low. ALARM pin should be left floating
 when unused/disabled.
- SOX pin provides the output of one of the current sense amplifiers.

7.3.2.2 I²C Interface

The MCT8315A supports an I²C serial communication interface that allows an external controller to send and receive data. This I²C interface lets the external controller to configure the EEPROM and read detailed fault and

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

17

motor state information. The I²C bus is a two-wire interface using the SCL and SDA pins which are described as follows:

- The SCL pin is the clock signal input.
- The SDA pin is the data input and output.

7.3.3 Step-Down Mixed-Mode Buck Regulator

The MCT8315A has an integrated mixed-mode buck regulator to supply regulated 3.3-V or 5-V power for an external controller or system voltage rail. Additionally, the buck output can also be configured to 4-V or 5.7-V for supporting the extra headroom for an external LDO for generating a 3.3-V or 5-V supplies. The output voltage of the buck is set by BUCK_SEL.

The buck regulator has a low quiescent current of ~1-2 mA during light loads to prolong battery life. The device improves performance during line and load transients by implementing a pulse-frequency current-mode control scheme which requires less output capacitance and simplifies frequency compensation design.

to in the second section go is a paint to galaxie.								
Buck Mode	Buck output voltage	Max output current from AVDD (I _{AVDD_MAX})	Max output current from Buck (I _{BK_MAX})	Buck current limit	AVDD power sequencing			
Inductor - 47 µH	3.3-V or 4-V	20 mA	170 mA - I _{AVDD}	600 mA (BUCK_CL = 0b)	Not supported (BUCK_PS_DIS = 1b)			
Inductor - 47 µH	5-V or 5.7-V	20 mA	170 mA - I _{AVDD}	600 mA (BUCK_CL = 0b)	Supported (BUCK_PS_DIS = 0b)			
Inductor - 22 µH	5-V or 5.7-V	20 mA	20 mA - I _{AVDD}	150 mA (BUCK_CL = 1b)	Not supported (BUCK_PS_DIS = 1b)			
Inductor - 22 µH	3.3-V or 4-V	20 mA	20 mA - I _{AVDD}	150 mA (BUCK_CL = 1b)	Supported (BUCK_PS_DIS = 0b)			
Resistor - 22 Ω	5-V or 5.7-V	20 mA	10 mA - I _{AVDD}	150 mA (BUCK_CL = 1b)	Not supported (BUCK_PS_DIS = 1b)			
Resistor - 22 Ω	3.3-V or 4-V	20 mA	10 mA - I _{AVDD}	150 mA (BUCK_CL = 1b)	Supported (BUCK_PS_DIS = 0b)			

表 7-1. Recommended settings for Buck Regulator

7.3.3.1 Buck in Inductor Mode

The buck regulator in MCT8315A is primarily designed to support low inductance of 47-µH and 22-µH. A 47-µH inductor allows the buck regulator to operate up to 170-mA load current support, whereas applications requiring current up to 20-mA can use a 22-µH inductor which saves component size.

图 7-2 shows the connection of buck regulator in inductor mode.

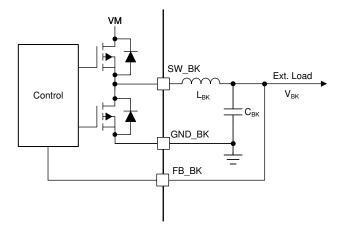


图 7-2. Buck (Inductor Mode)

7.3.3.2 Buck in Resistor mode

If the external load requirement is less than 10-mA, the inductor can be replaced with a resistor. In resistor mode the power is dissipated across the external resistor and the efficiency is lower than buck in inductor mode.

§ 7-3 shows the connection of buck in resistor mode.

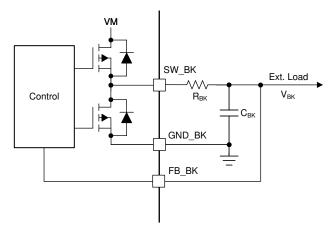


图 7-3. Buck (Resistor Mode)

7.3.3.3 Buck Regulator with External LDO

The buck regulator also supports the voltage requirement to supply an external LDO to generate standard 3.3-V or 5-V output rail with higher accuracies. The buck output voltage should be configured to 4-V or 5.7-V to provide extra headroom to support the external LDO for generating 3.3-V or 5-V rail as shown in $\boxed{8}$ 7-4. This allows for a lower-voltage LDO design to save cost and better thermal management due to low drop-out voltage.

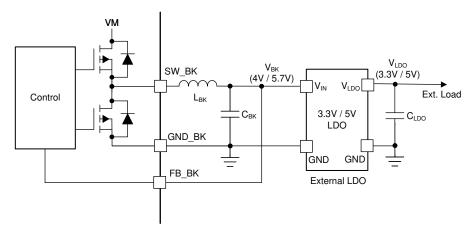


图 7-4. Buck Regulator with External LDO

7.3.3.4 AVDD Power Sequencing from Buck Regulator

The AVDD LDO has an option of using the power supply from mixed mode buck regulator to reduce the device power dissipation. The power sequencing mode allows on-the-fly changeover of AVDD LDO input from DC mains (VM) to buck output (V_{BK}) as shown in $\boxed{8}$ 7-5. This sequencing can be configured through the BUCK PS DIS bit. Power sequencing is supported only when buck output voltage is set to 5-V or 5.7-V.



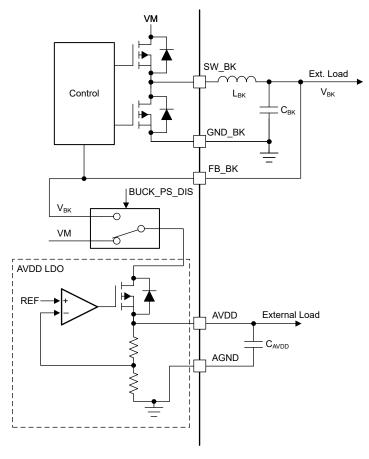


图 7-5. AVDD Power Sequencing from Mixed Mode Buck Regulator

7.3.3.5 Mixed Mode Buck Operation and Control

The buck regulator implements a pulse frequency modulation (PFM) architecture with peak current mode control. The output voltage of the buck regulator is compared with the internal reference voltage (V_{BK_REF}) which is internally generated depending on the buck output voltage setting (BUCK_SEL) which constitutes an outer voltage control loop. Depending on the comparator output going high ($V_{BK} < V_{BK_REF}$) or low ($V_{BK} > V_{BK_REF}$), the high-side power FET of the buck turns on and off respectively. An independent current control loop monitors the current in high-side power FET (I_{BK}) and turns off the high-side FET when the current becomes higher than the buck current limit (I_{BK_CL} set by BUCK_CL) - this implements a current limit control for the buck regulator. \boxtimes 7-6 shows the architecture of the buck and various control/protection loops.

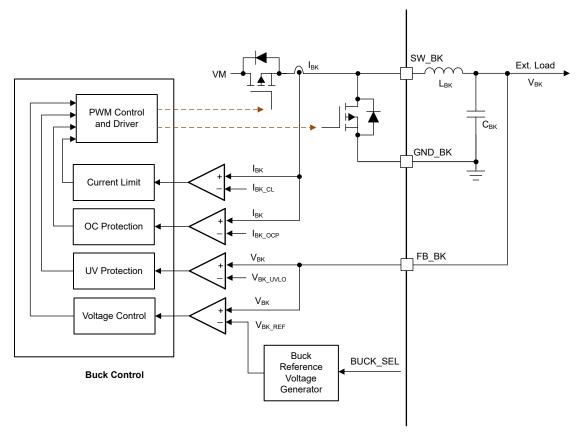


图 7-6. Buck Operation and Control Loops

7.3.3.6 Buck Under Voltage Protection

If at any time the voltage on the FB_BK pin (buck regulator output) falls lower than the V_{BK_UV} threshold, both the high-side and low-side MOSFETs of the buck regulator are disabled. MCT8315A goes into reset state whenever buck UV event occurs, since the internal circuitry in MCT8315A is powered from the buck regulator output.

7.3.3.7 Buck Over Current Protection

The buck over current event is sensed by monitoring the current flowing through high-side MOSFET of the buck regulator. If the current through the high-side MOSFET exceeds the I_{BK_OCP} threshold for a time longer than the deglitch time (t_{OCP_DEG}), a buck OCP event is recognized and both the high-side and low-side MOSFETs of the buck regulator are disabled. MCT8315A goes into reset state whenever buck OCP event occurs, since the internal circuitry in MCT8315A is powered from the buck regulator output.

7.3.4 AVDD Linear Voltage Regulator

A 3.3-V linear regulator is integrated into MCT8315A and is available for use by external circuitry. This AVDD LDO regulator is used for powering up the internal circuitry of the device and additionally, this regulator can also provide the supply voltage for a low-power MCU or other external circuitry supporting up to 20-mA. The output of the AVDD regulator should be bypassed near the AVDD pin with a X5R or X7R, 1-μF, 6.3-V ceramic capacitor routed directly back to the adjacent AGND ground pin.

The AVDD nominal, no-load output voltage is 3.3-V.



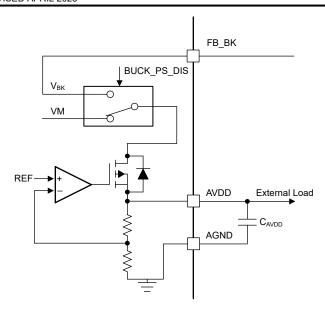


图 7-7. AVDD Linear Regulator Block Diagram

Use 方程式 1 to calculate the power dissipated in the device by the AVDD linear regulator with VM as supply (BUCK_PS_DIS = 1b)

$$P = (V_{VM} - V_{AVDD}) \times I_{AVDD} \tag{1}$$

For example, at a V_{VM} of 24-V, drawing 20-mA out of AVDD results in a power dissipation as shown in 方程式 2.

$$P = (24 \text{ V} - 3.3 \text{ V}) \times 20 \text{ mA} = 414 \text{ mW}$$
 (2)

$$P = (V_{FB\ BK} - V_{AVDD}) \times I_{AVDD} \tag{3}$$

7.3.5 Charge Pump

Since the output stages use N-channel FETs, the device requires a gate-drive voltage higher than the VM power supply to turn-on the high-side FETs. The MCT8315A integrates a charge-pump circuit that generates a voltage above the VM supply for this purpose.

The charge pump requires two external capacitors (C_{CP} , C_{FLY}) for operation. See \boxtimes 7-1 and \gtrless 5-1 for details on these capacitors (value, connection, and so forth).

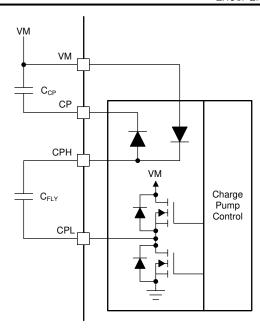


图 7-8. Charge Pump

7.3.6 Slew Rate Control

An adjustable gate-drive current control is provided for the output stage MOSFETs to achieve configurable slew rate for EMI mitigation. The MOSFET VDS slew rate is a critical factor for optimizing radiated emissions, total energy and duration of diode recovery spikes and switching voltage transients related to parasitic elements of the PCB. This slew rate is predominantly determined by the control of the internal MOSFET gate current as shown in $\boxed{3}$ 7-9.

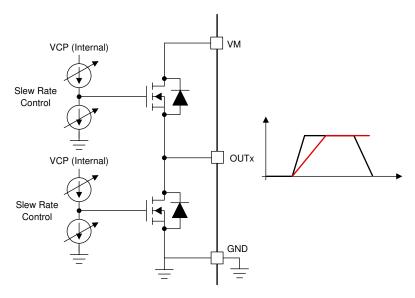


图 7-9. Slew Rate Circuit Implementation

The slew rate of each half-bridge can be adjusted through SLEW_RATE settings. Slew rate can be configured as 25-V/µs, 50-V/µs, 125-V/µs or 200-V/µs. The slew rate is calculated by the rise-time and fall-time of the voltage on OUTx pin as shown in $\boxed{8}$ 7-10.



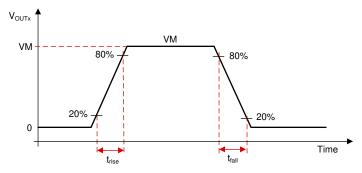


图 7-10. Slew Rate Timings

7.3.7 Cross Conduction (Dead Time)

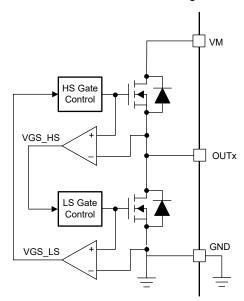
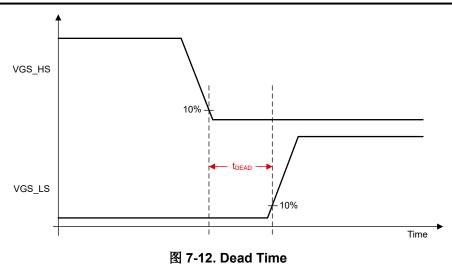


图 7-11. Cross Conduction Protection



7.3.8 Speed Control

The MCT8315A offers four methods of directly controlling the speed of the motor. The speed control method is configured by SPD CTRL MODE. The speed command can be controlled in one of the following four ways.

- PWM input on SPEED pin by varying duty cycle of input signal
- Frequency input on SPEED pin by varying frequency of input signal
- Analog input on SPEED pin by varying amplitude of input signal
- Over I²C by configuring SPEED CTRL

The speed can also be indirectly controlled by varying the supply voltage (V_M).

The signal path from SPEED pin input (or I²C based speed input) to output duty cycle (DUTY_OUT) applied to FETs is shown in

▼ 7-13.

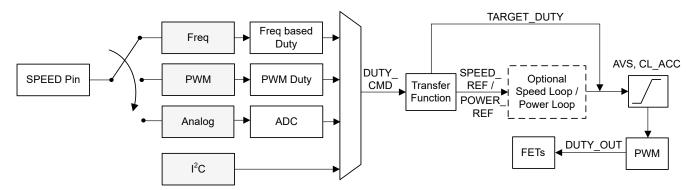


图 7-13. Multiplexing the Speed Command

图 7-14 shows the transfer function between DUTY_CMD and SPEED_REF / POWER_REF / TARGET_DUTY.

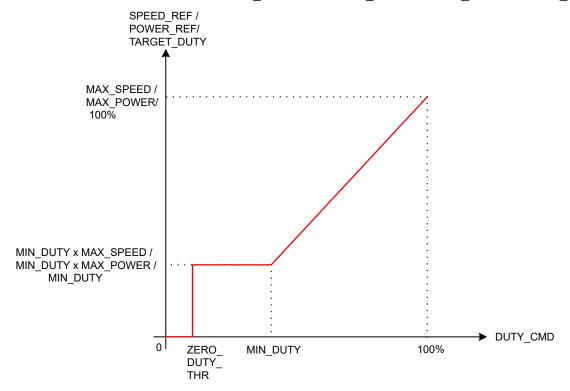


图 7-14. Speed Input Transfer Function

When speed/power loop is disabled (CLOSED_LOOP_MODE = 00b), DUTY_CMD sets the TARGET_DUTY in % - TARGET_DUTY is 100% when DUTY_CMD is 100% and TARGET_DUTY is equal to MIN_DUTY when DUTY_CMD is set to MIN_DUTY. TARGET_DUTY stays clamped at MIN DUTY for ZERO_DUTY_THR \le DUTY_CMD \le MIN_DUTY.

When speed loop is enabled (CLOSED_LOOP_MODE = 01b), DUTY_CMD sets the SPEED_REF in Hz. MAX_SPEED sets the SPEED_REF at DUTY_CMD of 100%. MIN_DUTY sets the minimum SPEED_REF (MIN_DUTY x MAX_SPEED). SPEED_REF stays clamped at (MIN_DUTY x MAX_SPEED) for ZERO DUTY THR \leq DUTY CMD \leq MIN DUTY.

When power loop is enabled (CLOSED_LOOP_MODE = 10b), DUTY_CMD sets the POWER_REF in W. MAX_POWER sets the POWER_REF at DUTY_CMD of 100%. MIN_DUTY sets the minimum POWER_REF (MIN_DUTY x MAX_POWER). POWER_REF stays clamped at (MIN_DUTY x POWER_REF) for ZERO_DUTY_THR \leq DUTY_CMD \leq MIN_DUTY.

ZERO_DUTY_THR sets the DUTY_CMD below which SPEED_REF / POWER_REF / TARGET_DUTY is set to zero and motor is in stopped state. AVS, CL_ACC configure the transient characteristics of DUTY_OUT; the steady state value of DUTY_OUT is directly configured in % through TARGET_DUTY (when speed/power loop is disabled) or through SPEED_REF/POWER_REF (when speed/power loop is enabled).

7.3.8.1 Analog Mode Speed Control

Analog input based speed control can be configured by setting SPD_CTRL_MODE to 00b. In this mode, the duty command (DUTY_CMD) varies with the analog voltage input on the SPEED pin (V_{SPEED}). When 0 \leq V_{SPEED} \leq V_{EN_SB}, DUTY_CMD is set to zero and the motor is stopped. When V_{EX_SB} \leq V_{SPEED} \leq V_{ANA_FS}, DUTY_CMD varies linearly with V_{SPEED} as shown in \boxtimes 7-15. V_{EX_SB} and V_{EN_SB} are the standby entry and exit thresholds - refer \dagger 7.4.1.2 for more information on V_{EX_SB} and V_{EN_SB}. When V_{SPEED} > V_{ANA_FS}, DUTY_CMD is clamped to 100%.

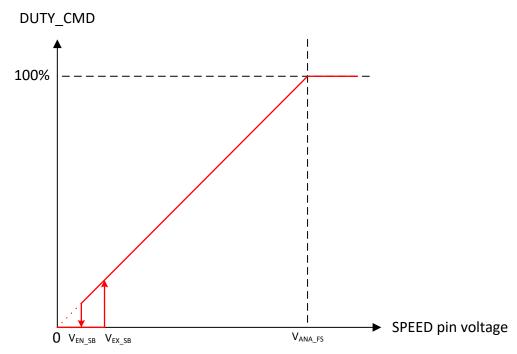


图 7-15. Analog Mode Speed Control

7.3.8.2 PWM Mode Speed Control

PWM based speed control can be configured by setting SPD_CTRL_MODE to 01b. In this mode, the PWM duty cycle applied to the SPEED pin can be varied from 0 to 100% and duty command (DUTY_CMD) varies linearly with the applied PWM duty cycle. When $0 \le \text{Duty}_{\text{SPEED}} \le \text{Duty}_{\text{EN}}$ BB, DUTY_CMD is set to zero and the motor

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

27

is stopped. When $Duty_{EX_SB} \le Duty_{SPEED} \le 100\%$, $DUTY_CMD$ varies linearly with $Duty_{SPEED}$ as shown in $\[\] 7-16$. $Duty_{EX_SB}$ and $Duty_{EN_SB}$ are the standby entry and exit thresholds - refer $\[\] 7.4.1.2$ for more information on $Duty_{EX_SB}$ and $Duty_{EN_SB}$. The frequency of the PWM input signal applied to the SPEED pin is defined as f_{PWM} and the range for this frequency can be configured through SPD_PWM_RANGE_SELECT.

各注

- 1. f_{PWM} is the frequency of the PWM signal the device can accept at SPEED pin to control motor speed. It does not correspond to the PWM output frequency that is applied to the motor phases. The PWM output frequency can be configured through PWM_FREQ_OUT (see 节 7.3.15).
- 2. SLEEP_TIME should be set longer than the off time in PWM signal (V_{SPEED} < V_{IL}) at lowest duty input. For example, if f_{PWM} is 10 kHz and lowest duty input is 2%, SLEEP_TIME should be more than 98 μs to ensure there is no unintended sleep entry.

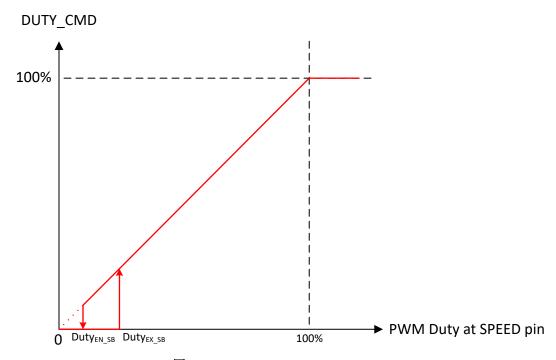


图 7-16. PWM Mode Speed Control

7.3.8.3 I²C based Speed Control

I²C based serial interface can be used for speed control by setting SPD_CTRL_MODE to 10b. In this mode, the speed command can be written directly into SPEED_CTRL. The SPEED pin can be used to control the sleep entry and exit - if SPEED pin input is set to a value lower than V_{EN_SL} after SPEED_CTRL has been set to 0b for a time longer than SLEEP_TIME, MCT8315A enters sleep state. When SPEED pin > V_{EX_SL} , MCT8315A exits sleep state and speed is controlled through SPEED_CTRL. If $0 \le SPEED_CTRL \le SPEED_CTRL_{EN_SB}$ and SPEED pin > V_{EX_SL} , MCT8315A is in standby state. The relationship between DUTY_CMD and SPEED_CTRL is shown in $\boxed{8}$ 7-17. Refer $\boxed{7}$ 7.4.1.2 for more information on SPEED_CTRL_{EN_SB} EX_SB and SPEED_CTRL_{EN_SB} EX_SB.

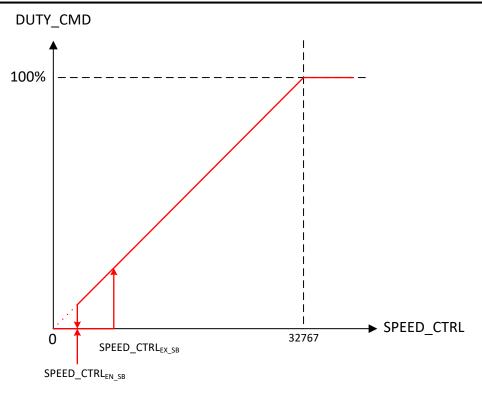


图 7-17. I2C Mode Speed Control

7.3.8.4 Frequency Mode Speed Control

Frequency based speed control is configured by setting SPD_CTRL_MODE to 11b. In this mode, duty command varies linearly as a function of the frequency of the square wave input at SPEED pin. When $0 \le \text{Freq}_{\text{SPEED}} \le \text{Freq}_{\text{SP}, \text{SB}}$, DUTY_CMD is set to zero and the motor is stopped. When $\text{Freq}_{\text{EX}, \text{SB}} \le \text{Freq}_{\text{SPEED}} \le \text{INPUT}_{\text{MAX}}$, FREQUENCY, DUTY_CMD varies linearly with $\text{Freq}_{\text{SPEED}}$ as shown in $\boxed{8}$ 7-18. Freq $_{\text{EX}, \text{SB}}$ and $\text{Freq}_{\text{EN}, \text{SB}}$ are the standby entry and exit thresholds - refer $\boxed{7}$ 7.4.1.2 for more information on $\text{Freq}_{\text{EX}, \text{SB}}$ and $\text{Freq}_{\text{EN}, \text{SB}}$. Input frequency greater than INPUT_MAX_FREQUENCY clamps the DUTY_CMD to 100%.



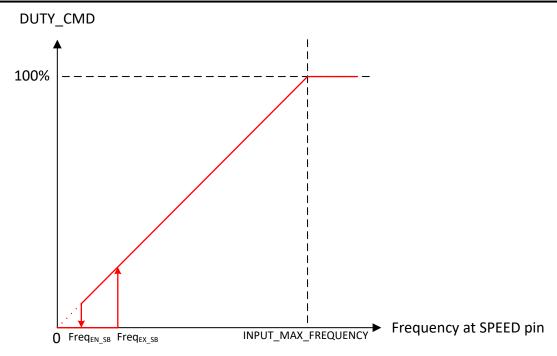


图 7-18. Frequency Mode Speed Control

7.3.9 Starting the Motor Under Different Initial Conditions

The motor can be in one of three states when MCT8315A begins the start-up process. The motor may be stationary, spinning in the forward direction, or spinning in the reverse direction. The MCT8315A includes a number of features to allow for reliable motor start-up under all of these conditions.

7-19 shows the motor start-up flow for each of the three initial motor states.

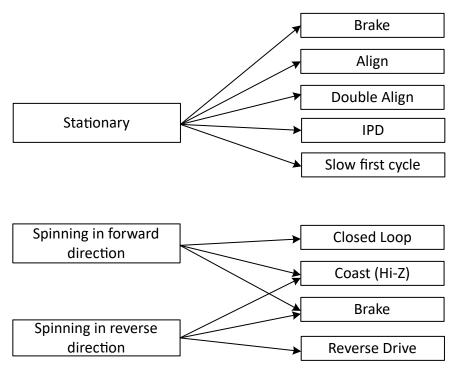


图 7-19. Starting the motor under different initial conditions

备注

"Forward" means "spinning in the same direction as the commanded direction", and "Reverse" means "spinning in the opposite direction as the commanded direction".

7.3.9.1 Case 1 - Motor is Stationary

If the motor is stationary, the commutation must be initialized to be in phase with the position of the motor. The MCT8315A provides various options to initialize the commutation logic to the motor position and reliably start the motor.

- The align and double align techniques force the motor into alignment by applying a voltage across particular motor phases to force the motor to rotate in alignment with this phase.
- Initial position detect (IPD) determines the position of the motor based on the deterministic inductance variation, which is often present in BLDC motors.
- The slow first cycle method starts the motor by applying a low frequency cycle to align the rotor position to the applied commutation by the end of one electrical rotation.

MCT8315A also provides a configurable brake option to ensure the motor is stationary before initiating one of the above start-up methods. Device enters open loop acceleration after going through the configured start-up method.

7.3.9.2 Case 2 - Motor is Spinning in the Forward Direction

If the motor is spinning forward (same direction as the commanded direction) with sufficient speed (BEMF), the MCT8315A resynchronizes with the spinning motor and continues commutation by going directly to closed loop operation. By resynchronizing to the spinning motor, the user achieves the fastest possible start-up time for this initial condition. This resynchronization feature can be enabled or disabled through RESYNC_EN. If resynchronization is disabled, the MCT8315A can be configured to wait for the motor to coast to a stop and/or apply a brake. After the motor has stopped spinning, the motor start-up sequence proceeds as in Case 1, considering the motor is stationary.

7.3.9.3 Case 3 - Motor is Spinning in the Reverse Direction

If the motor is spinning in the reverse direction (the opposite direction as the commanded direction), the MCT8315A provides several methods to change the direction and drive the motor to the target speed reference in the commanded direction.

The reverse drive method allows the motor to be driven so that it decelerates through zero speed. The motor achieves the shortest possible spin-up time when spinning in the reverse direction.

If reverse drive is not enabled, then the MCT8315A can be configured to wait for the motor to coast to a stop and/or apply a brake. After the motor has stopped spinning, the motor start-up sequence proceeds as in Case 1, considering the motor is stationary.

备注

Take care when using the reverse drive or brake feature to ensure that the current is limited to an acceptable level and that the supply voltage does not surge as a result of energy being returned to the power supply.



7.3.10 Motor Start Sequence (MSS)

▼ 7-20 shows the motor-start sequence implemented in the MCT8315A device.

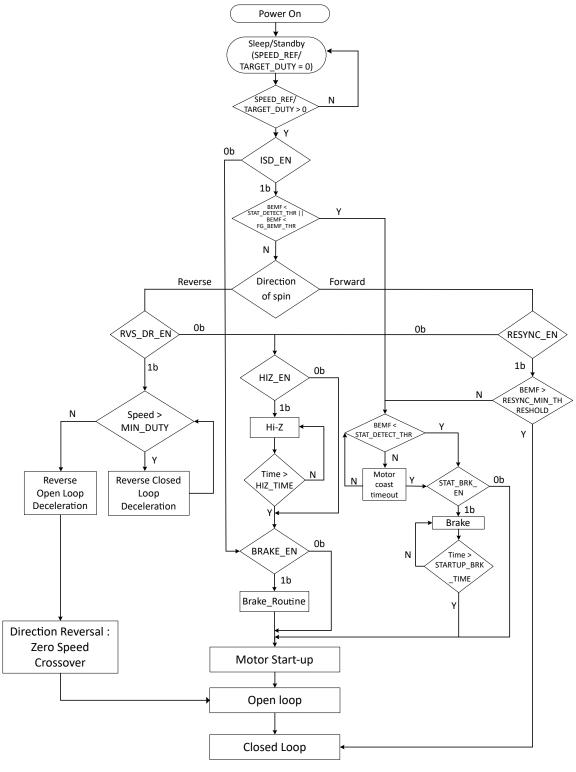


图 7-20. Motor Start Sequence

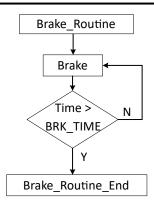


图 7-21. Brake Routine

Power-On State This is the initial state of the Motor Start Sequence (MSS) when MCT8315A

is powered on. In this state, MCT8315A configures the peripherals,

initializes the algorithm parameters from EEPROM and prepares for driving

the motor.

Sleep/Standby In this state, SPEED REF/POWER REF/TARGET DUTY is set to zero and

MCT8315A is either in sleep or standby mode depending on DEV MODE

and SPEED/WAKE pin voltage.

SPEED_REF/POWER_REF/

When SPEED REF/POWER REF/TARGET DUTY is set to greater than **TARGET_DUTY > 0 Judgement** zero, MCT8315A exits the sleep/standby state and proceeds to ISD EN

judgement. As long as SPEED REF is set to zero, MCT8315A stays in

sleep/standby state.

ISD EN Judgement MCT8315A checks to see if the initial speed detect (ISD) function is enabled

> (ISD_EN = 1b). If ISD is enabled, MSS proceeds to the BEMF < STAT DETECT THR judgement. Instead, if ISD is disabled, the MSS

proceeds directly to the BRAKE_EN judgement.

BEMF < FG_BEMF_THR

Judgement

BEMF < STAT_DETECT_THR or ISD determines the initial condition (speed, angle, direction of spin) of the motor (see † 7.3.10.1). If motor is deemed to be stationary (BEMF < STAT DETECT THR or BEMF < FG BEMF THR), the MSS proceeds to second BEMF < STAT DETECT THR judgement. If the motor is not stationary, MSS proceeds to verify the direction of spin.

Direction of spin Judgement The MSS determines whether the motor is spinning in the forward or the

> reverse direction. If the motor is spinning in the forward direction, the MCT8315A proceeds to the RESYNC_EN judgement. If the motor is spinning in the reverse direction, the MSS proceeds to the RVS DR EN

judgement.

RESYNC_EN Judgement If RESYNC EN is set to 1b, MCT8315A proceeds to BEMF >

RESYNC MIN THRESHOLD judgement. If RESYNC EN is set to 0b, MSS

proceeds to HIZ EN judgement.

BEMF >

RESYNC_MIN_THRESHOLD

Judgement

If motor speed is such that BEMF > RESYNC MIN THRESHOLD, MCT8315A uses the speed and position information from ISD to transition to the closed loop state (see Motor Resynchronization) directly. If BEMF <

RESYNC MIN THRESHOLD, MCT8315A proceeds to BEMF <

STAT DETECT THR judgement.

BEMF < STAT DETECT THR

Judgement

If motor speed is such that BEMF > STAT DETECT THR, MCT8315A proceeds to motor coast timeout. If BEMF < STAT DETECT THR,

MCT8315A proceeds to STAT_BRK_EN judgement.



Motor Coast Timeout MCT8315A waits for 200000 PWM cycles for the motor to coast down to a

speed where BEMF < STAT_DETECT_THR; after 200000 PWM cycles lapse in the motor coast state, MCT8315A proceeds to STAT_BRK_EN judgement irrespective of BEMF. If BEMF < STAT_DETECT_THR during motor coast before the 200000 cycle timeout, MCT8315A proceeds to

STAT_BRK_EN judgement immediately.

STAT_BRK_EN Judgement The MSS checks if the stationary brake function is enabled (STAT_BRK_EN

=1b). If the stationary brake function is enabled, the MSS advances to the stationary brake routine. If the stationary brake function is disabled, the

MSS advances to motor start-up state (see 节 7.3.10.4).

Stationary Brake Routine The stationary brake routine can be used to ensure the motor is completely

stationary before attempting to start the motor. The stationary brake is applied by turning on all three low-side driver MOSFETs for a time

configured by STARTUP_BRK_TIME.

RVS_DR_EN Judgement The MSS checks to see if the reverse drive function is enabled

(RVS_DR_EN = 1b). If it is enabled, the MSS transitions to check speed of the motor in reverse direction. If the reverse drive function is not enabled (RVS_DR_EN = 0b), the MSS advances to the HIZ_EN judgement.

Speed > MIN_DUTY Judgement The MSS checks if the speed (in reverse direction) is higher than the speed

at MIN_DUTY - till the speed (in reverse direction) is higher than the speed at MIN_DUTY, MSS stays in reverse closed loop deceleration. When speed (in reverse direction) drops below the speed at MIN_DUTY, the MSS

transitions to reverse open loop deceleration.

Reverse Open Loop

Deceleration and Zero Speed

Crossover

In reverse open loop deceleration, the MCT8315A decelerates the motor in open-loop till speed reaches zero. At zero speed, direction changes and

MCT8315A begins open loop acceleration.

HIZ_EN Judgement The MSS checks to determine whether the coast (Hi-Z) function is enabled

(HIZ_EN = 1b). If the coast function is enabled (HIZ_EN = 1b), the MSS advances to the coast routine. If the coast function is disabled (HIZ_EN = $\frac{1}{2}$)

0b), the MSS advances to the BRAKE EN judgement.

Coast (Hi-Z) Routine The device coasts the motor by turning OFF all six MOSFETs for a certain

time configured by HIZ TIME.

BRAKE EN Judgement The MSS checks to determine whether the brake function is enabled

(BRAKE_EN = 1b). If the brake function is enabled (BRAKE_EN = 1b), the MSS advances to the brake routine. If the brake function is disabled (BRAKE_EN = 0b), the MSS advances to the motor start-up state (see †

7.3.10.4).

Brake Routine MCT8315A implements a brake by turning on all three (high-side or low-

side) MOSFETS for BRK TIME. Brake is applied either using high-side or

low-side MOSFETs based on BRK MODE configuration.

Closed Loop In this state, the MCT8315A drives the motor with sensorless trapezoidal

commutation based on either zero cross detection or BEMF integration.

7.3.10.1 Initial Speed Detect (ISD)

The ISD function is used to identify the initial condition of the motor and is enabled by setting ISD_EN to 1b. The initial speed, position and direction is determined by sensing the three phase voltages. ISD can be disabled by setting ISD_EN to 0b. If the function is disabled (ISD_EN set to 0b), the MCT8315A does not perform the initial speed detect function and proceeds to check if the brake routine (BRAKE_EN) is enabled.

Submit Document Feedback

7.3.10.2 Motor Resynchronization

The motor resynchronization function works when the ISD and resynchronization functions are both enabled and the device determines that the initial state of the motor is spinning in the forward direction (same direction as the commanded direction). The speed and position information measured during ISD are used to initialize the drive state of the MCT8315A, which can transition directly into closed loop state without needing to stop the motor. In the MCT8315A, motor resynchronization can be enabled/disabled through RESYNC_EN bit. If motor resynchronization is disabled, the device proceeds to check if the motor coast (Hi-Z) routine is enabled.

7.3.10.3 Reverse Drive

The MCT8315A uses the reverse drive function to change the direction of the motor rotation when ISD_EN and RVS_DR_EN are both set to 1b and the ISD determines the motor spin direction to be opposite to that of the commanded direction. Reverse drive includes synchronizing with the motor speed in the reverse direction, reverse decelerating the motor through zero speed, changing direction, and accelerating in open loop in forward (or commanded) direction until the device transitions into closed loop in forward direction (see 7-22). MCT8315A uses the same parameter values for open to closed loop handoff threshold (OPN_CL_HANDOFF_THR), open loop acceleration rates (OL_ACC_A1, OL_ACC_A2) and open loop current limit (OL_ILIMIT) in the reverse direction as in the forward direction.

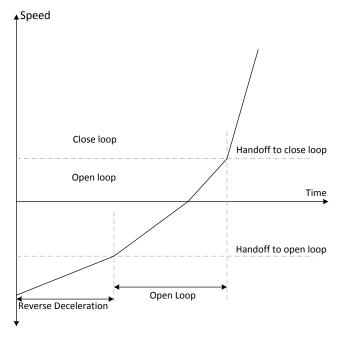


图 7-22. Reverse Drive Function

7.3.10.4 Motor Start-up

There are different options available for motor start-up from a stationary position and these options can be configured by MTR_STARTUP. In align and double align mode, the motor is aligned to a known position by injecting a DC current. In IPD mode, the rotor position is estimated by applying 6 different high-frequency pulses. In slow first cycle mode, the motor is started by applying a low frequency cycle.

7.3.10.4.1 Align

Align is enabled by configuring MTR_STARTUP to 00b. The MCT8315A aligns the motor by injecting a DC current using a particular phase pattern (phase-C high-side FET and phase-B low-side FET are ON) - current flowing into phase-B and flowing out from phase-C for a certain time configured by ALIGN_TIME.

The duty cycle during align is defined by ALIGN_DUTY. In MCT8315A, current limit during align is configured by ALIGN_CURR_THR.

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback



A fast change in the phase current during align may result in a sudden change in the driving torque and this could result in acoustic noise. To avoid this, the MCT8315A ramps up duty cycle from 0 to until it reaches ALIGN_DUTY at a configurable rate set by ALIGN_RAMP_RATE. At the end of align routine, the motor will be aligned at the known position.

7.3.10.4.2 Double Align

Double align is enabled by configuring MTR_STARTUP to 01b. Single align is not reliable when the initial position of the rotor is 180° out of phase with the applied phase pattern. In this case, it is possible to have start-up failures using single align. In order to improve the reliability of align based start-up, the MCT8315A provides the option of double align start-up. In double align start-up, MCT8315A uses a phase pattern for the second align that is 60° out of phase with the first align phase pattern in the commanded direction. In double align, relevant parameters like align time, current limit, ramp rate are the same as in the case of single align - two different phase patterns are applied in succession with the same parameters to ensure that the motor will be aligned to a known position irrespective of initial rotor position.

7.3.10.4.3 Initial Position Detection (IPD)

Initial Position Detection (IPD) can be enabled by configuring MTR_STARTUP to 10b. In IPD, inductive sense method is used to determine the initial position of the motor using the spatial variation in the motor inductance.

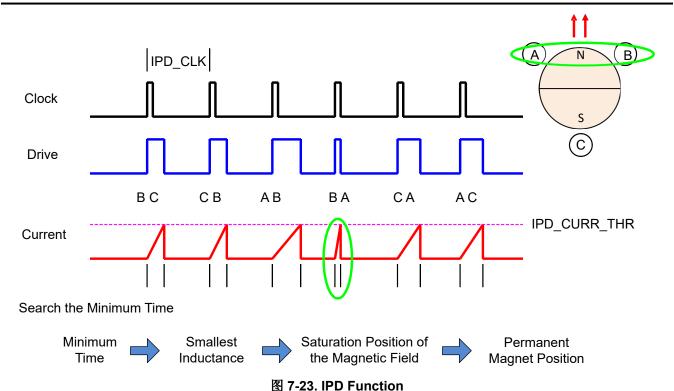
Align or double align may result in the motor spinning in the reverse direction before starting open loop acceleration. IPD can be used in such applications where reverse rotation of the motor is unacceptable. IPD does not wait for the motor to align with the commutation and therefore can allow for a faster motor start-up sequence. IPD works well when the inductance of the motor varies as a function of position. IPD works by pulsing current in to the motor and hence can generate acoustics which must be taken into account when determining the best start-up method for a particular application.

7.3.10.4.3.1 IPD Operation

IPD operates by sequentially applying six different phase patterns according to the following sequence: BC-> CB-> AB-> BA-> CA-> AC (see 7-23). When the current reaches the threshold configured by IPD_CURR_THR, the MCT8315A stops driving the particular phase pattern and measures the time taken to reach the current threshold from when the particular phase pattern was applied. Thus, the time taken to reach IPD_CURR_THR is measured for all six phase patterns - this time varies as a function of the inductance in the motor windings. The state with the shortest time represents the state with the minimum inductance. The minimum inductance is because of the alignment of the north pole of the motor with this particular driving state.

Submit Document Feedback Copyright © 2023 Texas Instruments Incorporated

Product Folder Links: MCT8315A



7.3.10.4.3.2 IPD Release Mode

Two modes are available for configuring the way the MCT8315A stops driving the motor when the current threshold is reached. The recirculate (or brake) mode is selected if IPD_RLS_MODE = 0b. In this configuration, the low-side (LSC) MOSFET remains ON to allow the current to recirculate between the MOSFET (LSC) and body diode (LSA) (see \$\mathbb{R}\$ 7-24). Hi-Z mode is selected if IPD_RLS_MODE = 1b. In Hi-Z mode, both the high-side (HSA) and low-side (LSC) MOSFETs are turned OFF and the current recirculates through the body diodes back to the power supply (see \$\mathbb{R}\$ 7-25).

In the Hi-Z mode, the phase current has a faster settle-down time, but that can result in a voltage increase on V_M . The user must manage this with an appropriate selection of either a clamp circuit or by providing sufficient capacitance between V_M and PGND to absorb the energy. If the voltage surge cannot be contained or if it is unacceptable for the application, recirculate mode must be used. When using the recirculate mode, select the IPD_CLK_FREQ appropriately to give the current in the motor windings enough time to decay to 0-A before the next IPD phase pattern is applied.

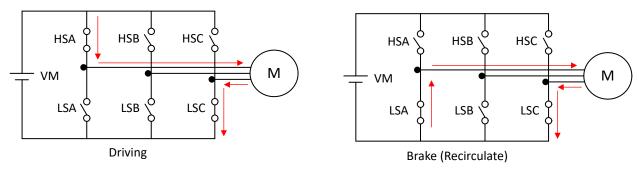


图 7-24. IPD Release Mode - Brake (0b)



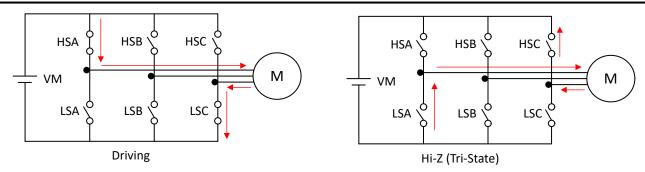


图 7-25. IPD Release Mode - Tristate (1b)

7.3.10.4.3.3 IPD Advance Angle

After the initial position is detected, the MCT8315A begins driving the motor in open loop at an angle specified by IPD ADV ANGLE.

Advancing the drive angle anywhere from 0° to 180° results in positive torque. Advancing the drive angle by 90° results in maximum initial torque. Applying maximum initial torque could result in uneven acceleration to the rotor. Select the IPD_ADV_ANGLE to allow for smooth acceleration in the application (see 8 7-26).

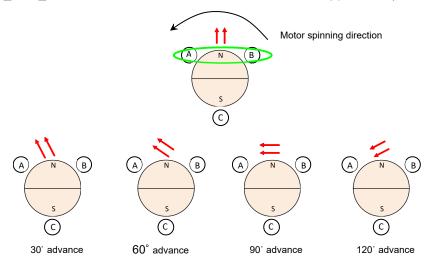


图 7-26. IPD Advance Angle

7.3.10.4.4 Slow First Cycle Startup

Slow First Cycle start-up is enabled by configuring MTR_STARTUP to 11b. In slow first cycle start-up, the MCT8315A starts motor commutation at a frequency defined by SLOW_FIRST_CYCLE_FREQ. The frequency configured is used only for first cycle, and then the motor commutation follows acceleration profile configured by open loop acceleration coefficients A1 and A2. The slow first cycle frequency has to be configured to be slow enough to allow motor to synchronize with the commutation sequence. This mode is useful when fast startup is desired as it significantly reduces the align time.

7.3.10.4.5 Open loop

Upon completing the motor position initialization with either align, double align, IPD or slow first cycle, the MCT8315A begins to accelerate the motor in open loop. During open loop, fixed duty cycle is applied and the cycle by cycle current limit functionality is used to regulate the current.

In MCT8315A, open loop current limit threshold is selected through OL_ILIMIT_CONFIG and is set either by CBC_ILIMIT or OL_ILIMIT based on the configuration of OL_ILIMIT_CONFIG. Open loop duty cycle is configured through OL_DUTY. While the motor is in open loop, speed (and commutation instants) is determined by 方程式 4. In MCT8315A, open loop acceleration coefficients, A1 and A2 are configured through OL_ACC_A1

Copyright © 2023 Texas Instruments Incorporated

and OL_ACC_A2 respectively. The function of the open-loop operation is to drive the motor to a speed at which the motor generates sufficient BEMF to allow the BEMF zero-crossing based commutation control to accurately drive the motor.

Speed (t) = A1 * t + 0.5 * A2 *
$$t^2$$
 (4)

7.3.10.4.6 Transition from Open to Closed Loop

MCT8315A has an internal mechanism to determine the motor speed for transition from open loop commutation to BEMF zero crossing based closed loop commutation. This feature of automatically deciding the open to closed handoff speed can be enabled by configuring AUTO_HANDOFF to 1b. If AUTO_HANDOFF is set to 0b, the open to closed loop handoff speed needs to be configured by OPN_CL_HANDOFF_THR. The closed loop in this section does not refer to closed speed loop - it refers to the commutation control changing from open loop (equation based) to closed loop (BEMF zero crossing based).

7.3.11 Closed Loop Operation

In closed loop operation, the MCT8315A drives the motor using trapezoidal commutation. The commutation instant is determined by the BEMF zero crossing on the phase which is not driven (Hi-Z). The duty cycle of the applied motor voltage is determined by DUTY OUT (see Speed Control).

7.3.11.1 120° Commutation

In 120° commutation, each phase is driven for 120° and is Hi-Z for 60° within each half electrical cycle as shown in \boxtimes 7-27. In 120° commutation there are six different commutation states. 120° commutation can be configured by setting COMM_CONTROL to 00b. MCT8315A supports different modulation modes with 120° commutation which can be configured through PWM_MODUL.

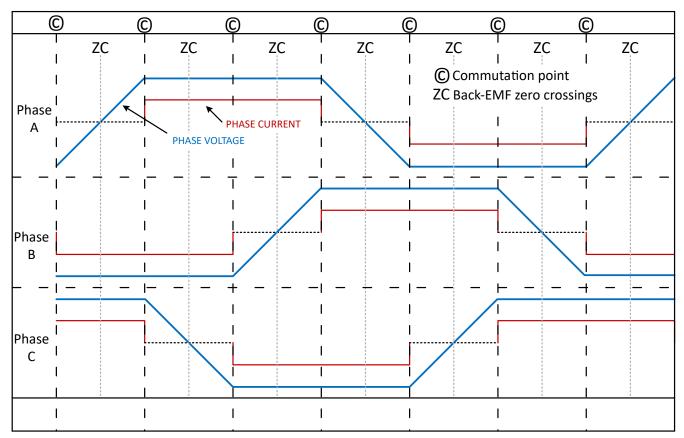


图 7-27. 120° commutation

7.3.11.1.1 High-Side Modulation

High-side modulation can be configured by setting PWM_MODUL to 00b. In high-side modulation, for a given commutation state, one of the high-side FETs is switching with the commanded duty cycle DUTY_OUT, while the low-side FET is ON with 100% duty cycle (see

7-28).

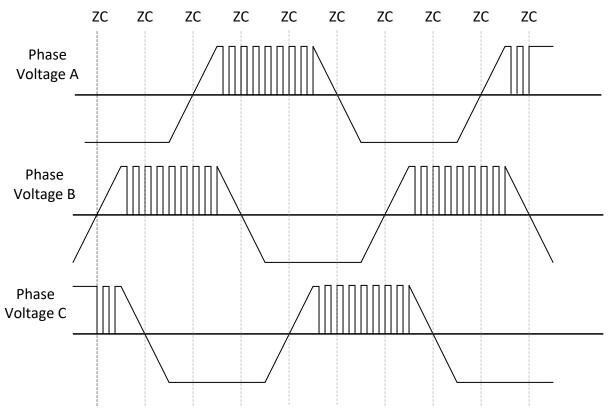


图 7-28. 120° commutation in High Side Modulation Mode

7.3.11.1.2 Low-Side Modulation

Low-side modulation can be configured by setting PWM_MODUL to 01b. In low-side modulation, for a given commutation state, one of the low-side FETs is switching with the commanded duty cycle DUTY_OUT, while the high-side FET is ON with 100% duty cycle (see \$\mathbb{Z}\$ 7-29).

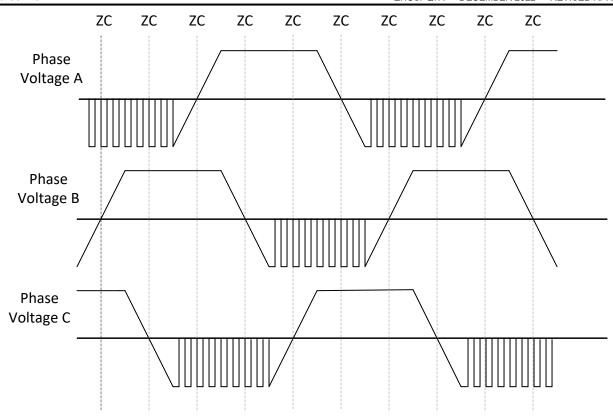


图 7-29. 120 ° commutation in Low Side Modulation Mode

7.3.11.1.3 Mixed Modulation

Mixed modulation can be configured by setting PWM_MODUL to 10b. In mixed modulation, MCT8315A dynamically switches between high and low-side modulation (see 图 7-30). The switching losses are distributed evenly amongst the high and low-side MOSFETs in mixed modulation mode.



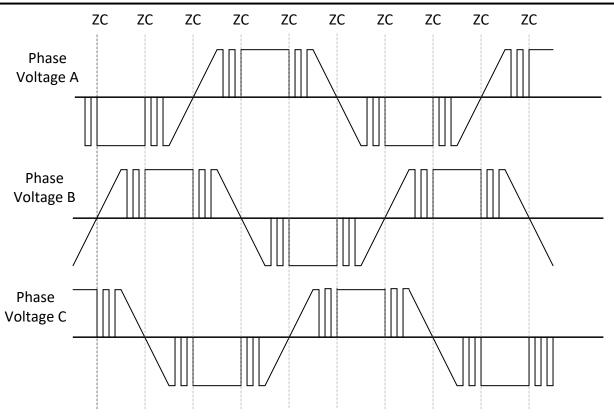


图 7-30. 120° commutation in Mixed Modulation Mode

7.3.11.2 Variable Commutation

Variable commutation can be configured by setting COMM_CONTROL to 01b. 120° commutation may result in acoustic noise due to the long Hi-Z period causing some torque ripple in the motor. In order to reduce this torque ripple and acoustic noise, the MCT8315A uses variable commutation to reduce the phase current ripple at commutation by extending 120° driving time and gradually decreasing duty cycle prior to entering Hi-Z state. In this mode, the phase is Hi-Z between 30° and 60° and this window size is dynamically adjusted based on speed. A smaller window size will typically give better acoustic performance.

8 7-31 shows 150° commutation with 30° window size.

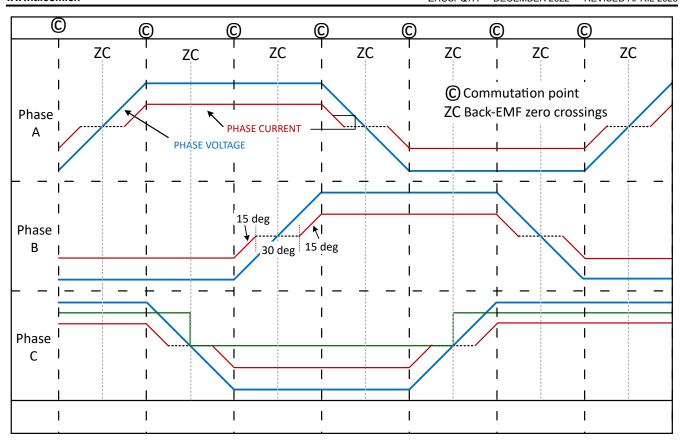


图 7-31. 150° commutation

备注

Different modulation modes are supported only with 120° commutation; variable commutation uses mixed modulation mode only.

7.3.11.3 Lead Angle Control

To achieve the best efficiency, it is often desirable to control the drive state of the motor so that the motor phase current is aligned with the motor BEMF voltage. MCT8315A provides the option to advance or delay the phase voltage from the commutation point by adjusting the lead angle. The lead angle can be adjusted to obtain optimal efficiency. This can be accomplished by operating the motor at constant speed and load conditions and adjusting the lead angle (LD_ANGLE) until the minimum current is achieved. The MCT8315A has the capability to apply both positive and negative lead angle (by configuring LD_ANGLE_POLARITY) as shown in $\boxed{8}$ 7-32

Lead angle can be calculated by $\{LD_ANGLE \ x \ 0.12\}^{\circ}$; for example, if the LD_ANGLE is 0x1E and LD_ANGLE_POLARITY is 1b, then a lead angle of $+3.6^{\circ}$ (advance) is applied. If LD_ANGLE_POLARITY is 0b, then a lead angle of -3.6° (delay) is applied.

备注

For 120° commutation, the negative lead angle is limited to -20°; any lead angle lower than that will be clamped to -20°.

For variable commutation, negative lead angle is not supported and positive lead angle is limited to +15°. Anything configured higher than +15° or lower than 0° will be clamped to 15° and 0° respectively.



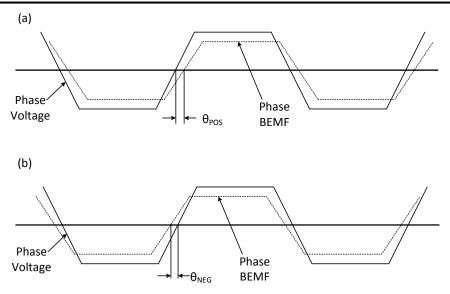


图 7-32. Positive and Negative Lead Angle Definition

7.3.11.4 Closed loop accelerate

To prevent sudden changes in the torque applied to the motor which could result in acoustic noise, the MCT8315A device provides the option of limiting the maximum rate at which the speed command can change. The closed loop acceleration rate parameter sets the maximum rate at which the speed command changes (shown in 87-33). In the MCT8315A, closed loop acceleration rate is configured through CL ACC.

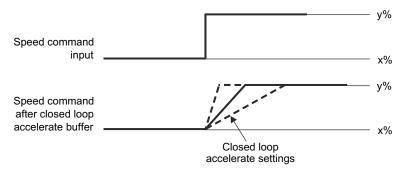


图 7-33. Closed loop accelerate

7.3.12 Speed Loop

MCT8315A has a speed loop option which can be used to maintain constant speed under varying operating conditions. Speed loop is enabled by setting CLOSED_LOOP_MODE to 01b. K_p and K_i coefficients are configured through SPD_POWER_KP and SPD_POWER_KI. The output of speed loop (SPEED_PI_OUT) is used to generate the DUTY_OUT (see $\boxed{8}$ 7-13). The PI controller output upper (V_{MAX}) and lower bound (V_{MIN}) saturation limits are configured through SPD_POWER_V_MAX and SPD_POWER_V_MIN respectively. When output of the speed loop saturates, the integrator is disabled to prevent integral wind-up. The speed loop PI controller is as in $\boxed{8}$ 7-34.

SPEED_REF is derived from duty command input and maximum motor speed (MAX_SPEED) configured by user (see 方程式 5). In speed loop mode, minimum SPEED REF is set by MIN DUTY * MAX SPEED.

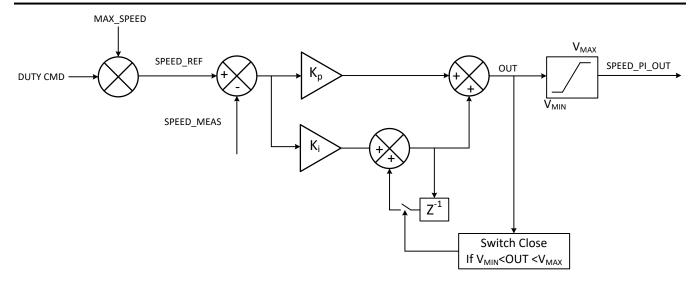


图 7-34. Speed Loop

7.3.13 Input Power Regulation

MCT8315A provides an option of regulating the (input) power instead of motor speed - this input power regulation can be done in two modes, namely, closed loop power control and power limit control. Input power regulation (instead of motor speed) mode is selected by setting CLOSED_LOOP_MODE to 10b. This should be accompanied by setting CONST_POWER_MODE to 01b for closed loop power control or to 10b for power limit control. In either of the power regulation modes, the maximum power that MCT8315A can draw from the DC input supply is set by MAX_POWER - the power reference (POWER_REF in 图 7-35) varies as function of the duty command input (DUTY CMD) and MAX_POWER as given by 方程式 6. The hysteresis band for the power reference is set by CONST_POWER_LIMIT_HYST. In both the power regulation modes, the minimum power reference is set by MIN_DUTY x MAX_POWER.

In both the power regulation modes, MCT8315A uses the same PI controller parameters as in the speed loop mode. K_p and K_i coefficients are configured through SPD_POWER_KP and SPD_POWER_KI. The PI controller output upper (V_{MAX}) and lower bound (V_{MIN}) saturation limits are configured through SPD_POWER_V_MAX and SPD_POWER_V_MIN respectively. The key difference between closed loop power control and power limit control is in when the PI controller decides the DUTY OUT (see \boxtimes 7-13) applied to FETs. In closed loop power control, DUTY OUT is always equal to POWER_PI_OUT from the PI controller output in \boxtimes 7-35. However, in power limit control, the PI controller decides the DUTY OUT only if POWER_MEAS > POWER_REF + CONST_POWER_LIMIT_HYST. If POWER_MEAS < POWER_REF + CONST_POWER_LIMIT_HYST, the PI controller is not used and DUTY OUT is equal to DUTY CMD. Essentially, in closed loop power control, input power is always actively regulated to POWER_REF whereas, in power limit control, input power is only limited to POWER_REF and not actively regulated to POWER_REF. When output of the power PI loop saturates, the integrator is disabled to prevent integral wind-up.



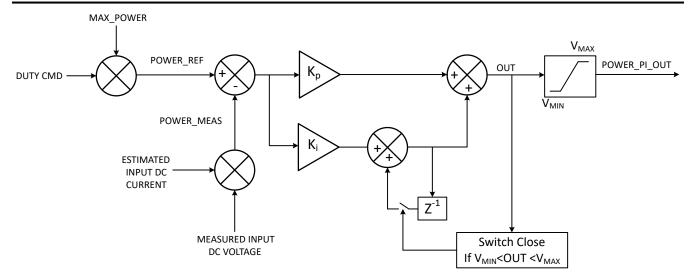


图 7-35. Power Regulation

7.3.14 Anti-Voltage Surge (AVS)

When a motor is driven, energy is transferred from the power supply into the motor. Some of this energy is stored in the form of inductive and mechanical energy. If the speed command suddenly drops such that the BEMF voltage generated by the motor is greater than the voltage that is applied to the motor, then the mechanical energy of the motor is returned to the power supply and the V_M voltage surges. The AVS feature works to prevent this voltage surge on V_M and can be enabled by setting AVS_EN to 1b. AVS can be disabled by setting AVS_EN to 0b. When AVS is disabled, the deceleration rate is configured through CL_DEC_CONFIG

7.3.15 Output PWM Switching Frequency

MCT8315A provides the option to configure the output PWM switching frequency of the MOSFETs through PWM_FREQ_OUT. PWM_FREQ_OUT has range of 5-100 kHz. In order to select optimal output PWM switching frequency, user has to make tradeoff between the current ripple and the switching losses. Generally, motors having lower L/R ratio require higher PWM switching frequency to reduce current ripple.

7.3.16 Fast Start-up (< 50 ms)

MCT8315A has the capability to accelerate a motor from 0 to 100% speed within 50ms. This will only work on low inertia motors which are capable of this level of acceleration. In order to achieve fast start-up, the commutation instant detection needs to be configured to hybrid mode by setting INTEG_ZC_METHOD to 1b. In the hybrid mode, the commutation instant is determined by using back-EMF integration at low-medium speeds and by using built-in comparators (BEMF zero crossing) at higher speeds. MCT8315A automatically transitions between back-EMF integration and comparator based commutation depending on the motor speed as shown in 7-36. The duty cycles for commutation method transition at lower speeds are directly configured by INTEG_DUTY_THR_LOW and INTEG_DUTY_THR_HIGH and at higher speeds are indirectly configured by INTEG_CYC_THR_LOW and INTEG_CYC_THR_HIGH. These duty cycles should be configured to provide a sufficient hysteresis band to avoid repeated commutation method transitions near threshold duty cycles. The BEMF threshold values used to determine the commutation instant in the back-EMF integration method are configured by BEMF_THRESHOLD1 and BEMF_THRESHOLD2.

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

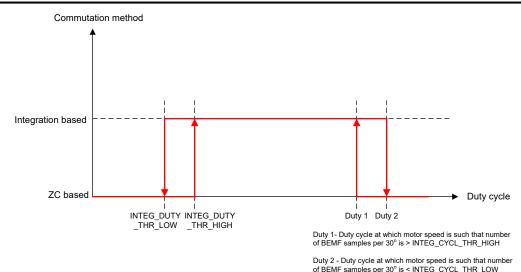


图 7-36. Commutation Method Transition

7.3.16.1 BEMF Threshold

₹ 7-37 shows the three-phase voltages during 120° trapezoidal operation. It is seen that one of the phases will always be floating within a 60° commutation interval and MCT8315A integrates this floating phase voltage (which denotes the motor back-EMF) in the back-EMF integration method to detect the next commutation instant. The floating phase voltage can either be increasing or decreasing and the algorithm starts the integration after the zero cross detection in order to eliminate integration errors due to variable degauss time. The floating phase voltage is periodically sampled (after zero cross) and added (discrete form of integration). BEMF threshold (BEMF_THRESHOLD1 and BEMF_THRESHOLD2) value is set such that the integral value of the floating phase voltage crosses the BEMF_THRESHOLD1 or BEMF_THRESHOLD2 value at (or very near) to the commutation instant. BEMF_THRESHOLD1 is the threshold for rising floating phase voltage and BEMF_THRESHOLD2 is the threshold for falling floating phase voltage. If BEMF_THRESHOLD2 is set to 0, then BEMF_THRESHOLD1 is used as the threshold for both rising and falling floating phase voltage.



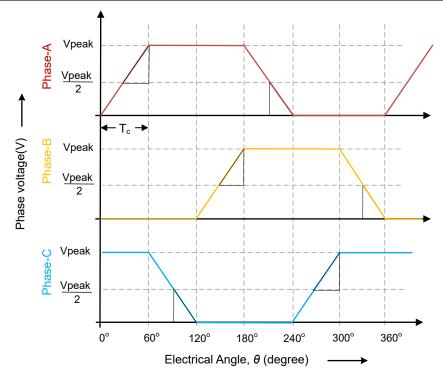


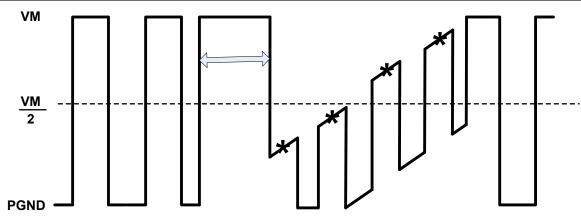
图 7-37. Back-EMF integration using floating phase voltage

In 图 7-37, Vpeak is the peak-peak value of the back-EMF, Vpeak/2 denotes the zero cross of the back-EMF and Tc is the commutation interval or time period of the 60° window. The highlighted triangle in each 60° window is the integral value of back-EMF used by the algorithm to determine the commutation instant. This integral value, which can be approximated as the area of the highlighted triangle, is given by 方程式 7.

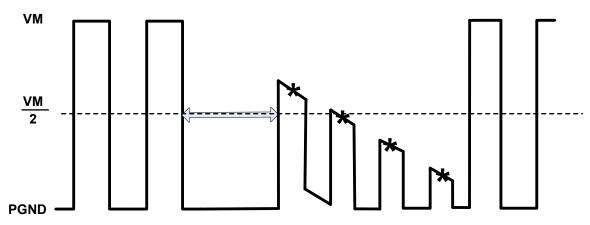
See for an example application on setting the BEMF threshold.

7.3.16.2 Dynamic Degauss

In MCT8315A, the degauss time can be dynamically computed after the commutation for a precise detection of the zero crossing instant. This is done by enabling the dynamic degauss feature (DYN_DEGAUSS_EN is set to 1b). This feature allows the motor control algorithm to capture the zero crossing instant after the outgoing (floating) phase voltage is completely settled; that is, when the outgoing phase current has decayed to zero and the outgoing (floating) phase voltage is not clamped (to either VM or PGND) and represents the true back-EMF. This accurate measurement of zero cross instant allows fast acceleration of the motors (< 50ms) using MCT8315A.



Degauss time(shown by double-sided arrow) after commutation during which the outgoing(floating) phase voltage is clamped to VM(by negative outgoing phase current) during increasing back-EMF; sampling of back-EMF(denoted by *) should start after degauss time is over for accurate zero cross instant detection



Degauss time(shown by double-sided arrow) after commutation during which the outgoing(floating) phase voltage is clamped to PGND(by positive outgoing phase current) during decreasing back-EMF; sampling of back-EMF(denoted by *) should start after degauss time is over for accurate zero cross instant detection

图 7-38. Degauss Time

7.3.17 Fast Deceleration

MCT8315A has the capability to decelerate a motor quickly (100% to 10% speed reduction within tens of ms) without pumping energy back into the input DC supply using the fast deceleration feature in conjunction with the AVS feature. The fast deceleration feature can be enabled by setting FAST_DECEL_EN to 1b; AVS_EN should be set to 1b to prevent energy pump-back into the input DC supply. This combination enables a linear braking effect resulting in a fast and smooth speed reduction without energy pump-back into the DC input supply. This feature combination can also be used during reverse drive (see Reverse Drive) or motor stop (see Active Spin-Down) to reduce the motor speed quickly without energy pump-back into the DC input supply.

The deceleration time can be controlled by appropriately configuring the current limit during deceleration, FAST_DECEL_CURR_LIM. A higher current limit results in a lower deceleration time and vice-versa. A higher than necessary current limit setting may result in motor stall faults, at low target speeds, due to excessive braking torque. This can also lead to higher losses in MCT8315A, especially in repeated acceleration-deceleration cycles. Therefore, the FAST_DECEL_CURR_LIM should be chosen appropriately, so as to decelerate within the required time without resulting in stall faults or overheating.

FAST_BRK_DELTA is used to configure the target speed hysteresis band to exit the fast deceleration mode and re-enter motoring mode when motor reaches the target speed. For example, if FAST_BRK_DELTA is set to 1%,



the fast deceleration is deemed complete when motor speed reaches within 1% of target speed. Setting a higher value for FAST_BRK_DELTA may eliminate motor stall faults, especially when high FAST_DECEL_CURR_LIM values are used. Setting a higher value for FAST_BRK_DETLA will also result in higher speed error between target speed and motor speed at the end of deceleration mode - motor will eventually reach the target speed once motoring mode is resumed. FAST_DECEL_CURR_LIM and FAST_BRK_DELTA should be configured in tandem to optimize between lower deceleration time and reliable (no stall faults) deceleration profile.

FAST_DEC_DUTY_THR configures the speed below which fast deceleration will be implemented. For example, if FAST_DEC_DUTY_THR is set to 70%, any deceleration from speeds above 70% will not use fast deceleration until the speed goes below 70%. FAST_DEC_DUTY_WIN is used to set the minimum deceleration window (initial speed - target speed) below which fast deceleration will not be implemented. For example, if FAST_DEC_DUTY_WIN is set to 15% and 50%->40% deceleration command is received, fast deceleration is not used to reduce the speed from 50% to 40% since the deceleration window (10%) is smaller than FAST_DEC_DUTY_WIN.

MCT8315A provides a dynamic current limit option during fast deceleration to improve the stability of fast deceleration when braking to very low speeds; using this feature the current limit during fast deceleration can be reduced as the motor speed decreases. This feature can be enabled by setting DYNAMIC_BRK_CURR to 1b. The current limit at the start of fast deceleration (at FAST_DEC_DUTY_THR) is configured by FAST_DECEL_CURR_LIM and the current limit at zero speed is configured by DYN_BRK_CURR_LOW_LIM; the current limit during fast deceleration varies linearly with speed between these two operating points when dynamic current limit is enabled. If dynamic current limit is disabled, current limit during fast deceleration stays constant and is configured by FAST_DECEL_CURR_LIM.

7.3.18 Active Demagnetization

MCT8315A has smart rectification features (active demagnetization) which decreases power losses in the device by reducing diode conduction losses. When this feature is enabled, the device automatically turns ON the corresponding MOSFET whenever it detects diode conduction. This feature can be enabled by configuring EN_ASR.

备注

EN_ASR needs to be set to 1b to enable active demagnetization.

The MCT8315A device includes a high-side (AD_HS) and low-side (AD_LS) comparator which detects the negative flow of current in the device on each half-bridge. The AD_HS comparator compares the sense-FET output with the supply voltage (VM) threshold, whereas the AD_LS comparator compares with the ground (0-V) threshold. Depending upon the flow of current from OUTx to VM or PGND to OUTx, the AD_HS or the AD_LS comparator trips. These comparator outputs provide a reference point for the operation of active demagnetization feature.

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

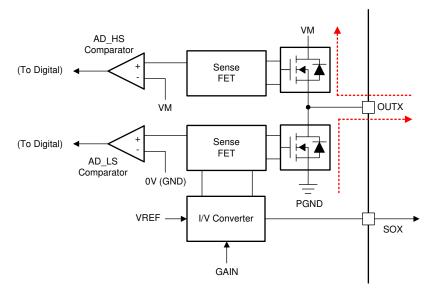


图 7-39. Active Demagnetization Operation

7.3.18.1 Active Demagnetization in action

₹ 7-40 shows the operation of active demagnetization during the BLDC motor commutation. As shown in ₹ 7-40 (a), the current is flowing from HA to LC in one commutation state. During the commutation change over as shown in ₹ 7-40 (b), the HB FET is turned ON (and HA FET is turned OFF), and the commutation current (due to motor inductance) in OUTA flows through the body diode of LA. This results in a higher diode loss depending on the commutation current. This commutation loss is reduced by turning on the LA FET for the commutation time as shown in ₹ 7-40 (c).

Similarly, the active demagnetization operation of a high-side FET is realized in 图 7-40 (d), (e) and (f).



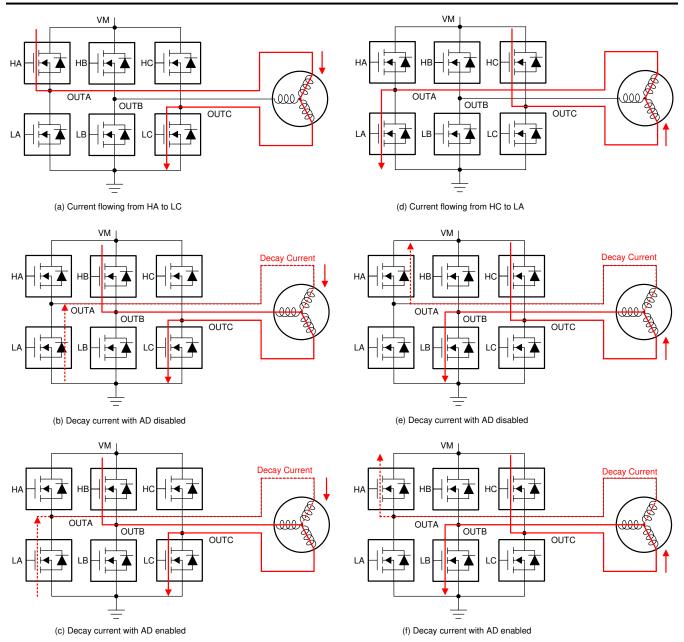
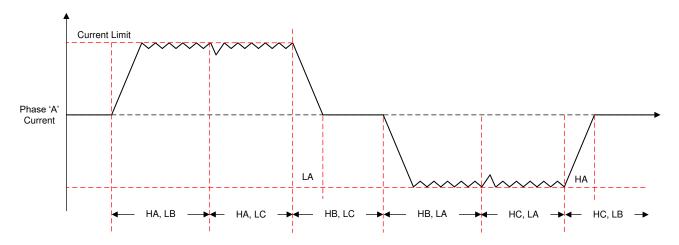


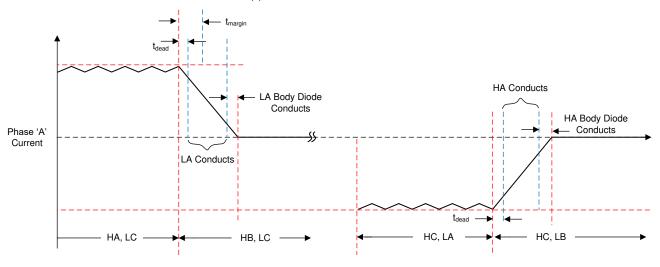
图 7-40. Active Demagnetization in BLDC Motor Commutation

⊠ 7-41 (a) shows the BLDC motor phase current waveforms with Active Demagnetization with trapezoidal commutation. This figure shows the operation of various switches in a single commutation cycle.

图 7-41 (b) shows the zoomed waveform of commutation cycle.



(a) Commutation current of Phase "A"



(b) Zoomed waveform of Active Demagnetization

图 7-41. Current Waveforms with Active Demagnetization

7.3.19 Motor Stop Options

The MCT8315A provides different options for stopping the motor which can be configured by MTR STOP.

7.3.19.1 Coast (Hi-Z) Mode

Coast (Hi-Z) mode is configured by setting MTR_STOP to 000b. When motor stop command is received, the MCT8315A will transition into a high impedance (Hi-Z) state by turning off all MOSFETs. When the MCT8315A transitions from driving the motor into a Hi-Z state, the inductive current in the motor windings continues to flow and the energy returns to the power supply through the body diodes in the MOSFET output stage (see example 37-42).



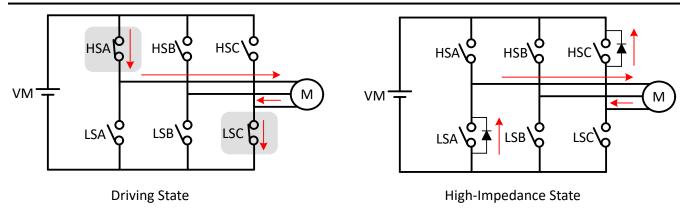


图 7-42. Coast (Hi-Z) Mode

In this example, current is applied to the motor through the high-side phase-A MOSFET (HSA) and returned through the low-side phase-C MOSFET (LSC). When motor stop command is received all 6 MOSFETs transition to Hi-Z state and the inductive energy returns to supply through body diodes of MOSFETs LSA and HSC.

7.3.19.2 Recirculation Mode

Recirculation mode is configured by setting MTR_STOP to 001b. In order to prevent the inductive energy from returning to DC input supply during motor stop, the MCT8315A allows current to circulate within the MOSFETs by selectively turning OFF some of the active (ON) MOSFETs for a certain time (auto calculated recirculation time to allow the inductive current to decay to zero) before transitioning into Hi-Z by turning OFF the remaining MOSFETs.

If high-side modulation was active, prior to motor stop command, then the high-side MOSFET is turned OFF on receiving motor stop command and the current recirculation takes place through low-side MOSFET (see example 37-43). Once the recirculation time lapses, the low-side MOSFET also turns OFF and all MOSFETs are in Hi-Z state.

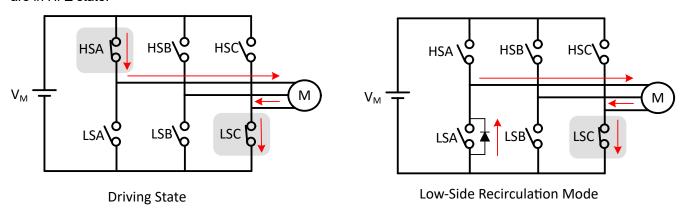


图 7-43. Low-Side Recirculation

If low-side modulation was active, prior to motor stop command, then the low-side MOSFET is turned OFF on receiving motor stop command and the current recirculation takes place through high-side MOSFET (see example 🖺 7-44). Once the recirculation time lapses, the high-side MOSFET also turns OFF and all MOSFETs are in Hi-Z state

Product Folder Links: MCT8315A

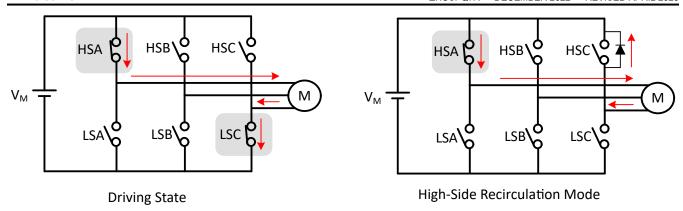


图 7-44. High-Side Recirculation

7.3.19.3 Low-Side Braking

Low-side braking mode is configured by setting MTR_STOP to 010b. When a motor stop command is received, the output speed is reduced to a value defined by ACT_SPIN_BRK_THR prior to turning all low-side MOSFETs ON (see example 7-45) for a time configured by MTR_STOP_BRK_TIME. If the motor speed is below ACT_SPIN_BRK_THR prior to receiving stop command, then the MCT8315A transitions directly into the brake state. After applying the brake for MTR_STOP_BRK_TIME, the MCT8315A transitions into the Hi-Z state by turning OFF all MOSFETs.

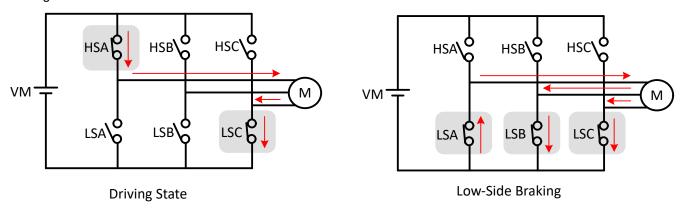


图 7-45. Low-Side Braking

The MCT8315A can also enter low-side braking through BRAKE pin input. When BRAKE pin is pulled to HIGH state, the output speed is reduced to a value defined by BRAKE_DUTY_THRESHOLD prior to turning all low-side MOSFETs ON. In this case, MCT8315A stays in low-side brake state till BRAKE pin changes to LOW state.

7.3.19.4 High-Side Braking

High-side braking mode is configured by setting MTR_STOP to 011b. When a motor stop command is received, the output speed is reduced to a value defined by ACT_SPIN_BRK_THR prior to turning all high-side MOSFETs ON (see example 7-46) for a time configured by MTR_STOP_BRK_TIME. If the motor speed is below ACT_SPIN_BRK_THR prior to receiving stop command, then the MCT8315A transitions directly into the brake state. After applying the brake for MTR_STOP_BRK_TIME, the MCT8315A transitions into Hi-Z state by turning OFF all MOSFETs.



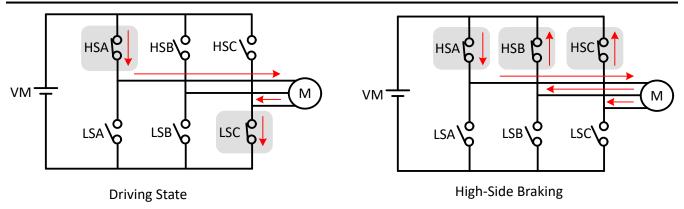


图 7-46. High-Side Braking

7.3.19.5 Active Spin-Down

Active spin down mode is configured by setting MTR_STOP to 100b. When motor stop command is received, MCT8315A reduces duty cycle to ACT_SPIN_BRK_THR and then transitions to Hi-Z state by turning all MOSFETs OFF. The advantage of this mode is that by reducing duty cycle, the motor is decelerated to a lower speed thereby reducing the phase currents before entering Hi-Z. Now, when motor transitions into Hi-Z state, the energy transfer to power supply is reduced. The threshold ACT_SPIN_BRK_THR needs to configured high enough for MCT8315A to not lose synchronization with the motor.

7.3.20 FG Configuration

The MCT8315A provides information about the motor speed through the Frequency Generate (FG) pin and provides an FG output until the motor back-EMF falls below FG BEMF THR.

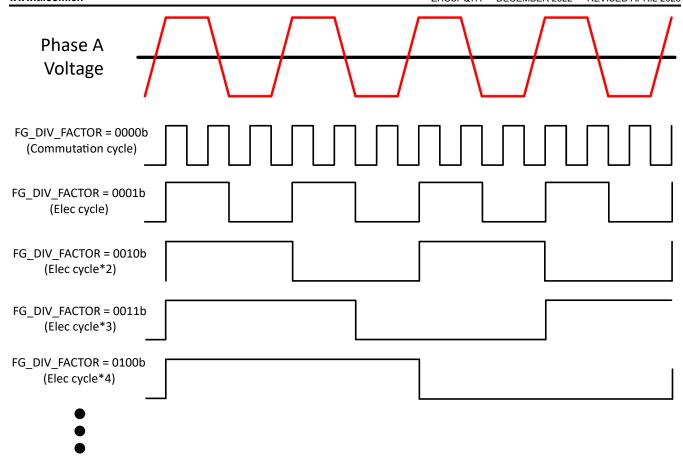
7.3.20.1 FG Output Frequency

The FG output frequency can be configured by FG_DIV_FACTOR. In MCT8315, FG toggles once every commutation cycle if FG_DIV_FACTOR is set to 0000b. Many applications require the FG output to provide a pulse for every mechanical rotation of the motor. Different FG_DIV_FACTOR configurations can accomplish this for 2-pole up to 30-pole motors.

₹ 7-47 shows the FG output when MCT8315A has been configured to provide FG pulses once every commutation cycle (electrical cycle/3), once every electrical cycle (2 poles), once every two electrical cycle (4 poles), once every three electrical cycles (6 poles), once every four electrical cycles (8 poles), and so on.

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated



7.3.20.2 FG Open-Loop and Lock Behavior

During closed loop operation, the driving speed (FG output frequency) and the actual motor speed are synchronized. During open-loop operation, however, FG may not reflect the actual motor speed. During motor-lock condition, the FG output is driven high.

图 7-47. FG Frequency Divider

The MCT8315A provides three options for controlling the FG output during open loop, as shown in ⊠ 7-48. The selection of these options is configured through FG SEL.

If FG SEL is set to,

- 00b: When in open loop, the FG output is based on the driving frequency.
- 01b: When in open loop, the FG output will be driven high.
- 10b: The FG output will reflect the driving frequency during open loop operation in the first motor start-up cycle after power-on, sleep/standby; FG will be held high during open loop operation in subsequent start-up cycles.



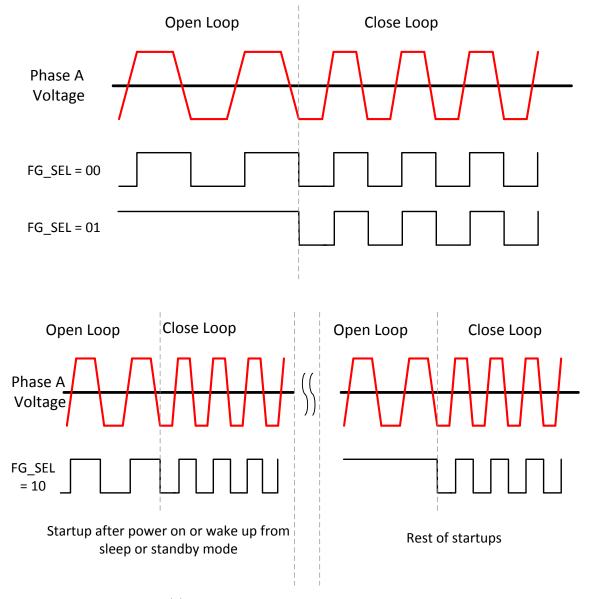


图 7-48. FG Behavior During Open Loop

7.3.21 Protections

The MCT8315A is protected from a host of fault events including motor lock, VM undervoltage, AVDD undervoltage, buck undervoltage, charge pump undervoltage, overtemperature and overcurrent events. 表 7-2 summarizes the response, recovery modes, power stage status, reporting mechanism for different faults.

备注

- 1. Actionable faults (latched or retry) are always reported on nFAULT pin (as logic low).
- 2. Actionable faults (latched or retry) are reported on ALARM pin (as logic high) when ALARM_PIN_EN is set to 1b.
- 3. Report only faults are reported on nFAULT (as logic low) only when ALARM_PIN_EN is set to 0b. When ALARM_PIN_EN is set to 1b, report only faults are reported only on ALARM pin (as logic high) while nFAULT stays high (external pull-up).
- 4. Priority order for multi-fault scenarios is latched > slower retry time fault > faster retry time fault > report only fault. For example, if a latched and retry fault happen simultaneously, the device stays latched in fault mode until user issues clear fault command by writing 1b to CLR_FLT. If two retry faults with different retry times happen simultaneously, the device retries only after the longer (slower) retry time lapses.
- 5. Recovery refers only to state of FETs (Hi-Z or active) after the fault condition is removed. Automatic indicates that the device automatically recovers (and FETs are active) when retry time lapses after the fault condition is removed. Latched indicates that the device waits for clearing of fault condition (by writing 1b to CLR_FLT bit) to make the FETs active again.
- 6. Actionable (latched or retry) faults can take up to 200-ms after fault response (FETs in Hi-Z) to be reported on nFAULT pin (as logic low), ALARM pin (as logic high) and fault status registers.
- 7. Latched faults can take up to 200-ms after CLR_FLT command is issued (over I²C) to be cleared.

表 7-2. Fault Action and Response

A 1-2. I dult Action and Response						
FAULT	CONDITION	CONFIGURATION	REPORT	FETs	DIGITAL	RECOVERY
VM undervoltage	V _{VM} < V _{UVLO}	_	_	Hi-Z	Disabled	Automatic: V _{VM} > V _{UVLO}
AVDD undervoltage	V _{AVDD} < V _{AVDD_UV}	_	_	Hi-Z	Disabled	Automatic: V _{AVDD} > V _{AVDD_UV}
Buck undervoltage (BUCK_UV)	V _{FB_BK} < V _{BK_UV}	_	_	Active/Hi-Z	Active/Disabled	Automatic: V _{FB_BK} > V _{BK_UV}
Charge pump undervoltage (VCP_UV)	V _{CP} < V _{CPUV}	_	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Hi-Z	Active	Automatic: V _{VCP} > V _{CPUV}
	V _{VM} > V _{OVP}	OVP_EN = 0b	None	Active	Active	No action
Over Voltage Protection (OVP)		OVP_EN = 1b	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Hi-Z	Active	Automatic: V _{VM} < V _{OVP}
	I _{PHASE} > I _{OCP}	OCP_MODE = 00b	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
Over Current Protection (OCP)		OCP_MODE = 01b	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Hi-Z	Active	Retry: t _{RETRY}
		OCP_MODE = 10b	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Active	Active	No action
		OCP_MODE = 11b	None	Active	Active	No action
Buck Overcurrent Protection (BUCK_OCP)	I _{BK} > I _{BK_OCP}	_	_	Hi-Z	Disabled	Automatic



表 7-2. Fault Action and Response (continued)

FAULT	CONDITION	CONFIGURATION	REPORT	FETs	DIGITAL	RECOVERY
Motor Lock (MTR_LCK)	Motor lock: Abnormal Speed; No Motor Lock; Loss of Sync	MTR_LCK_MODE = 00000b or 0001b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
		MTR_LCK_MODE = 0010b	nFAULT and CONTROLLER_FA ULT_STATUS register	High side brake	Active	Latched: CLR_FLT
		MTR_LCK_MODE = 0011b	nFAULT and CONTROLLER_FA ULT_STATUS register	Low side brake	Active	Latched: CLR_FLT
		MTR_LCK_MODE = 0100b or 0101b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Retry: t _{LCK_RETRY}
		MTR_LCK_MODE = 0110b	nFAULT and CONTROLLER_FA ULT_STATUS register	High side brake	Active	Retry: t _{LCK_RETRY}
		MTR_LCK_MODE = 0111b	nFAULT and CONTROLLER_FA ULT_STATUS register	Low side brake	Active	Retry: t _{LCK_RETRY}
		MTR_LCK_MODE = 1000b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active	Active	No action
		MTR_LCK_MODE = 1xx1b	None	Active	Active	No action
	V _{SOX} > CBC_ILIMIT	CBC_ILIMIT_MODE = 0000b	nFAULT and CONTROLLER_FA ULT_STATUS register	Recirculation	Active	Automatic: Next PWM cycle
		CBC_ILIMIT_MODE = 0001b	None	Recirculation	Active	Automatic: Next PWM cycle
Cycle by Cycle Current Limit (CBC_ILIMIT)		CBC_ILIMIT_MODE = 0010b	nFAULT and CONTROLLER_FA ULT_STATUS register	Recirculation	Active	Automatic: V _{SOX} < CBC_ILIMIT
		CBC_ILIMIT_MODE = 0011b	None	Recirculation	Active	Automatic: V _{SOX} < CBC_ILIMIT
		CBC_ILIMIT_MODE = 0100b	nFAULT and CONTROLLER_FA ULT_STATUS register	Recirculation	Active	Automatic: PWM cycle > CBC_RETRY_PWM_CYC
		CBC_ILIMIT_MODE = 0101b	None	Recirculation	Active	Automatic: PWM cycle > CBC_RETRY_PWM_CYC
		CBC_ILIMIT_MODE= 0110b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active	Active	No action
		CBC_ILIMIT_MODE = 0111b, 1xxxb	None	Active	Active	No action

表 7-2. Fault Action and Response (continued)

表 7-2. Fault Action and Response (continued)						
FAULT	CONDITION	CONFIGURATION	REPORT	FETs	DIGITAL	RECOVERY
	V _{SOX} > LOCK_ILIMIT	LOCK_ILIMIT_MODE = 0000b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
		LOCK_ILIMIT_MODE = 0001b	nFAULT and CONTROLLER_FA ULT_STATUS register	Recirculation	Active	Latched: CLR_FLT
		LOCK_ILIMIT_MODE = 0010b	nFAULT and CONTROLLER_FA ULT_STATUS register	High-side brake	Active	Latched: CLR_FLT
		LOCK_ILIMIT_MODE = 0011b	nFAULT and CONTROLLER_FA ULT_STATUS register	Low-side brake	Active	Latched: CLR_FLT
Lock-Detection Current Limit		LOCK_ILIMIT_MODE = 0100b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Retry: t _{LCK_RETRY}
(LOCK_ILIMIT)		LOCK_ILIMIT_MODE = 0101b	nFAULT and CONTROLLER_FA ULT_STATUS register	Recirculation	Active	Retry: t _{LCK_RETRY}
		LOCK_ILIMIT_MODE = 0110b	nFAULT and CONTROLLER_FA ULT_STATUS register	High-side brake	Active	Retry: t _{LCK_RETRY}
		LOCK_ILIMIT_MODE = 0111b	nFAULT and CONTROLLER_FA ULT_STATUS register	Low-side brake	Active	Retry: t _{LCK_RETRY}
		LOCK_ILIMIT_MODE= 1000b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active	Active	No action
		LOCK_ILIMIT_MODE = 1xx1b	None	Active	Active	No action
IPD Timeout Fault	IPD TIME > 500ms (approx.), during IPD current ramp up or ramp down	IPD_TIMEOUT_FAULT_E N = 0b	_	Active	Active	No action
(IPD_T1_FAULT and IPD_T2_FAULT)		IPD_TIMEOUT_FAULT_E N = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Retry: t _{LCK_RETRY}
IPD Timeout Fault (IPD_T1_FAULT and IPD_T2_FAULT)	IPD TIME > 500ms (approx.), during IPD current ramp up or ramp down	_	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
IPD Frequency	IPD pulse before the current decay in previous IPD pulse	IPD_FREQ_FAULT_EN = 0b	_	Active	Active	No action
Fault 1		IPD_FREQ_FAULT_EN = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Retry: t _{LCK_RETRY}
IPD Frequency Fault (IPD_FREQ_FAULT)	IPD pulse before the current decay in previous IPD pulse	_	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
Maximum VM (overvoltage) fault	V _{VM} > MAX_VM_MOTOR, if MAX_VM_MOTOR ≠ 000b	MAX_VM_MODE = 0b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
		MAX_VM_MODE = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Automatic: (V _{VM} < MAX_VM_MOTOR - 1)-V
Minimum VM (undervoltage) fault	V _{VM} < MIN_VM_MOTOR, if MIN_VM_MOTOR ≠ 000b	MIN_VM_MODE = 0b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
		MIN_VM_MODE = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Automatic: (V _{VM} > MIN_VM_MOTOR + 0.5)-V



表 7-2. Fault Action and Response (continued)

FAULT	CONDITION	CONFIGURATION	REPORT	FETs	DIGITAL	RECOVERY
External Watchdog	Watchdog tickle does not arrive before configured time interval when EXT_WDT_EN =1b. Refer 节 7.5.5	EXT_WDT_FAULT_MOD E = 0b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active	Active	No action
		EXT_WDT_FAULT_MOD E = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Hi-Z	Active	Latched: CLR_FLT
Bus Current Limit	I _{VM} > BUS_CURRENT_LIMIT. Refer	BUS_CURRENT_LIMIT_E NABLE = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active; motor speed will be restricted to limit DC bus current	Active	Automatic: Speed restriction is removed when I _{VM} < BUS_CURRENT_LIMIT
Current Loop Saturation	Indication of current loop saturation due to lower V _{VM}	SATURATION_FLAGS_E N = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active; motor speed may not reach speed reference	Active	Automatic: motor will reach reference operating point upon exiting saturation
Speed Loop Saturation	Indication of speed loop saturation due to lower V _{VM} , lower ILIMIT setting etc.,	SATURATION_FLAGS_E N = 1b	nFAULT and CONTROLLER_FA ULT_STATUS register	Active; motor speed may not reach speed reference	Active	Automatic: motor will reach reference operating point upon exiting saturation
	T _J > T _{OTW}	OTW_REP = 0b	_	Active	Active	No action
Thermal warning (OTW)		OTW_REP = 1b	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Active	Active	Automatic: T _J < T _{OTW} - T _{OTW_HYS}
Thermal shutdown (TSD)	T _J > T _{TSD}	_	nFAULT and GATE_DRIVER_FA ULT_STATUS register	Hi-Z	Active	Automatic: T _J < T _{TSD} - T _{TSD_HYS}

Product Folder Links: MCT8315A

62

7.3.21.1 VM Supply Undervoltage Lockout

If at any time the input supply voltage on the VM pin falls lower than the V_{UVLO} threshold (VM UVLO falling threshold), all the integrated FETs, driver charge-pump and digital logic are disabled as shown in $\[mathbb{N}\]$ 7-49. MCT8315A goes into reset state whenever VM UVLO event occurs.

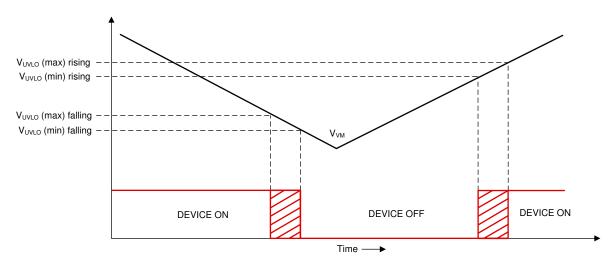


图 7-49. VM Supply Undervoltage Lockout

7.3.21.2 AVDD Undervoltage Lockout (AVDD UV)

If at any time the voltage on the AVDD pin falls lower than the V_{AVDD_UV} threshold, all the integrated FETs, driver charge-pump and digital logic controller are disabled. Since internal circuitry in MCT8315A is powered through the AVDD regulator, MCT8315A goes into reset state whenever AVDD UV event occurs.

7.3.21.3 BUCK Undervoltage Lockout (BUCK UV)

If at any time the input supply voltage on the FB_BK pin falls lower than the V_{BK_UVLO} threshold, both the high-side and low-side MOSFETs of the buck regulator are disabled . Since internal circuitry in MCT8315A is powered through the buck regulator, MCT8315A goes into reset state whenever buck UV event occurs.

7.3.21.4 VCP Charge Pump Undervoltage Lockout (CPUV)

If at any time the voltage on the VCP pin (charge pump) falls lower than the V_{CPUV} threshold, all the integrated FETs are disabled and the nFAULT pin is driven low. The DRIVER_FAULT and VCP_UV bits are set to 1b in the status registers. Normal operation resumes (driver operation and the nFAULT pin is released) when the VCP undervoltage condition clears. The VCP_UV bit stays set until cleared through the CLR_FLT bit.

7.3.21.5 Overvoltage Protection (OVP)

If at any time input supply voltage on the VM pins rises higher than V_{OVP} , all the integrated FETs are disabled and the nFAULT pin is driven low. The DRIVER_FAULT and OVP bits are set to 1b in the status registers. Normal operation resumes (driver operation and the nFAULT pin is released) when the OVP condition clears. The OVP bit stays set until cleared through the CLR_FLT bit. Setting the OVP_EN to 0b disables this protection feature.

The OVP threshold can be set to 22-V or 34-V based on the OVP_SEL bit.



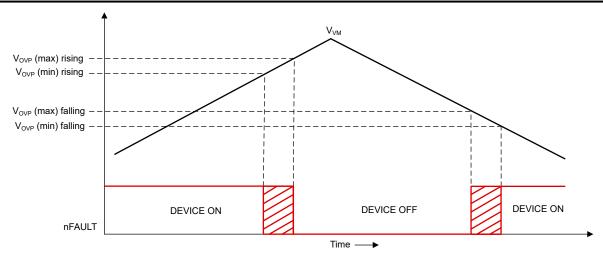


图 7-50. Over Voltage Protection

7.3.21.6 Overcurrent Protection (OCP)

MOSFET overcurrent event is sensed by monitoring the current flowing through the FETs. If the current across a FET exceeds the I_{OCP} threshold for longer than the deglitch time t_{OCP} , an OCP event is recognized and action is taken according to OCP_MODE. The I_{OCP} threshold is set through the OCP_LVL, t_{OCP} is set through OCP_DEG and the OCP_MODE can be configured in four different modes: latched shutdown, automatic retry, report only and disabled.

7.3.21.6.1 OCP Latched Shutdown (OCP_MODE = 00b)

When an OCP event happens in this mode, all MOSFETs are disabled and the nFAULT pin is driven low. The DRIVER_FAULT, OCP and corresponding FET's OCP bits are set to 1b in the status registers. Normal operation resumes (driver operation and the nFAULT pin is released) when the OCP condition clears and a clear fault command is issued through the CLR_FLT bit.

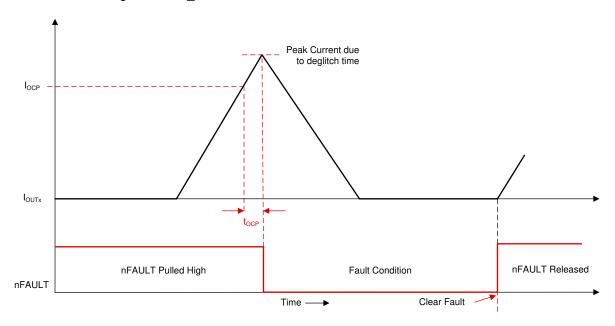


图 7-51. Overcurrent Protection - Latched Shutdown Mode

7.3.21.6.2 OCP Automatic Retry (OCP_MODE = 01b)

When an OCP event happens in this mode, all the FETs are disabled and the nFAULT pin is driven low. The DRIVER_FAULT, OCP and corresponding FET's OCP bits are set to 1b in the fault status registers. Normal operation resumes automatically (gate driver operation and the nFAULT pin is released) after the t_{RETRY} (OCP_RETRY) time elapses. The DRIVER_FAULT bit is reset to 0b after the t_{RETRY} period expires. The OCP and corresponding FET's OCP bits are set to 1b until cleared through the CLR_FLT bit.

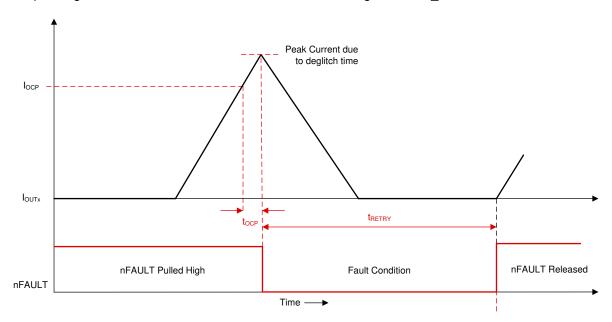


图 7-52. Overcurrent Protection - Automatic Retry Mode

7.3.21.6.3 OCP Report Only (OCP_MODE = 10b)

No protective action is taken when an OCP event happens in this mode. The overcurrent event is reported by setting the DRIVER_FAULT, OCP, and corresponding FET's OCP bits to 1b in the fault status registers. The device continues to operate as usual. The external controller manages the overcurrent condition by acting appropriately. The reporting clears when the OCP condition clears and a clear fault command is issued through the CLR_FLT bit.

7.3.21.6.4 OCP Disabled (OCP_MODE = 11b)

No action is taken when an OCP event happens in this mode.

7.3.21.7 Buck Overcurrent Protection

The buck overcurrent event is sensed by monitoring the current flowing through high-side MOSFET of the buck regulator. If the current through the high-side MOSFET exceeds the I_{BK_OCP} threshold for a time longer than the deglitch time (t_{OCP}), a buck OCP event is recognized and the buck regulator MOSFETs are disabled (Hi-Z). MCT8315A goes into reset state whenever buck OCP event occurs, since the internal circuitry in MCT8315A is powered from the buck regulator output.

7.3.21.8 Cycle-by-Cycle (CBC) Current Limit (CBC ILIMIT)

Cycle-by-cycle (CBC) current limit provides a means of controlling the amount of current delivered to the motor. This is useful when the system must limit the amount of current pulled from the power supply during motor operation. The CBC current limit limits the current applied to the motor from exceeding the configured threshold. CBC current limit functionality is achieved by connecting the output of current sense amplifier V_{SOX} to a hardware comparator. If the voltage at output of current sense amplifier exceeds the CBC_ILIMIT threshold, a CBC_ILIMIT event is recognized and action is taken according to CBC_ILIMIT_MODE. Total delay in reaction to this event is dependent on the current sense amplifier gain and the comparator delay. CBC current limit in closed loop is set through CBC_ILIMIT while configuration of OL_ILIMIT_CONFIG sets the CBC current limit in open

loop operation. Different modes can be configured through CBC_ILIMIT_MODE: CBC_ILIMIT automatic recovery next PWM cycle, CBC_ILIMIT automatic recovery threshold based, CBC_ILIMIT automatic recovery number of PWM cycles based, CBC_ILIMIT report only, CBC_ILIMIT disabled.

7.3.21.8.1 CBC_ILIMIT Automatic Recovery next PWM Cycle (CBC_ILIMIT_MODE = 000xb)

When a CBC_ILIMIT event happens in this mode, MCT8315A stops driving the FETs using recirculation mode to prevent the inductive energy from entering the DC input supply. The CBC_ILIMIT bit is set to 1b in the fault status registers. Normal operation resumes at the start of next PWM cycle and CBC_ILIMIT bit is reset to 0b. The status of CONTROLLER_FAULT bit and nFAULT pin will be determined by CBC_ILIMIT_MODE. When CBC_ILIMIT_MODE is 0000b, CONTROLLER_FAULT bit is set to 1b and nFAULT pin driven low until next PWM cycle. When CBC_ILIMIT_MODE is 0001b, CONTROLLER_FAULT bit is not set to 1b and nFAULT is not driven low.

7.3.21.8.2 CBC_ILIMIT Automatic Recovery Threshold Based (CBC_ILIMIT_MODE = 001xb)

When a CBC_ILIMIT event happens in this mode, MCT8315A stops driving the FETs using recirculation mode to prevent the inductive energy from entering the DC input supply. The CBC_ILIMIT bit is set to 1b in the status registers. Normal operation resumes after V_{SOX} falls below CBC_ILIMIT threshold and CBC_ILIMIT bit is set to 0b. The status of CONTROLLER_FAULT bit and nFAULT pin will be determined by CBC_ILIMIT_MODE. When CBC_ILIMIT_MODE is 0010b, CONTROLLER_FAULT bit is set to 1b and nFAULT pin driven low until V_{SOX} falls below CBC_ILIMIT threshold. When CBC_ILIMIT_MODE is 0011b, CONTROLLER_FAULT bit is not set to 1b and nFAULT is not driven low.

7.3.21.8.3 CBC_ILIMIT Automatic Recovery after 'n' PWM Cycles (CBC_ILIMIT_MODE = 010xb)

When a CBC_ILIMIT event happens in this mode, MCT8315A stops driving the FETs using recirculation mode to prevent the inductive energy from entering the DC input supply. The CBC_ILIMIT bit is set to 1b in the fault status registers. Normal operation resumes after (CBC_RETRY_PWM_CYC +1) PWM cycles and CBC_ILIMIT bit is set to 0b. The status of CONTROLLER_FAULT bit and nFAULT pin will be determined by CBC_ILIMIT_MODE. When CBC_ILIMIT_MODE is 0100b, CONTROLLER_FAULT bit is set to1b and nFAULT pin driven low until (CBC_RETRY_PWM_CYC +1) PWM cycles lapse. When CBC_ILIMIT_MODE is 0101b, CONTROLLER_FAULT bit is not set to 1b and nFAULT is not driven low.

7.3.21.8.4 CBC_ILIMIT Report Only (CBC_ILIMIT_MODE = 0110b)

No protective action is taken when a CBC_ILIMIT event happens in this mode. The CBC current limit event is reported by setting the CONTROLLER_FAULT and CBC_ILIMIT bits to 1b in the fault status registers. The gate drivers continue to operate. The external controller manages the overcurrent condition by acting appropriately. The reporting clears when the CBC_ILIMIT condition clears and a clear fault command is issued through the CLR FLT bit.

7.3.21.8.5 CBC_ILIMIT Disabled (CBC_ILIMIT_MODE = 0111b or 1xxxb)

No action is taken when a CBC_ILIMIT event happens in this mode.

7.3.21.9 Lock Detection Current Limit (LOCK ILIMIT)

The lock detection current limit function provides a configurable threshold for limiting the current to prevent damage to the system. The MCT8315A continuously monitors the output of the current sense amplifier (CSA) through the ADC. If at any time, the voltage on the output of CSA exceeds LOCK_ILIMIT for a time longer than t_{LCK_ILIMIT} , a LOCK_ILIMIT event is recognized and action is taken according to LOCK_ILIMIT_MODE. The threshold is set through LOCK_ILIMIT, the t_{LCK_ILIMIT} is set through LOCK_ILIMIT_DEG. LOCK_ILIMIT_MODE can be set to four different modes: LOCK_ILIMIT latched shutdown, LOCK_ILIMIT automatic retry, LOCK_ILIMIT report only and LOCK_ILIMIT disabled.

7.3.21.9.1 LOCK_ILIMIT Latched Shutdown (LOCK_ILIMIT_MODE = 00xxb)

When a LOCK_ILIMIT event happens in this mode, the status of MOSFETs will be configured by LOCK ILIMIT MODE and nFAULT is driven low. Status of MOSFETs during LOCK ILIMIT:

Product Folder Links: MCT8315A

LOCK ILIMIT MODE = 0000b: All MOSFETs are turned OFF.

Copyright © 2023 Texas Instruments Incorporated

www.ti.com.cn

- LOCK ILIMIT_MODE = 0001b: MOSFET which was switching is turned OFF while the one which was conducting stays ON till inductive energy is completely recirculated.
- LOCK_ILIMIT_MODE = 0010b: All high-side MOSFETs are turned ON.
- LOCK ILIMIT MODE = 0011b: All low-side MOSFETs are turned ON.

The CONTROLLER FAULT and LOCK ILIMIT bits are set to 1b in the fault status registers. Normal operation resumes (gate driver operation and the nFAULT pin is released) when the LOCK ILIMIT condition clears and a clear fault command is issued through the CLR FLT bit.

7.3.21.9.2 LOCK_ILIMIT Automatic Recovery (LOCK_ILIMIT_MODE = 01xxb)

When a LOCK_ILIMIT event happens in this mode, the status of MOSFETs will be configured by LOCK ILIMIT MODE and nFAULT is driven low. Status of MOSFETs during LOCK ILIMIT:

- LOCK_ILIMIT_MODE = 0100b: All MOSFETs are turned OFF.
- LOCK ILIMIT MODE = 0101b: MOSFET which was switching is turned OFF while the one which was conducting stays ON till inductive energy is completely recirculated.
- LOCK ILIMIT MODE = 0110b: All high-side MOSFETs are turned ON
- LOCK ILIMIT MODE = 0111b: All low-side MOSFETs are turned ON

The CONTROLLER FAULT and LOCK ILIMIT bits are set to 1b in the fault status registers. Normal operation resumes automatically (gate driver operation and the nFAULT pin is released) after the t_{I CK RETRY} (configured by LCK RETRY) time lapses. The CONTROLLER FAULT and LOCK ILIMIT bits are reset to 0b after the $t_{\mbox{\scriptsize LCK_RETRY}}$ period expires.

7.3.21.9.3 LOCK_ILIMIT Report Only (LOCK_ILIMIT_MODE = 1000b)

No protective action is taken when a LOCK ILIMIT event happens in this mode. The lock detection current limit event is reported by setting the CONTROLLER FAULT and LOCK ILIMIT bits to 1b in the fault status registers. The gate drivers continue to operate. The external controller manages this condition by acting appropriately. The reporting clears when the LOCK ILIMIT condition clears and a clear fault command is issued through the CLR_FLT bit.

7.3.21.9.4 LOCK_ILIMIT Disabled (LOCK_ILIMIT_MODE = 1xx1b)

No action is taken when a LOCK ILIMIT event happens in this mode.

7.3.21.10 Thermal Warning (OTW)

If the die temperature exceeds the thermal warning limit (T_{OTW}), nFAULT is pulled low and the OT and OTW bits in the gate driver status register are set to 1b. The reporting of OTW (on nFAULT and status bits) can be enabled by setting OTW REP to 1b. The device performs no additional action and continues to function. In this case, the nFAULT pin is released when the die temperature decreases below the hysteresis point of the thermal warning limit (T_{OTW} - T_{OTW HYS}). The OTW bit remains set until cleared through the CLR_FLT bit and the die temperature is lower than thermal warning limit. (Totw - Totw Hys).

7.3.21.11 Thermal Shutdown (TSD)

If the die temperature exceeds the thermal shutdown limit (T_{TSD}), all the FETs are disabled, the charge pump is shut down, and the nFAULT pin is driven low. In addition, the DRIVER FAULT, OT and TSD bit in the status register are set to 1b. Normal operation resumes (driver operation and the nFAULT pin is released) when the die temperature decreases below the hysteresis point of the thermal shutdown limit (T_{TSD} - T_{TSD} HYS). The TSD bit stays latched high indicating that a thermal event occurred until a clear fault command is issued through the CLR FLT bit. This protection feature cannot be disabled.

7.3.21.12 Motor Lock (MTR_LCK)

The MCT8315A continuously checks for different motor lock conditions (see Motor Lock Detection) during motor operation. When one of the enabled lock condition happens, a MTR_LCK event is recognized and action is taken according to the MTR LCK MODE.

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback



In MCT8315A, all locks can be enabled or disabled individually and retry times can be configured through LCK RETRY. MTR LCK MODE bit can operate in four different modes: MTR LCK latched shutdown, MTR LCK automatic retry, MTR LCK report only and MTR LCK disabled.

7.3.21.12.1 MTR LCK Latched Shutdown (MTR LCK MODE = 00xxb)

When a MTR LCK event happens in this mode, the status of MOSFETs will be configured by MTR LCK MODE and nFAULT is driven low. Status of MOSFETs during MTR_LCK:

- MTR LCK MODE = 0000b: All MOSFETs are turned OFF.
- MTR LCK MODE = 0001b: MOSFET which was switching is turned OFF while the one which was conducting stays ON till inductive energy is completely recirculated.
- MTR LCK MODE = 0010b; All high-side MOSFETs are turned ON.
- MTR LCK MODE = 0011b: All low-side MOSFETs are turned ON.

The CONTROLLER_FAULT, MTR_LCK and respective motor lock condition bits are set to 1b in the fault status registers. Normal operation resumes (gate driver operation and the nFAULT pin is released) when the MTR LCK condition clears and a clear fault command is issued through the CLR FLT bit.

7.3.21.12.2 MTR_LCK Automatic Recovery (MTR_LCK_MODE= 01xxb)

When a MTR LCK event happens in this mode, the status of MOSFETs will be configured by MTR LCK MODE and nFAULT is driven low. Status of MOSFETs during MTR LCK:

- MTR LCK MODE = 0100b: All MOSFETs are turned OFF.
- MTR LCK MODE = 0101b: MOSFET which was switching is turned OFF while the one which was conducting stays ON till inductive energy is completely recirculated.
- MTR LCK MODE = 0110b: All high-side MOSFETs are turned ON.
- MTR LCK MODE = 0111b: All low-side MOSFETs are turned ON.

The CONTROLLER FAULT, MTR LCK and respective motor lock condition bits are set to 1b in the fault status registers. Normal operation resumes automatically (gate driver operation and the nFAULT pin is released) after the t_{LCK RETRY} (configured by LCK_RETRY) time lapses. The CONTROLLER_FAULT, MTR_LCK and respective motor lock condition bits are reset to 0b after the t_{LCK} _{RETRY} period expires.

7.3.21.12.3 MTR_LCK Report Only (MTR_LCK_MODE = 1000b)

No protective action is taken when a MTR LCK event happens in this mode. The motor lock event is reported by setting the CONTROLLER_FAULT, MTR_LCK and respective motor lock condition bits to 1b in the fault status registers. The gate drivers continue to operate. The external controller manages this condition by acting appropriately. The reporting clears when the MTR LCK condition clears and a clear fault command is issued through the CLR FLT bit.

7.3.21.12.4 MTR_LCK Disabled (MTR_LCK_MODE = 1xx1b)

No action is taken when a MTR_LCK event happens in this mode.

7.3.21.13 Motor Lock Detection

The MCT8315A provides different lock detect mechanisms to determine if the motor is in a locked state. Multiple detection mechanisms work together to ensure the lock condition is detected quickly and reliably. In addition to detecting if there is a locked motor condition, the MCT8315A can also identify and take action if there is no motor connected to the system. Each of the lock detect mechanisms and the no-motor detection can be disabled by their respective register bits (LOCK1/2/3 EN).

7.3.21.13.1 Lock 1: Abnormal Speed (ABN_SPEED)

MCT8315A monitors the speed continuously and at any time the speed exceeds LOCK_ABN_SPEED, an ABN SPEED lock event is recognized and action is taken according to the MTR LCK MODE. In MCT8315A, the threshold is set through the LOCK ABN SPEED register. ABN SPEED lock can be enabled/disabled by LOCK1 EN.

Product Folder Links: MCT8315A

Copyright © 2023 Texas Instruments Incorporated

7.3.21.13.2 Lock 2: Loss of Sync (LOSS_OF_SYNC)

The motor is commutated by detecting the zero crossing on the phase which is in Hi-Z state. If the motor is locked, the back-EMF will disappear and MCT8315A will be not able to detect the zero crossing. If MCT8315A is not able to detect zero crossing for LOSS_SYNC_TIMES number of times, LOSS_OF_SYNC event is recognized and action is taken according to the MTR_LCK_MODE. LOSS_OF_SYNC lock can be enabled/disabled by LOCK2 EN.

7.3.21.13.3 Lock3: No-Motor Fault (NO_MTR)

The MCT8315A continuously monitors the relevant phase current (low-side phase in the present phase pattern); if the relevant phase current stays below NO_MTR_THR for a time longer than NO_MTR_DEG_TIME, a NO_MTR event is recognized. The response to the NO_MTR event is configured through MTR_LCK_MODE . NO MTR lock can be enabled/disabled by LOCK3 EN.

7.3.21.14 SW VM Undervoltage Protection

MCT8315A provides the option of a software based VM undervoltage protection. The VM level at which the software triggers the undervoltage fault is set by MIN_VM_MOTOR and the fault response to VM undervoltage is set by MIN_VM_MODE. If MIN_VM_MODE is set to 0b, VM undervoltage fault (at MIN_VM_MOTOR) is latched and the FETs are in Hi-Z until the fault condition is cleared by writing 1b to CLR_FIT bit. If MIN_VM_MODE is set to 1b, VM undervoltage fault (at MIN_VM_MOTOR) automatically clears and the device starts motor operation once VM > MIN_VM_MODE.

7.3.21.15 SW VM Overvoltage Protection

MCT8315A provides the option of a software based VM overvoltage protection. The VM level at which the software triggers the overvoltage fault is set by MAX_VM_MOTOR and the fault response to VM overvoltage is set by MAX_VM_MODE. If MAX_VM_MODE is set to 0b, VM overvoltage fault (at MAX_VM_MOTOR) is latched and the FETs are in Hi-Z until the fault condition is cleared by writing 1b to CLR_FIT bit. If MAX_VM_MODE is set to 1b, VM overvoltage fault (at MAX_VM_MOTOR) automatically clears and the device starts motor operation once VM < MAX_VM_MODE.

7.3.21.16 IPD Faults

The MCT8315A uses 12-bit timers to estimate the time during the current ramp up and ramp down during IPD, when the motor start-up is configured as IPD (MTR_STARTUP is set to 10b). During IPD, the algorithm checks for a successful current ramp-up to IPD_CURR_THR, starting with an IPD clock of 10MHz; if unsuccessful (timer overflow before current reaches IPD_CURR_THR), IPD is repeated with lower frequency clocks of 1MHz, 100kHz, and 10kHz sequentially. If the IPD timer overflows (current does not reach IPD_CURR_THR) with all the four clock frequencies, then the IPD_T1_FAULT gets triggered. Similarly the algorithm checks for a successful current decay to zero during IPD current ramp down using all the mentioned IPD clock frequencies. If the IPD timer overflows (current does not ramp down to zero) in all the four attempts, then the IPD_T2_FAULT gets triggered.

IPD gives incorrect results if the next IPD pulse is commanded before the complete decay of current due to present IPD pulse. The MCT8315A can generate a fault called IPD_FREQ_FAULT during such a scenario . The IPD_FREQ_FAULT maybe triggered if the IPD frequency is too high for the IPD current limit and the IPD release mode or if the motor inductance is too high for the IPD frequency, IPD current limit and IPD release mode.

7.4 Device Functional Modes

7.4.1 Functional Modes

7.4.1.1 Sleep Mode

In sleep mode, the MOSFETs, sense amplifiers, buck regulator, charge pump, AVDD LDO regulator and the I²C bus are disabled. The device can be configured to enter sleep (instead of standby) mode by configuring DEV MODE to 1b. SPEED pin and I²C speed command determine entry and exit from sleep state as described in 表 7-3.

7.4.1.2 Standby Mode

The device can be configured to operate as a standby device by setting DEV MODE to 0b. In standby mode, the charge pump, AVDD LDO, buck regulator and I²C bus are active while the motor is in stopped state waiting for a suitable non-zero speed command. SPEED pin (analog, PWM or frequency based speed input) or I²C speed command (I²C based speed input) determines entry and exit from standby state as described in 表 7-3.

The thresholds for entering and exiting standby mode in different speed input modes are as follows,

- 1. Analog : $V_{EN\ SB}$ = (ZERO_DUTY_THR x $V_{ANA\ FS}$), $V_{EX\ SB}$ = ((ZERO_DUTY_THR + ZERO_DUTY_HYST) x V_{ANA FS})
- PWM: Duty_{EN SB} = ZERO_DUTY_THR, Duty_{EX SB} = (ZERO_DUTY_THR + ZERO_DUTY_HYST)
- 3. I^2C : SPEED_ $\bar{C}TRL_{EN\ SB}$ = ZERO_DUTY_THR \bar{x} 32767, SPEED_CTRL_{EX\ SB} = (ZERO_DUTY_THR + ZERO DUTY HYST) x 32767
- 4. Frequency: Freq_{EN SB} = ZERO_DUTY_THR x INPUT_MAX_FREQUENCY, Freq_{EX SB} = (ZERO DUTY THR + ZERO DUTY HYST) x INPUT MAX FREQUENCY

表 7-3. Conditions to Enter or Exit Sleep or Standby Modes

SPEED COMMAND MODE	ENTER STANDBY CONDITION	EXIT FROM STANDBY CONDITION	ENTER SLEEP CONDITION	EXIT FROM SLEEP CONDITION
Analog	V _{SPEED} < V _{EN_SB}	V _{SPEED} > V _{EX_SB}	V _{SPEED} < V _{EN_SL} for t _{DET_SL_ANA}	V _{SPEED} > V _{EX_SL} for t _{DET_ANA}
PWM	Duty _{SPEED} < Duty _{EN_SB}	Duty _{SPEED} > Duty _{EX_SB}	V _{SPEED} < V _{IL} for t _{DET_SL_PWM}	V _{SPEED} > V _{IH} for t _{DET_PWM}
I ² C	SPEED_CTRL < SPEED_CTRL _{EN_SB}	SPEED_CTRL > SPEED_CTRL _{EX_SB}	SPEED_CTRL is set to 0b for SLEEP_TIME and V _{SPEED} < V _{IL}	V _{SPEED} > V _{IH} for t _{DET_PWM}
Frequency	Freq _{SPEED} < Freq _{EN_SB}	Freq _{SPEED} > Freq _{EX_SB}	V _{SPEED} < V _{IL} for t _{DET_SL_PWM}	V _{SPEED} > V _{IH} for t _{DET_PWM}

备注

V_{SPEED} : SPEED pin input voltage, Duty_{SPEED} : SPEED pin input PWM duty, Freq_{SPEED} : SPEED pin input frequency

7.4.1.3 Fault Reset (CLR FLT)

In the case of latched faults, the device goes into a partial shutdown state to help protect the power MOSFETs and system. When the fault condition clears, the device can go to the operating state again by setting the CLR FLT to 1b.

7.5 External Interface

7.5.1 DRVOFF Functionality

When DRVOFF pin is driven high, all six MOSFETs are put in Hi-Z state, irrespective of speed command. If motor speed command is non-zero when DRVOFF is driven high, device may encounter a fault like no motor or abnormal BEMF.

7.5.2 DAC outputs

MCT8315A has two 12-bit DACs which output analog voltage equivalent of digital variables on the DACOUT1 and DACOUT2 pins. The maximum DAC output voltage is 3-V. Signals available on DACOUT pins are useful in

> Copyright © 2023 Texas Instruments Incorporated Product Folder Links: MCT8315A

tracking internal variables in real-time and can be used for tuning speed controller or motor acceleration time. The address for variables to be tracked on DACOUT1 and DACOUT2 are configured using DACOUT1_VAR_ADDR and DACOUT2_VAR_ADDR respectively. DACOUT1 is available on pin 38 and DACOUT2 can be configured on pin 36 by setting DAC_SOX_CONFIG to 00b. DACOUT2 is also available on pin 37. DAC_CONFIG should be configured to 1b for pins 37, 38 to function as DAC outputs.

7.5.3 Current Sense Output

MCT8315A can provide the built-in current sense amplifiers' output on the SOX pin. SOX output is available on pin 36 and can be configured by DAC_SOX_CONFIG.

7.5.4 Oscillator Source

MCT8315A has a built-in oscillator that is used as the clock source for all digital peripherals and timing measurements. Default configuration for MCT8315A is to use the internal oscillator and it is sufficient to drive the motor without need for any external crystal or clock sources.

In case MCT8315A does not meet accuracy requirements of timing measurement or speed loop, then MCT8315A has an option to support an external clock reference.

In order to improve EMI performance, MCT8315A provides the option of modulating the clock frequency by enabling Spread Spectrum Modulation (SSM) through SSM CONFIG.

7.5.4.1 External Clock Source

Speed loop accuracy of MCT8315A over the operating temperature range can be improved by providing a more accurate clock reference on EXT_CLK pin as shown in [8] 7-53. EXT_CLK will be used to calibrate the internal clock oscillator - this will help match the accuracy of the internal clock oscillator to that of the external clock. External clock source can be selected by configuring CLK_SEL to 11b and setting EXT_CLK_EN to 1b. The external clock source frequency can be configured through EXT_CLK_CONFIG.

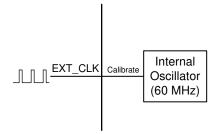


图 7-53. External Clock Reference

备注

External clock is optional and can be used when higher clock accuracy is needed. MCT8315A will always power up using the internal oscillator in all modes.

7.5.5 External Watchdog

MCT8315A provides an external watchdog feature - EXT_WD_EN bit should be set to 1b to enable the external watchdog. When this feature is enabled, the device waits for a tickle (low to high transition in EXT_WD pin, EXT_WD_STATUS_SET set to 1b in I²C mode) from the external watchdog input for a configured time interval; if the time interval between two consecutive tickles is higher than the configured time, a watchdog fault is triggered. This fault can be configured using EXT_WD_FAULT either as a report only fault or as a latched fault with outputs in Hi-Z state. The latched fault can be cleared by writing 1b to CLR_FLT. When a watchdog timeout occurs, EXT_WD_TIMEOUT bit is set to 1b. In case, the next tickle arrives before the configured time interval elapses, the watchdog timer is reset and it begins to wait for the next tickle. This can be used to continuously monitor the health of an external MCU (which is the external watchdog input) and put the MCT8315A outputs in Hi-Z in case the external MCU is in an erroneous state.

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

71



The external watchdog input is selected using EXT_WD_INPUT and can either be the EXT_WD pin or the I²C interface. The time interval between two tickles to trigger a watchdog fault is configured by EXT_WD_FREQ; there are 4 time (frequency) settings - 100ms (10Hz), 200ms (5Hz), 500ms (2Hz) and 1000ms (1Hz).

备注

Watchdog should be disabled by setting EXT_WD_EN to 0b before changing EXT_WD_FREQ configuration.

7.6 EEPROM access and I²C interface

7.6.1 EEPROM Access

MCT8315A has 1024 bits (16 rows of 64 bits each) of EEPROM, which are used to store the motor configuration parameters. Erase operations are row-wise (all 64 bits are erased in a single erase operation), but 32-bit write and read operations are supported. EEPROM can be written and read using the I²C serial interface but erase cannot be performed using I²C serial interface. The shadow registers corresponding to the EEPROM are located at addresses 0x000080-0x0000AE.

备注

MCT8315A allows EEPROM write and read operations only when the motor is not spinning.

7.6.1.1 EEPROM Write

In MCT8315A, EEPROM write procedure is as follows,

- 1. Write register 0x000080 (ISD_CONFIG) with ISD configuration like resync enable, reverse drive enable, stationary detect threshold etc.,
- 2. Write register 0x000082 (MOTOR_STARTUP1) with motor start-up configuration like start-up method, first cycle frequency, IPD parameters, align parameters etc.,
- 3. Write register 0x000084 (MOTOR_STARTUP2) with motor start-up configuration like open loop acceleration, minimum duty cycle etc.,
- 4. Write register 0x000086 (CLOSED_LOOP1) with motor control configuration like closed loop acceleration, PWM frequency, PWM modulation etc.,
- 5. Write register 0x000088 (CLOSED_LOOP2) with motor control configuration like FG signal parameters, motor stop options etc..
- 6. Write register 0x00008A (CLOSED_LOOP3) with motor control configuration like fast start-up and dynamic degauss parameters including BEMF thresholds, duty cycle thresholds etc.,
- 7. Write register 0x00008C (CLOSED_LOOP4) with motor control configuration like fast deceleration parameters including fast deceleration duty threshold, window, current limits etc.,
- Write register 0x00008E (CONST_SPEED) with motor control configuration like speed loop parameters including closed loop mode, saturation limits, K_D, K_i etc.,
- 9. Write register 0x000090 (CONST_PWR) with motor control configuration like input power regulation parameters including maximum power, constant power mode, power level hysteresis, maximum speed etc.,
- 10. Write register 0x000092 (FAULT_CONFIG1) with fault control configuration like CBC, lock current limits and actions, retry times etc.,
- 11. Write register 0x000094 (FAULT_CONFIG2) with fault control configuration like OV, UV limits and actions, abnormal speed level, motor lock setting etc.,
- 12. Write registers 0x000096 and 0x000098 (150_DEG_TWO_PH_PROFILE, 150 DEG_THREE_PH_PROFILE) with PWM duty cycle configurations for 150° modulation.
- 13. Write registers 0x00009A and 0x00009C (TRAP_CONFIG1 and TRAP_CONFIG2) with algorithm parameters like ISD BEMF threshold, blanking time, AVS current limits etc.,
- 14. Write registers 0x0000A4 and 0x0000A6 (PIN_CONFIG1 and PIN_CONFIG2) with pin configuration for DIR, BRAKE, DACOUT1 and DACOUT2, SOX, external watchdog etc.,
- 15. Write register 0x0000A8 (DEVICE_CONFIG) with device configuration like device mode, external clock enable, clock source, speed input PWM frequency range etc.,
- 16. Write registers 0x0000AC and 0x0000AE (GD_CONFIG1 and GD_CONFIG2) with gate driver configuration like slew rate, CSA gain, OCP level, mode, OVP enable etc.,
- 17. Write 0x8A500000 into register 0x0000E6 to write the shadow register (0x000080-0x0000AE) values into the EEPROM.
- 18. Wait for 300ms for the EEPROM write operation to complete.

Steps 1-16 can be selectively executed based on registers/parameters that need to be modified. After all shadow registers have been updated with the required values, step 17 should be executed to copy the contents of the shadow registers into the EEPROM.

Product Folder Links: MCT8315A

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

73

7.6.1.2 EEPROM Read

In MCT8315A, EEPROM read procedure is as follows,

- 1. Write 0x40000000 into register 0x0000E6 to read the EEPROM data into the shadow registers (0x000080-0x0000AE).
- 2. Wait for 100ms for the EEPROM read operation to complete.
- 3. Read the shadow register values, 1 or 2 registers at a time, using the I²C read command as explained in † 7.6.2. Shadow register addresses are in the range of 0x000080-0x0000AE. Register address increases in steps of 2 for 32-bit read operation (since each address is a 16-bit location).

7.6.2 I²C Serial Interface

MCT8315A interfaces with an external MCU over an I²C serial interface. MCT8315A is an I²C target to be interfaced with a controller. External MCU can use this interface to read/write from/to any non-reserved register in MCT8315A

备注

For reliable communication, a 100- μ s delay should be used between every byte transferred over the I^2C bus.

7.6.2.1 I²C Data Word

The I^2C data word format is shown in $\frac{1}{2}$ 7-4.

表 7-4. I²C Data Word Format

TARGET_ID	RGET_ID R/W CONTROL WORD		DATA	CRC-8		
A6 - A0	W0	CW23 - CW0	D15 / D31/ D63 - D0	C7 - C0		

Target ID and R/W Bit: The first byte includes the 7-bit I²C target ID (default 0x00, but can be modified by setting I2C_TARGET_ADDR), followed by the read/write command bit. Every packet in MCT8315A the communication protocol starts with writing a 24-bit control word and hence the R/W bit is always 0.

24-bit Control Word: The Target Address is followed by a 24-bit control bit. The control word format is shown in 表 7-5.

表 7-5. 24-bit Control Word Format

OP_R/W	CRC_EN DLEN		MEM_SEC	MEM_PAGE	MEM_ADDR
CW23	CW22	CW21- CW20	CW19 - CW16	CW15 - CW12	CW11 - CW0

Each field in the control word is explained in detail below.

OP_R/W - **Read/Write**: R/W bit gives information on whether this is a read (1b) operation or write (0b) operation. For write operation, MCT8315A will expect data bytes to be sent after the 24-bit control word. For read operation, MCT8315A will expect an I²C read request with repeated start or normal start after the 24-bit control word.

CRC_EN - **Cyclic Redundancy Check(CRC) Enable**: MCT8315A supports CRC to verify the data integrity. This bit controls whether the CRC feature is enabled or not.

DLEN - **Data Length**: DLEN field determines the length of the data that will be sent by external MCU to MCT8315A. MCT8315A protocol supports three data lengths: 16-bit, 32-bit and 64-bit.

表 7-6. Data Length Configuration

DLEN Value	Data Length
00b	16-bit
01b	32-bit
10b	64-bit

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

表 7-6. Data Length Configuration (continued)

DLEN Value	Data Length
11b	Reserved

MEM_SEC - **Memory Section**: Each memory location in MCT8315A is addressed using three separate entities in the control word - Memory Section, Memory Page, Memory Address. Memory Section is a 4-bit field which denotes the memory section to which the memory location belongs like RAM, ROM etc.

MEM_PAGE - **Memory Page**: Memory page is a 4-bit field which denotes the memory page to which the memory location belongs.

MEM_ADDR - **Memory Address**: Memory address is the last 12-bits of the address. The complete 22-bit address is constructed internally by MCT8315A using all three fields - Memory Section, Memory Page, Memory Address. For memory locations 0x000000-0x000800, memory section is 0x0, memory page is 0x0 and memory address is the lowest 12 bits(0x000 for 0x000000, 0x080 for 0x000080 and 0x800 for 0x000800). All relevant memory locations (EEPROM and RAM variables) have MEM_SEC and MEM_PAGE values both corresponding to 0x0. All other MEM_SEC, MEM_PAGE values are reserved and not for external use.

Data Bytes: For a write operation to MCT8315A, the 24-bit control word is followed by data bytes. The DLEN field in the control word should correspond with the number of bytes sent in this section. In case of mismatch between number of data bytes and DLEN, the write operation is discarded.

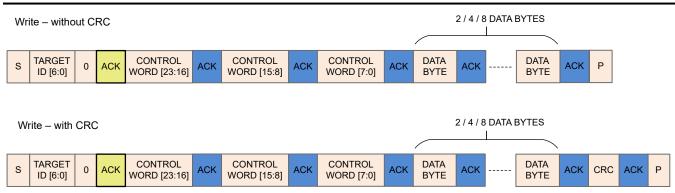
CRC Byte: If the CRC feature is enabled in the control word, CRC byte has to be sent at the end of a write transaction. Refer to \ddagger 7.6.2.6 for detailed information on CRC byte calculation.

7.6.2.2 I²C Write Transaction

MCT8315A write transaction over I^2C involves the following sequence (see $\boxed{8}$ 7-54).

- 1. I²C start condition.
- 2. Start is followed by the I²C target ID byte, made up of 7-bit target ID along with the R/W bit set to 0b. ACK in yellow box indicates that MCT8315A has processed the received target ID which has matched with it's I²C target ID and therefore will proceed with this transaction. If target ID received does not match with the I²C ID of MCT8315A, then the transaction is ignored, and no ACK is sent by MCT8315A.
- 3. The target ID byte is followed by the 24-bit control word sent one byte at a time. Bit 23 in the control word is 0b as it is a write transaction. ACK in blue boxes correspond to acknowledgements sent by MCT8315A to the controller that the previous byte (of control word) has been received and next byte can be sent.
- 4. The 24-bit control word is then followed by the data bytes. The number of data bytes sent by the controller depends on the DLEN field in the control word.
 - a. While sending data bytes, the LSB byte is sent first. Refer to 节 7.6.2.4 for more details.
 - b. 16-bit/32-bit write The data sent is written to the address mentioned in control word.
 - c. 64-bit Write 64-bit is treated as two successive 32-bit writes. The address mentioned in control word is taken as Addr_1. Addr_2 is internally calculated by MCT8315A by incrementing Addr_1 by 0x2. A total of 8 data bytes are sent. The first 4 bytes (sent in LSB first) are written to Addr_1 and the next 4 bytes are written to Addr_2.
 - d. ACK in blue boxes (after every data byte) correspond to the acknowledgement sent by MCT8315A to the controller that the previous data byte has been received and next data byte can be sent.
- 5. If CRC is enabled, the packet ends with a CRC byte. CRC is calculated for the entire packet (Target ID + W bit, Control Word, Data Bytes). MCT8315A will send an ACK on receiving the CRC byte.
- 6. I^2C Stop condition from the controller to terminate the transaction.





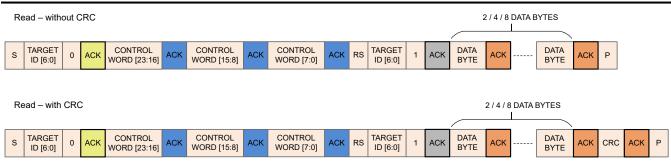
CRC includes {TARGET ID,0}, CONTROL WORD[23:0], DATA BYTES

图 7-54. I²C Write Transaction Sequence

7.6.2.3 I²C Read Transaction

MCT8315A read transaction over I²C involves the following sequence (see 图 7-55).

- 1. I²C Start condition from the controller to initiate the transaction.
- 2. Start is followed by the I²C target ID byte, made up of 7-bit target ID along with the R/W bit set to 0b. ACK (in yellow box) indicates that MCT8315A has processed the received target ID which has matched with it's I²C target ID and therefore will proceed with this transaction. If target ID received does not match with the I²C ID of MCT8315A, then the transaction is ignored and no ACK is sent by MCT8315A.
- 3. The target ID byte is followed by the 24-bit control word sent one byte at a time. Bit 23 in the control word is set to 1b as it is a read transaction. ACK (in blue boxes) correspond to acknowledgements sent by MCT8315A to the controller that the previous byte (of control word) has been received and next byte can be sent.
- 4. The control word is followed by a Repeated Start (RS, start without a preceding stop) or normal Start (P followed by S) to initiate the data (to be read back) transfer from MCT8315A to I²C controller. RS or S is followed by the 7-bit target ID along with R/W bit set to 1b to initiate the read transaction. MCT8315A sends an ACK (in grey box after RS) to the controller to acknowledge the receipt of read transaction request.
- 5. Post acknowledgement of read transaction request, MCT8315A sends the data bytes on SDA one byte at a time. The number of data bytes sent by MCT8315A depends on the DLEN field in the control word.
 - a. While sending data bytes, the LSB byte is sent first. Refer the examples in †7.6.2.4 for more details.
 - b. 16-bit/32-bit Read The data from the address mentioned in control word is sent back to the controller.
 - c. 64-bit Read 64-bit is treated as two successive 32-bit reads. The address mentioned in control word is taken as Addr_1. Addr_2 is internally calculated by MCT8315A by incrementing Addr_1 by 0x2. A total of 8 data bytes are sent by MCT8315A. The first 4 bytes (sent in LSB first) are read from Addr_1 and the next 4 bytes are read from Addr_2.
 - d. ACK in orange boxes correspond to acknowledgements sent by the controller to MCT8315A that the previous byte has been received and next byte can be sent.
- 6. If CRC is enabled in the control word, then MCT8315A sends an additional CRC byte at the end. Controller has to read the CRC byte and then send the last ACK (in orange). CRC is calculated for the entire packet (Target ID + W bit, Control Word, Target ID + R bit, Data Bytes).
- 7. I²C Stop condition from the controller to terminate the transaction.



CRC includes {TARGET ID,0}, CONTROL WORD[23:0], {TARGET ID,1}, DATA BYTES

图 7-55. I²C Read Transaction Sequence

7.6.2.4 I²C Communication Protocol Packet Examples

All values used in this example section are in hex format. I²C target ID used in the examples is 0x60.

Example for 32-bit Write Operation: Address - 0x00000080, Data - 0x1234ABCD, CRC Byte - 0x45 (Sample value; does not match with the actual CRC calculation)

表	7-7.	Example	for	32-bit	Write	Operation	Packet
---	------	---------	-----	--------	-------	-----------	---------------

Start Byt	е	Control Word 0				Control V	Control Word 1		Data Bytes				CRC
Target ID	I ² C Write	OP_R/ W	CRC_E N	DLEN	MEM_S EC	MEM_P AGE	MEM_A DDR	MEM_A DDR	DB0	DB1	DB2	DB3	CRC Byte
A6-A0	W0	CW23	CW22	CW21- CW20	CW19- CW16	CW15- CW12	CW11- CW8	CW7- CW0	D7-D0	D7-D0	D7-D0	D7-D0	C7-C0
0x60	0x0	0x0	0x1	0x1	0x0	0x0	0x0	0x80	0xCD	0xAB	0x34	0x12	0x45
0xC0 0x50			0x00		0x80	0xCD	0xAB	0x34	0x12	0x45			

Example for 64-bit Write Operation: Address - 0x00000080, Data Address 0x00000080 - Data 0x01234567, Data Address 0x00000082 - Data 0x89ABCDEF, CRC Byte - 0x45 (Sample value; does not match with the actual CRC calculation)

表 7-8. Example for 64-bit Write Operation Packet

	· · · · · · · · · · · · · · · · · · ·											
Start By	te	Control Word 0				Control Word	1	Control Word 2	Data Bytes	CRC		
Target ID	I ² C Write	OP_R/W	CRC_EN	DLEN	MEM_SEC	MEM_PAGE	MEM_ADDR	MEM_ADDR	DB0 - DB7	CRC Byte		
A6-A0	W0	CW23	CW22	CW21- CW20	CW19- CW16	CW15- CW12	CW11-CW8	CW7-CW0	[D7-D0] x 8	C7-C0		
0x60	0x0	0x0	0x1	0x2	0x0	0x0	0x0	0x80	0x67452301EFCDAB89	0x45		
0xC0		0x60				0x00		0x80	0x67452301EFCDAB89	0x45		

Example for 32-bit Read Operation: Address - 0x00000080, Data - 0x1234ABCD, CRC Byte - 0x56 (Sample value; does not match with the actual CRC calculation)

表 7-9. Example for 32-bit Read Operation Packet

Start Byte		Control Word 0			-		Control Word 2	Start By	te	Byte 0	Byte 1	Byte 2	Byte 3	Byte 4	
Target ID	I ² C Write	R/W	CRC_ EN	DLEN	MEM_ SEC	MEM_ PAGE	MEM_ ADDR	MEM_ ADDR	Target ID	I ² C Read	DB0	DB1	DB2	DB3	CRC Byte
A6-A0	W0	CW23	CW22	CW21- CW20	CW19- CW16	CW15- CW12	CW11- CW8	CW7- CW0	A6-A0	W0	D7-D0	D7-D0	D7-D0	D7-D0	C7-C0
0x60	0x0	0x1	0x1	0x1	0x0	0x0	0x0	0x80	0x60	0x1	0xCD	0xAB	0x34	0x12	0x56

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

77



表 7-9. Example for 32-bit Read Operation Packet (continued)

	• · · · · · · · · · · · · · · · · · · ·		•	,		,				
0xC0	0xD0	0x00	0x80	0xC1	0xCD	0xAB	0x34	0x12	0x56	

7.6.2.5 I²C Clock Stretching

The I²C peripheral in MCT8315A implements clock stretching under certain conditions when there are pending I²C interrupts waiting to be processed. During clock stretching, MCT8315A pulls SCL low and the I²C bus is unavailable for use by other devices. The following is a list of conditions under which clock stretching can occur:

- 1. Start interrupt pending: There are two scenarios when a start interrupt can result in clock stretching,
 - a. When target ID is a match, I²C peripheral in MCT8315A raises a start interrupt request. Until this start interrupt request is processed, clock is stretched. Upon processing this request, clock is released and an ACK (marked in yellow or grey in 图 7-54 and 图 7-55) is sent to the controller for continuing with the transaction.
 - b. If Start (followed by target ID match) for a new transaction is received when a receive interrupt from previous transaction is yet to be processed, clock is stretched until both the receive interrupt and start interrupt are processed in chronological order. This process ensures that previous transaction is executed correctly before initiating the next transaction.
- 2. **Receive interrupt pending**: When a receive interrupt is waiting to be processed and the receive register is full which occurs when two successive bytes (data or control) have been received by MCT8315A (separated by one ACK shown as blue boxes in
 7-54 and 7-55) without the receive interrupt generated by the first byte being processed. Upon receive of second byte, clock is stretched until receive interrupt generated by the first byte is processed.
- 3. **Transmit buffer is empty**: In case of a transmit interrupt pending (to send data back to controller), if the transmit buffer is waiting to be populated with data to be read back to the controller, clock stretching is done until the transmit buffer is populated with requested data. After the buffer is populated, clock is released and data is sent to controller.

备注

I²C clock stretching is timed out after 5 ms by MCT8315A to allow I²C bus access for other devices on the same bus.

7.6.2.6 CRC Byte Calculation

An 8-bit CCIT polynomial ($x^8 + x^2 + x + 1$) and CRC initial value 0xFF is used for CRC computation.

CRC Calculation in Write Operation: When the external MCU writes to MCT8315A, if the CRC is enabled, the external MCU has to compute an 8-bit CRC byte and add the CRC byte at the end of the data. MCT8315A will compute CRC using the same polynomial internally and if there is a mismatch, the write request is discarded. Input data for CRC calculation by external MCU for write operation are listed below:

- 1. Target ID + write bit.
- 2. Control word 3 bytes
- 3. Data bytes 2/4/8 bytes

CRC Calculation in Read Operation: When the external MCU reads from MCT8315A, if the CRC is enabled, MCT8315A sends the CRC byte at the end of the data. The CRC computation in read operation involves the start byte, control words sent by external MCU along with data bytes sent by MCT8315A. Input data for CRC calculation by external MCU to verify the data sent by MCT8315A are listed below:

Product Folder Links: MCT8315A

- 1. Target ID + write bit
- 2. Control word 3 bytes
- 3. Target ID + read bit
- 4. Data bytes 2/4/8 bytes

Copyright © 2023 Texas Instruments Incorporated

7.7 EEPROM (Non-Volatile) Register Map

7.7.1 Algorithm_Configuration Registers

 $\bar{\chi}$ 7-10 lists the memory-mapped registers for the Algorithm_Configuration registers. All register offset addresses not listed in $\bar{\chi}$ 7-10 should be considered as reserved locations and the register contents should not be modified.

表 7-10. ALGORITHM_CONFIGURATION Registers

Offset	Acronym	Register Name	Section
80h	ISD_CONFIG	ISD configuration	ISD_CONFIG Register (Offset = 80h) [Reset = 00000000h]
82h	MOTOR_STARTUP1	Motor start-up configuration 1	MOTOR_STARTUP1 Register (Offset = 82h) [Reset = 00000000h]
84h	MOTOR_STARTUP2	Motor start-up configuration 2	MOTOR_STARTUP2 Register (Offset = 84h) [Reset = X]
86h	CLOSED_LOOP1	Closed loop configuration 1	CLOSED_LOOP1 Register (Offset = 86h) [Reset = 00000000h]
88h	CLOSED_LOOP2	Closed loop configuration 2	CLOSED_LOOP2 Register (Offset = 88h) [Reset = 00000000h]
8Ah	CLOSED_LOOP3	Closed loop configuration 3	CLOSED_LOOP3 Register (Offset = 8Ah) [Reset = 14000000h]
8Ch	CLOSED_LOOP4	Closed loop configuration 4	CLOSED_LOOP4 Register (Offset = 8Ch) [Reset = 00000000h]
8Eh	CONST_SPEED	Constant speed configuration	CONST_SPEED Register (Offset = 8Eh) [Reset = 00000000h]
90h	CONST_PWR	Constant power configuration	CONST_PWR Register (Offset = 90h) [Reset = 00000000h]
96h	150_DEG_TWO_PH_PROFILE	150° Two-ph profile	150_DEG_TWO_PH_PROFILE Register (Offset = 96h) [Reset = 00000000h]
98h	150_DEG_THREE_PH_PROFIL E	150° Three-ph profile	150_DEG_THREE_PH_PROFILE Register (Offset = 98h) [Reset = 00000000h]
9Ah	TRAP_CONFIG1	Trap configuration 1	TRAP_CONFIG1 Register (Offset = 9Ah) [Reset = 00000000h]
9Ch	TRAP_CONFIG2	Trap configuration 2	TRAP_CONFIG2 Register (Offset = 9Ch) [Reset = 00200000h]

Complex bit access types are encoded to fit into small table cells. 表 7-11 shows the codes that are used for access types in this section.

表 7-11. Algorithm_Configuration Access Type Codes

Access Type	Code	Description							
Read Type									
R	R	Read							
Write Type									
W	W	Write							
Reset or Defaul	t Value								
-n		Value after reset or the default value							

7.7.1.1 ISD_CONFIG Register (Offset = 80h) [Reset = 00000000h]

ISD_CONFIG is shown in 图 7-56 and described in 表 7-12.

Return to the Summary Table.

Register to configure initial speed detect settings

图 7-56. ISD CONFIG Register

	M 7-30. ISD_CONFIG Register												
31	30	29	28	27	26	25	24						
PARITY	ISD_EN	BRAKE_EN	HIZ_EN	RVS_DR_EN	RESYNC_EN	STAT_BRK_EN	STAT_DETECT _THR						
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h R/W-0h R/W-0		R/W-0h	R/W-0h						
23	22	21	20	19	19 18		16						
STAT_DET	TECT_THR	BRK_MODE	RESERVED		BRK_TIME								
R/W	V-0h	R/W-0h	R/W-0h	R/W-0h			R/W-0h						
15	14	13	12	11	10	9	8						
	BRK_TIME		HIZ_TIME STARTT										
	R/W-0h			R/V	/-0h		R/W-0h						
7	6	5	4	3	2	1	0						
STARTUP_	BRK_TIME	RESY	NC_MIN_THRES	HOLD	RESERVED								
R/W	V-0h		R/W-0h		R/W-0h								

表 7-12. ISD_CONFIG Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30	ISD_EN	R/W	0h	ISD enable 0h = Disable 1h = Enable
29	BRAKE_EN	R/W	0h	Brake enable 0h = Disable 1h = Enable
28	HIZ_EN	R/W	0h	Hi-Z enable 0h = Disable 1h = Enable
27	RVS_DR_EN	R/W	0h	Reverse drive enable 0h = Disable 1h = Enable
26	RESYNC_EN	R/W	0h	Resynchronization enable 0h = Disable 1h = Enable
25	STAT_BRK_EN	R/W	0h	Enable or disable brake during stationary 0h = Disable 1h = Enable
24-22	STAT_DETECT_THR	R/W	Oh	Stationary BEMF detect threshold 0h = 5 mV 1h = 10 mV 2h = 15 mV 3h = 20 mV 4h = 25 mV 5h = 30 mV 6h = 50 mV 7h = 100 mV

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated



表 7-12. ISD_CONFIG Register Field Descriptions (continued)

Bit Field Type Reset Description					riela Descriptions (continuea)		
Discription	Bit	Field	Туре	Reset	Description		
19-17 RESERVED R/W Oh Reserved	21	BRK_MODE	R/W	0h	0h = All three low-side FETs turned ON		
16-13 BRK_TIME R/W Oh Brake time h = 10 ms h = 10 ms h = 10 ms h = 200 ms h = 300 ms h = 400 ms h = 10 ms h = 400 ms h = 400 ms h = 400 ms h = 400 ms h = 200 ms h = 200 ms h = 300 ms h = 300 ms h = 300 ms h = 300 ms h = 10 ms h = 400 ms h = 10 ms h = 100 ms h = 10	20	RESERVED	R/W	0h	Reserved		
N = 10 ms	19-17	RESERVED	R/W	0h	Reserved		
0h = 10 ms	16-13	BRK_TIME	R/W	Oh	0h = 10 ms 1h = 50 ms 2h = 100 ms 3h = 200 ms 4h = 300 ms 5h = 400 ms 6h = 500 ms 7h = 750 ms 8h = 1 s 9h = 2 s Ah = 3 s Bh = 4 s Ch = 5 s Dh = 7.5 s Eh = 10 s		
Oh = 1 ms	12-9	HIZ_TIME	R/W	Oh	0h = 10 ms 1h = 50 ms 2h = 100 ms 3h = 200 ms 4h = 300 ms 5h = 400 ms 6h = 500 ms 7h = 750 ms 8h = 1 s 9h = 2 s Ah = 3 s Bh = 4 s Ch = 5 s Dh = 7.5 s Eh = 10 s		
OLD resync 0h = computed based on MIN_DUTY 1h = 300 mV 2h = 400 mV 3h = 500 mV 4h = 600 mV 5h = 800 mV 6h = 1000 mV 7h = 1250 mV	8-6	STARTUP_BRK_TIME	R/W	0h	0h = 1 ms 1h = 10 ms 2h = 25 ms 3h = 50 ms 4h = 100 ms 5h = 250 ms 6h = 500 ms		
2-0 RESERVED R/W 0h Reserved		OLD			resync 0h = computed based on MIN_DUTY 1h = 300 mV 2h = 400 mV 3h = 500 mV 4h = 600 mV 5h = 800 mV 6h = 1000 mV 7h = 1250 mV		
	2-0	RESERVED	R/W	0h	Reserved		

7.7.1.2 MOTOR_STARTUP1 Register (Offset = 82h) [Reset = 00000000h]

MOTOR_STARTUP1 is shown in 图 7-57 and described in 表 7-13.

Return to the Summary Table.

Register to configure motor startup settings1

图 7-57. MOTOR STARTUP1 Register

		Д,		.,	9.0.0.			
31	30	29	28	27	26	25	24	
PARITY	MTR_S	TARTUP		ALIGN_RA	MP_RATE		ALIGN_TIME	
R/W-0h	R/W	/-0h		R/W-0h R/W				
23	22	21	20	19	18	17	16	
	ALIGN_TIME			ALIGN_C	URR_THR		IPD_CLK_FRE Q	
	R/W-0h			R/W-0h				
15	14	13	12	11	10	9	8	
IPD_CLI	K_FREQ		IPD_CU	RR_THR		IPD_RLS_MODE		
R/M	/-0h		R/V	V-0h		R/V	V-0h	
7	6	5	4	3	2	1	0	
IPD_ADV_ANGLE IPD_RE			EPEAT SLOW_FIRST_CYC_FREQ					
R/M	R/W-0h R/W			-0h R/W-0h				

表 7-13. MOTOR_STARTUP1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-29	MTR_STARTUP	R/W	0h	Motor start-up method 0h = Align 1h = Double Align 2h = IPD 3h = Slow first cycle
28-25	ALIGN_RAMP_RATE	R/W	Oh	Align voltage ramp rate 0h = 0.1 V/s 1h = 0.2 V/s 2h = 0.5 V/s 3h = 1 V/s 4h = 2.5 V/s 5h = 5 V/s 6h = 7.5 V/s 7h = 10 V/s 8h = 25 V/s 9h = 50 V/s Ah = 75 V/s Bh = 100 V/s Ch = 250 V/s Dh = 500 V/s Eh = 750 V/s Fh = 1000 V/s

Submit Document Feedback Copyr

表 7-13. MOTOR_STARTUP1 Register Field Descriptions (continued)

	表 7-13. MOTOR_STARTUP1 Register Field Descriptions (continued)									
Bit	Field	Туре	Reset	Description						
24-21	ALIGN_TIME	R/W	Oh	Align time 0h = 5 ms 1h = 10 ms 2h = 25 ms 3h = 50 ms 4h = 75 ms 5h = 100 ms 6h = 200 ms 7h = 400 ms 8h = 600 ms 9h = 800 ms Ah = 1 s Bh = 2 s Ch = 4 s Dh = 6 s Eh = 8 s Fh = 10 s						
20-17	ALIGN_CURR_THR	R/W	Oh	Align current threshold (Align current threshold (A) = ALIGN_CURR_THR / CSA_GAIN) 0h = Reserved 1h = 0.1V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V						
16-14	IPD_CLK_FREQ	R/W	Oh	IPD clock frequency 0h = 50 Hz 1h = 100 Hz 2h = 250 Hz 3h = 500 Hz 4h = 1000 Hz 5h = 2000 Hz 6h = 5000 Hz 7h = 10000 Hz						
13-10	IPD_CURR_THR	R/W	Oh	IPD current threshold (IPD current threshold (A) = IPD_CURR_THR / CSA_GAIN) 0h = Reserved 1h = Reserved 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V						



表 7-13. MOTOR STARTUP1 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
9-8	IPD_RLS_MODE	R/W	0h	IPD release mode 0h = Brake 1h = Tristate 2h = Reserved 3h = Reserved
7-6	IPD_ADV_ANGLE	R/W	0h	IPD advance angle 0h = 0° 1h = 30° 2h = 60° 3h = 90°
5-4	IPD_REPEAT	R/W	0h	Number of times IPD is executed 0h = one 1h = average of 2 times 2h = average of 3 times 3h = average of 4 times
3-0	SLOW_FIRST_CYC_FRE Q	R/W	Oh	Frequency of first cycle 0h = 0.05 Hz 1h = 0.1 Hz 2h = 0.25 Hz 3h = 0.5 Hz 4h = 1 Hz 5h = 2 Hz 6h = 3 Hz 7h = 5 Hz 8h = 10 Hz 9h = 15 Hz Bh = 25 Hz Ch = 50 Hz Dh = 100 Hz Eh = 150 Hz Fh = 200 Hz

7.7.1.3 MOTOR_STARTUP2 Register (Offset = 84h) [Reset = X]

MOTOR_STARTUP2 is shown in 图 7-58 and described in 表 7-14.

Return to the Summary Table.

Register to configure motor startup settings2

图 7-58. MOTOR STARTUP2 Register

图 7-56. MOTOR_STARTUP2 Register									
31	30	29	28	27	26	25	24		
PARITY	OL_ILIMIT_CO NFIG		OL_DUTY OL_ILIMIT						
R/W-0h	R/W-0h		R/W-0h			R/W-0h			
23	22	21	20	19	18	17	16		
OL_ILIMIT			OL_ACC_A1			OL_A	CC_A2		
R/W-0h		R/W-0h R/W-0h							
15	14	13	12	11	10	9	8		
	OL_ACC_A2		OPN_CL_HANDOFF_THR						
	R/W-0h				R/W-0h				
7	6	5	4	3	2	1	0		
AUTO_HANDO FF	FIRST_CYCLE _FREQ_SEL	MIN_DUTY RESERVED							
R/W-0h	R/W-0h		R/W-	0h		R	-X		

表 7-14. MOTOR_STARTUP2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30	OL_ILIMIT_CONFIG	R/W	Oh	Open loop current limit configuration 0h = Open loop current limit defined by OL_ILIMIT 1h = Open loop current limit defined by ILIMIT
29-27	OL_DUTY	R/W	Oh	Duty cycle limit during open loop 0h = 10% 1h = 15% 2h = 20% 3h = 25% 4h = 30% 5h = 40% 6h = 50% 7h = 100%
26-23	OL_ILIMIT	R/W	Oh	Open loop current limit (OL current threshold (A) = OL_CURR_THR / CSA_GAIN) 0h = Reserved 1h = 0.1V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V



表 7-14. MOTOR_STARTUP2 Register Field Descriptions (continued)

	Rit Field Time Boost Becautivitien						
Bit	Field	Type	Reset	Description			
22-18	OL_ACC_A1	R/W	0h	Open loop acceleration A1			
				0h = 0.005 Hz/s			
				1h = 0.01 Hz/s			
				2h = 0.025 Hz/s			
				3h = 0.05 Hz/s			
				4h = 0.1 Hz/s			
				5h = 0.25 Hz/s			
				6h = 0.5 Hz/s			
				7h = 1 Hz/s			
				8h = 2.5 Hz/s			
				9h = 5 Hz/s			
				Ah = 7.5 Hz/s			
				Bh = 10 Hz/s			
				Ch = 12.5 Hz/s			
				Dh = 15 Hz/s			
				Eh = 20 Hz/s			
				Fh = 30 Hz/s			
				10h = 40 Hz/s			
				11h = 50 Hz/s			
				12h = 60 Hz/s			
				13h = 75 Hz/s			
				14h = 100 Hz/s			
				15h = 125 Hz/s			
				16h = 150 Hz/s			
				17h = 175 Hz/s			
				18h = 200 Hz/s			
				19h = 250 Hz/s			
				1Ah = 300 Hz/s			
				1Bh = 400 Hz/s			
				1Ch = 500 Hz/s			
				1Dh = 750 Hz/s			
				1Eh = 1000 Hz/s			
				1Fh = No Limit (32767) Hz/s			

表 7-14. MOTOR STARTUP2 Register Field Descriptions (continued)

Rit Field Type Reset Description						
Bit	Field	Туре	Reset	Description		
17-13	OL_ACC_A2	R/W	0h	Open loop acceleration A2		
				0h = 0.005 Hz/s2		
				1h = 0.01 Hz/s2		
				2h = 0.025 Hz/s2		
				3h = 0.05 Hz/s2		
				4h = 0.1 Hz/s2		
				5h = 0.25 Hz/s2		
				6h = 0.5 Hz/s2		
				7h = 1 Hz/s2		
				8h = 2.5 Hz/s2		
				9h = 5 Hz/s2		
				Ah = 7.5 Hz/s2		
				Bh = 10 Hz/s2		
				Ch = 12.5 Hz/s2		
				Dh = 15 Hz/s2		
				Eh = 20 Hz/s2		
				Fh = 30 Hz/s2		
				10h = 40 Hz/s2		
				11h = 50 Hz/s2		
				12h = 60 Hz/s2		
				13h = 75 Hz/s2		
				14h = 100 Hz/s2		
				15h = 125 Hz/s2		
				16h = 150 Hz/s2		
				17h = 175 Hz/s2		
				18h = 200 Hz/s2		
				19h = 250 Hz/s2		
				1Ah = 300 Hz/s2		
				1Bh = 400 Hz/s2		
				1Ch = 500 Hz/s2		
				1Dh = 750 Hz/s2		
				1Eh = 1000 Hz/s2		
				1Fh = No Limit (32767) Hz/s2		



表 7-14. MOTOR_STARTUP2 Register Field Descriptions (continued)

		表 7-14. MOTOR_STARTUP2 Register Field Descriptions (continued)						
Bit	Field	Туре	Reset	Description				
12-8	OPN_CL_HANDOFF_TH R	R/W	Oh	Open to closed loop handoff threshold 0h = 1 Hz 1h = 4 Hz 2h = 8 Hz 3h = 12 Hz 4h = 16 Hz 5h = 20 Hz 6h = 24 Hz 7h = 28 Hz 8h = 32 Hz 9h = 36 Hz Ah = 40 Hz Bh = 45 Hz Ch = 50 Hz Dh = 55 Hz Eh = 60 Hz Fh = 65 Hz 10h = 70 Hz 11h = 75 Hz 12h = 80 Hz 13h = 85 Hz 14h = 90 Hz 15h = 100 Hz 16h = 150 Hz 17h = 200 Hz 18h = 250 Hz 19h = 300 Hz 18h = 450 Hz 11h = 550 Hz				
7	AUTO_HANDOFF	R/W	Oh	Auto handoff enable 0h = Disable Auto Handoff (and use OPN_CL_HANDOFF_THR) 1h = Enable Auto Handoff				
6	FIRST_CYCLE_FREQ_S EL	R/W	0h	First cycle frequency select 0h = Defined by SLOW_FIRST_CYC_FREQ 1h = 0 Hz				
5-2	MIN_DUTY	R/W	0h	Min operational duty cycle 0h = 1.5 % 1h = 2 % 2h = 3 % 3h = 4 % 4h = 5 % 5h = 6 % 6h = 7 % 7h = 8 % 8h = 9 % 9h = 10 % Ah = 12 % Bh = 15 % Ch = 17.5 % Dh = 20 % Eh = 25 % Fh = 30 %				
1-0	RESERVED	R	Х	Reserved				

7.7.1.4 CLOSED_LOOP1 Register (Offset = 86h) [Reset = 00000000h]

CLOSED_LOOP1 is shown in 图 7-59 and described in 表 7-15.

Return to the Summary Table.

Register to configure close loop settings1

图 7-59. CLOSED LOOP1 Register

El 7-33. GEOGLD_EGGI 1 Register									
31	30	29	28	27	26	25	24		
PARITY	COMM_C	ONTROL			CL_ACC				
R/W-0h	R/W	/-0h		R/W-0h					
23	22	21	20	19	18	17	16		
CL_DEC_CON FIG	CL_DEC PWM_FR						EQ_OUT		
R/W-0h			R/W-0h			R/W-0h			
15	14	13	12	11	10	9	8		
F	PWM_FREQ_OUT	-	PWM_MODUL PWM_MODE L			LD_ANGLE_PO LARITY	LD_ANGLE		
	R/W-0h		R/W-0h R/W-0h		R/W-0h	R/W-0h	R/W-0h		
7	6	5	4	3	2	1	0		
			LD_ANGLE				RESERVED		
R/W-0h									

表 7-15. CLOSED_LOOP1 Register Field Descriptions

_				_	
	Bit	Field	Туре	Reset	Description
	31	PARITY	R/W	0h	Parity bit
	30-29	COMM_CONTROL	R/W	0h	Trapezoidal commutation mode 0h = 120° Commutation 1h = Variable commutation between 120° and 150° 2h = Reserved 3h = Reserved



₹ 7-15. CLOSED_LOOP1 Register Field Descriptions (continued)						
Bit	Field	Туре	Reset	Description		
28-24	CL_ACC	R/W	0h	Closed loop acceleration rate 0h = 0.005 V/s 1h = 0.01 V/s 2h = 0.025 V/s 3h = 0.05 V/s 4h = 0.1 V/s 5h = 0.25 V/s		
				6h = 0.5 V/s 7h = 1 V/s 8h = 2.5 V/s 9h = 5 V/s Ah = 7.5 V/s Bh = 10 V/s Ch = 12.5 V/s Dh = 15 V/s Eh = 20 V/s Fh = 30 V/s		
				10h = 40 V/s 11h = 50 V/s 12h = 60 V/s 13h = 75 V/s 14h = 100 V/s 15h = 125 V/s 16h = 150 V/s 17h = 175 V/s 18h = 200 V/s 19h = 250 V/s		
23	CL_DEC_CONFIG	R/W	0h	1Ah = 300 V/s 1Bh = 400 V/s 1Ch = 500 V/s 1Dh = 750 V/s 1Eh = 1000 V/s 1Fh = 32767 V/s Closed loop decel configuration 0h = Close loop deceleration defined by CL_DEC 1h = Close loop deceleration defined by CL_ACC		

Bit	Field	Type	Reset	Description (continued)
22-18	CL_DEC	R/W	0h	Closed loop deceleration rate
				0h = 0.005 V/s
				1h = 0.01 V/s
				2h = 0.025 V/s
				3h = 0.05 V/s
				4h = 0.1 V/s
				5h = 0.25 V/s
				6h = 0.5 V/s
				7h = 1 V/s
				8h = 2.5 V/s
				9h = 5 V/s
				Ah = 7.5 V/s
				Bh = 10 V/s
				Ch = 12.5 V/s
				Dh = 15 V/s
				Eh = 20 V/s
				Fh = 30 V/s
				10h = 40 V/s
				11h = 50 V/s
				12h = 60 V/s
				13h = 75 V/s
				14h = 100 V/s
				15h = 125 V/s
				16h = 150 V/s
				17h = 175 V/s
				18h = 200 V/s
				19h = 250 V/s
				1Ah = 300 V/s
				1Bh = 400 V/s
				1Ch = 500 V/s
				1Dh = 750 V/s
				1Eh = 1000 V/s
				1Fh = 32767 V/s



Bit	Field	Туре	Reset	Description (continuou)
17-13	PWM_FREQ_OUT	R/W	Oh	Output PWM switching frequency 0h = 5 kHz 1h = 6 kHz 2h = 7 kHz 3h = 8 kHz 4h = 9 kHz 5h = 10 kHz 6h = 11 kHz 7h = 12 kHz 8h = 13 kHz 9h = 14 kHz Ah = 15 kHz Bh = 16 kHz Ch = 17 kHz Dh = 18 kHz Eh = 19 kHz Fh = 20 kHz 10h = 25 kHz 11h = 30 kHz 12h = 35 kHz 13h = 40 kHz 14h = 45 kHz 15h = 50 kHz 16h = 55 kHz 17h = 60 kHz 18h = 70 kHz 18h = 70 kHz 18h = 70 kHz 18h = 80 kHz 19h = 70 kHz 18h = 80 kHz 1Ch = 85 kHz 1Dh = 90 kHz 1Eh = 95 kHz
12-11	PWM_MODUL	R/W	0h	PWM modulation. 0h = High-Side Modulation 1h = Low-Side Modulation 2h = Mixed Modulation 3h = Reserved
10	PWM_MODE	R/W	Oh	PWM mode 0h = Single Ended Mode 1h = Complementary Mode
9	LD_ANGLE_POLARITY	R/W	0h	Polarity of applied lead angle 0h = Negative 1h = Positive
8-1	LD_ANGLE	R/W	0h	Lead Angle {Lead Angle (deg) = LD_ANGLE * 0.12}
0	RESERVED	R/W	0h	Reserved

7.7.1.5 CLOSED_LOOP2 Register (Offset = 88h) [Reset = 00000000h]

CLOSED_LOOP2 is shown in 图 7-60 and described in 表 7-16.

Return to the Summary Table.

Register to configure close loop settings2

图 7-60. CLOSED LOOP2 Register

		isi i	-00. CLOSED	_LOOP2 Regi	3161			
31	30	29	28	27	26	25	24	
PARITY	FG_	SEL		FG_DIV_	FACTOR		RESERVED	
R/W-0h	R/W	/-0h		R/W	/-0h		R/W-0h	
23	22	21	20	19	18	17	16	
	FG_BEMF_THR			MTR_STOP		MTR_STOP	P_BRK_TIME	
	R/W-0h			R/W-0h		R/V	V-0h	
15	14	13	12	11	10	9	8	
MTR_STOP	_BRK_TIME	A	CT_SPIN_BRK_T	HR	BRAKE_DUTY_THRESHOLD			
R/W	V-0h		R/W-0h			R/W-0h		
7	6	5	4	3	2	1	0	
AVS_EN		CBC_	ILIMIT RESERVED					
R/W-0h		R/V	V-0h R/W-0h					

表 7-16. CLOSED_LOOP2 Register Field Descriptions

Bit	Field	Туре	Reset	Description	
31	PARITY	R/W	0h	Parity bit	
30-29	FG_SEL	R/W	0h	FG mode select 0h = Output FG in open loop and closed loop 1h = Output FG in only closed loop 2h = Output FG in open loop for the first try. 3h = Reserved	
28-25	FG_DIV_FACTOR	R/W	Oh	FG division factor 0h = Divide by 3 (2-pole motor mechanical speed/3) 1h = Divide by 1 (2-pole motor mechanical speed) 2h = Divide by 2 (4-pole motor mechanical speed) 3h = Divide by 3 (6-pole motor mechanical speed) 4h = Divide by 4 (8-pole motor mechanical speed) 5h = Divide by 5 (10-pole motor mechanical speed) 6h = Divide by 6 (12-pole motor mechanical speed) 7h = Divide by 7 (14-pole motor mechanical speed) 8h = Divide by 8 (16-pole motor mechanical speed) 9h = Divide by 9 (18-pole motor mechanical speed) Ah = Divide by 10 (20-pole motor mechanical speed) Bh = Divide by 11 (22-pole motor mechanical speed) Ch = Divide by 12 (24-pole motor mechanical speed) Dh = Divide by 13 (26-pole motor mechanical speed) Eh = Divide by 14 (28-pole motor mechanical speed) Fh = Divide by 15 (30-pole motor mechanical speed)	
24	RESERVED	R/W	0h	Reserved	
23-21	FG_BEMF_THR	R/W	Oh	FG output BEMF threshold 0h = +/- 1mV 1h = +/- 2mV 2h = +/- 5mV 3h = +/- 10mV 4h = +/- 20mV 5h = +/- 30mV 6h = Reserved 7h = Reserved	



Bit	Field	Type	Reset	Description (continues)
20-18	MTR_STOP	R/W	Oh	Motor stop method 0h = Hi-z 1h = Recirculation 2h = Low-side braking 3h = High-side braking 4h = Active spin down 5h = Reserved 6h = Reserved 7h = Reserved
17-14	MTR_STOP_BRK_TIME	R/W	Oh	Brake time during motor stop 0h = 1 ms 1h = 2 ms 2h = 5 ms 3h = 10 ms 4h = 15 ms 5h = 25 ms 6h = 50 ms 7h = 75 ms 8h = 100 ms 9h = 250 ms Ah = 500 ms Bh = 1000 ms Ch = 2500 ms Dh = 5000 ms Eh = 10000 ms Fh = 15000 ms
13-11	ACT_SPIN_BRK_THR	R/W	Oh	Duty cycle threshold for motor stop using active spin down, low- and high-side braking 0h = Immediate 1h = 50 % 2h = 25 % 3h = 15 % 4h = 10 % 5h = 7.5 % 6h = 5 % 7h = 2.5 %
10-8	BRAKE_DUTY_THRESH OLD	R/W	Oh	Duty cycle threshold for BRAKE pin based low-side braking 0h = Immediate 1h = 50 % 2h = 25 % 3h = 15 % 4h = 10 % 5h = 7.5 % 6h = 5 % 7h = 2.5 %
7	AVS_EN	R/W	0h	AVS enable 0h = Disable 1h = Enable

Bit	Field	Туре	Reset	Description
6-3	CBC_ILIMIT	R/W	Oh	Cycle by Cycle (CBC) current limit (CBC current limit (A) = CBC_ILIMIT / CSA_GAIN) 0h = Reserved 1h = 0.1 V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V
2-0	RESERVED	R/W	0h	Fh = 1.5 V Reserved

7.7.1.6 CLOSED_LOOP3 Register (Offset = 8Ah) [Reset = 14000000h]

CLOSED_LOOP3 is shown in 图 7-61 and described in 表 7-17.

Return to the Summary Table.

Register to configure close loop settings3

图 7-61. CLOSED LOOP3 Register

		ъ.	• • • • • • • • •					
31	30	29	28	27	26	25	24	
PARITY	DYN_DGS_F	FILT_COUNT	DYN_DGS_U	JPPER_LIM	DYN_DGS_L	OWER_LIM	INTEG_CYCL_ THR_LOW	
R/W-0h	R/W	/-0h	R/W	/-2h	R/W	/-2h	R/W-0h	
23	22	21	20	19	18	17	16	
INTEG_CYCL_ THR_LOW	INTEG_CYCI	_THR_HIGH	INTEG_DUTY	_THR_LOW	INTEG_DUTY	_THR_HIGH	BEMF_THRES HOLD2	
R/W-0h	R/W	/-0h	R/W	/-0h	R/W	′-0h	R/W-0h	
15	14	13	12	11	10	9	8	
	BE	MF_THRESHOL	D2		BEMF_THRESHOLD1			
		R/W-0h				R/W-0h		
7	6	5	4	3	2	1	0	
BE	EMF_THRESHOL	D1	INTEG_ZC_ME THOD	DE	EGAUSS_MAX_W	IN	DYN_DEGAUS S_EN	
	R/W-0h		R/W-0h		R/W-0h		R/W-0h	

表 7-17. CLOSED_LOOP3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-29	DYN_DGS_FILT_COUNT	R/W	0h	Number of samples needed for dynamic degauss check $0h = 15$ $1h = 20$ $2h = 30$ $3h = 12$
28-27	DYN_DGS_UPPER_LIM	R/W	2h Dynamic degauss voltage upper bound 0h = (VM - 0.09) V 1h = (VM - 0.12) V 2h = (VM - 0.15) V 3h = (VM - 0.18) V	
26-25	DYN_DGS_LOWER_LIM	R/W	2h	Dynamic degauss voltage lower bound 0h = 0.03 V 1h = 0.06 V 2h = 0.09 V 3h = 0.12 V
24-23	INTEG_CYCL_THR_LOW	R/W	Oh	Number of BEMF samples per 30° below which commutation method switches from integration to ZC 0h = 3 1h = 4 2h = 6 3h = 8
22-21	INTEG_CYCL_THR_HIG H	R/W	0h	Number of BEMF samples per 30° above which commutation method switches from ZC to integration 0h = 4 1h = 6 2h = 8 3h = 10

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

The second secon							
Bit	Field	Туре	Reset	Description			
20-19	INTEG_DUTY_THR_LOW	R/W	Oh	Duty cycle below which commutation method switches from integration to ZC 0h = 12 % 1h = 15 % 2h = 18 % 3h = 20 %			
18-17	INTEG_DUTY_THR_HIG H	R/W	0h	Duty cycle above which commutation method switches from ZC to integration 0h = 12 % 1h = 15 % 2h = 18 % 3h = 20 %			



SEMF_THRESHOLD2 SEMF_Threshold for integration based commutation during falling lineating phase voltage SEMF_THRESHOLD2 SEMF_THRES	Bit	Field	Type	Reset	Description
floating phase voltage Oh = 0 1h = 25 2h = 50 3h = 75 4h = 100 5h = 150 7h = 175 8h = 100 7h = 175 8h = 200 9h = 225 8h = 250 8h = 275 Ch = 300 Dh = 325 En = 350 Fh = 378 Toh = 400 The = 550 The = 577 The = 577 The = 578 The = 778 T					
0h = 0 1h = 25 2h = 50 3h = 75 4h = 100 5h = 125 6h = 1515 6h = 1515 6h = 1515 6h = 1515 6h = 225 6h = 230 6h = 235 6h = 350 7h = 360 7h = 360 7h = 360 7h = 400 7h = 500 7h = 775 7h = 600 7h = 725 7h = 775 7h = 700 7h = 725 7h = 750 7h =	16-11	BEMF_IHRESHOLD2	R/W	Uh	
1					
2n = 50 3h = 75 4h = 100 5h = 125 6h = 150 7h = 176 8h = 205 9h = 225 9h = 235 9h = 235 9h = 240 9h = 250 9h = 100 9h = 250 9h = 100 9h = 1200					
Sh = 75					
## 100 ## 125 ## 125 ## 160 ## 175 ## 175 ## 120 ## 18					
\$ 125 \$ 6					
6h = 150 7h = 175 8h = 200 9h = 225 Ah = 225 Ah = 250 Bh = 275 Ch = 300 Dh = 325 En = 350 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 550 16h = 550 16h = 550 17h = 575 16h = 600 18h = 625 14h = 650 18h = 675 16h = 750 16h = 160 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1100 25h = 1200 25h = 1400 2					
Th = 175					
## SP					
Ah = 250 Bh = 275 Ch = 300 Dh = 325 Eh = 385 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 476 14h = 500 15h = 525 16h = 550 17h = 576 18h = 600 19h = 626 14h = 680 19h = 626 14h = 680 19h = 675 10h = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1100 27h = 1150 28h = 1250 28h = 1360 28h = 1460 28h = 1550 30h = 1460 33h = 2000 33h = 1900 33h = 1900 33h = 2000					
Bh = 275 Ch = 300 Dh = 325 Eh = 350 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 650 17h = 675 18h = 600 19h = 825 14h = 500 19h = 825 14h = 500 10h = 725 12h = 700 10h = 725 12h = 700 12h = 800 12h = 1000 12h = 1500 1					9h = 225
Ch = 300 Dh = 325 Eh = 350 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 14h = 650 18h = 650 18h = 675 1Ch = 700 1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 800 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 24h = 1300 28h = 1350 2Ch = 1450 2Ch = 1					
Dh = 325 Eh = 350 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 14h = 650 16h = 750 16h = 770 16h = 725 16h = 780 17h = 775 20h = 800 22h = 900 22h = 950 22h = 950 22h = 100 25h = 1100 27h = 1150 28h = 1200 28h = 1200 28h = 1300 28h = 1300 28h = 1300 28h = 1500 38h = 1500 38h = 1000 38h = 1000 38h = 1000 38h = 2000 38h = 3000 38h = 3000 38h = 3000					
Eh = 350 Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 526 17h = 575 18h = 600 13h = 625 18h = 670 18h = 670 18h = 670 18h = 775 18h = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1250 28h = 1350 28h = 1450 28h = 1500 38h = 1800 33h = 1900 33h = 1900 33h = 2000 33h = 32000					
Fh = 375 10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 14h = 660 18h = 676 10h = 700 10h = 725 1Eh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1150 26h = 1100 27h = 1150 28h = 1350 28h = 1350 26h = 1300 28h = 1350 26h = 1400 27h = 1450 27h = 1550 37h = 1550 37h = 1550 37h = 1500 37h = 1500 37h = 2000 37h = 3000 37h = 2000 37h = 3000 37h = 34000					
10h = 400 11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 650 18h = 675 1ch = 700 1dh = 725 1eh = 750 1eh = 750 1eh = 750 2eh = 800 2th = 850 2zh = 900 2dh = 900 2dh = 900 2dh = 1000 2fh = 1150 2gh = 1250 2gh = 1200 2gh = 1250 2gh = 1350 2gh = 1350 2gh = 1400 2gh = 1450 2gh = 1550 3gh = 1600 3gh = 1550 3gh = 1600 3gh = 1700 3gh = 1800 3gh = 1900 3gh = 2200 3gh = 2300 3gh = 2300 3gh = 2300					
11h = 425 12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 14h = 660 19h = 625 14h = 680 18h = 675 10h = 775 10h = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1100 27h = 1150 28h = 1250 28h = 1250 28h = 1350 29h = 1350 20h = 1450 21h = 1550 30h = 1600 31h = 1700 32h = 1850 32h = 1200 33h = 2000 33h = 2000 33h = 2000 33h = 2000 33h = 3000 33h = 3400					
12h = 450 13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 660 18h = 675 1Ch = 700 10h = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 800 21h = 850 22h = 800 24h = 1000 25h = 1150 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1450 2Ch = 1400 3Ch = 1600 3Th = 1700 3Ch = 1800 3Ch = 1900 3Ch = 2200 3Ch = 2200 3Ch = 2200 3Ch = 3200 3Ch = 32000					
13h = 475 14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 650 18h = 675 1Ch = 700 10h = 725 1Eh = 780 1Fh = 775 20h = 800 21h = 880 22h = 990 23h = 950 24h = 1000 25h = 1150 26h = 1100 27h = 1150 28h = 1250 2Ah = 1300 28h = 1350 2Ch = 1450 2Ch = 1450 2Ch = 1450 2Ch = 1450 2Ch = 1550 3Ch = 1500 3Ch = 1450 3Ch = 1500					
14h = 500 15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 650 18h = 675 1Ch = 700 1Dh = 725 1Eh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 2Dh = 1450 2Ch = 1500 2Fh = 1550 3Dh = 1600 3Th = 1700 3Ch = 3200 3Sh = 2200 3Th = 2300 3Sh = 2400 3Sh = 2300 3Sh = 2300 3Sh = 2300 3Sh = 3300 3Ch = 3300					
15h = 525 16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 660 18h = 675 1Ch = 700 1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 880 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 20h = 1450 2Ch = 1400 20h = 1450 2Ch = 1400 20h = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2200 37h = 2300 38h = 2800 38h = 3000 36h = 3000					
16h = 550 17h = 575 18h = 600 19h = 625 1Ah = 660 18h = 675 1Ch = 700 1Dh = 725 1Eh = 780 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1150 26h = 1100 27h = 1150 28h = 1200 29h = 1250 24h = 1300 28h = 1300 28h = 1550 2Ch = 1450 2Ch					
18h = 600 19h = 625 1Ah = 650 18h = 675 1Ch = 700 1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1200 29h = 1250 20h = 1330 2Ch = 1400 2Dh = 1450 2Ch = 1400 2Dh = 1450 2Ch = 1400 2Dh = 1450 2Ch = 1500 3Ch = 1500					16h = 550
19h = 625 1Ah = 650 1Bh = 675 1Ch = 700 1Dh = 725 1Eh = 750 1Eh = 775 20h = 800 21h = 800 21h = 800 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1250 28h = 1250 28h = 1250 28h = 1360 26h = 1360 26h = 1360 27h = 1150 28h = 1500 28h = 1500 28h = 1500 28h = 1500 28h = 1700 38h = 1800 38h = 1900 38h = 2100 38h = 2100 38h = 2200 37h = 2300 38h = 2400 38h = 2600 38h = 3000 36h = 3200 30h = 3400					
1 Ah = 650 1 Bh = 675 1 Ch = 700 1 Dh = 725 1 Eh = 750 1 Fh = 775 2 Dh = 800 2 11 = 850 2 2h = 900 2 3h = 950 2 4h = 1000 2 5h = 1050 2 6h = 1100 2 7h = 1150 2 8h = 1200 2 9h = 1250 2 Ah = 1300 2 8h = 1350 2 Ch = 1400 2 Dh = 1450 2 Ch = 1400 2 Dh = 1450 3 Dh = 1600 3 Th = 1700 3 Sh = 1800 3 Sh = 200 3 Sh = 2200 3 Th = 2300 3 Sh = 2400 3 Sh = 2800 3 Sh = 2800 3 Sh = 2800 3 Sh = 3000 3 Sh = 2800 3 Sh = 3000 3 Sh = 3400					
1Bh = 675 1Ch = 700 1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1550 3Ch = 1500 2Fh = 1550 3Ch = 1600 3Th = 1700 3Th = 1200 3Th = 2200 3Th = 2300 3Th = 2300 3Th = 2800 3Th = 2800 3Th = 3400					
1Ch = 700 1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 24h = 1300 26h = 1300 26h = 1350 27h = 1450 28h = 1550 28h = 1550 29h = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2800 38h = 2400 39h = 2800 38h = 2400 39h = 2800 38h = 2800 38h = 2800 38h = 2800 38h = 3000 36h = 3000					
1Dh = 725 1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 11100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1380 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 38h = 2400 38h = 2800 38h = 2800 38h = 2800 38h = 3000 3Ch = 3300					
1Eh = 750 1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Ch = 3800 3Ch = 3200					
1Fh = 775 20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 20h = 1450 20h = 1450 20h = 1450 20h = 1450 20h = 1500 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 38h = 2800 38h = 3000 3Ch = 3800 3Ch = 3200 3Ch = 3400 3Ch = 3200					
20h = 800 21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2800 38h = 3800 3Ch = 3800 3Ch = 3200 3Ch = 3400					
21h = 850 22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 38h = 3000 3Ch = 3200 3Dh = 3400					
22h = 900 23h = 950 24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200					
24h = 1000 25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2800 38h = 3000 3Ch = 3200					22h = 900
25h = 1050 26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 28h = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 38h = 2800 38h = 2800 38h = 2800 38h = 2800 38h = 3000 3Ch = 3200					
26h = 1100 27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Ah = 3200 3Ch = 3200 3Ch = 3200 3Dh = 3400					
27h = 1150 28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 33h = 2000 35h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Ch = 3200					
28h = 1200 29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Ch = 3200					
29h = 1250 2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					2/n = 1150
2Ah = 1300 2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Ch = 3200 3Ch = 3200 3Dh = 3400					
2Bh = 1350 2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
2Ch = 1400 2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
2Dh = 1450 2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 39h = 2600 39h = 2800 39h = 3000 3Ch = 3200 3Dh = 3400					
2Eh = 1500 2Fh = 1550 30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					2Dh = 1450
30h = 1600 31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					2Eh = 1500
31h = 1700 32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
32h = 1800 33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
33h = 1900 34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
34h = 2000 35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
35h = 2100 36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
36h = 2200 37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
37h = 2300 38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
38h = 2400 39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
39h = 2600 3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
3Ah = 2800 3Bh = 3000 3Ch = 3200 3Dh = 3400					
3Bh = 3000 3Ch = 3200 3Dh = 3400					
3Ch = 3200 3Dh = 3400					
					3Ch = 3200
3Eh = 3600					
					3Eh = 3600





Bit	Field	Туре	Reset	Description
				3Fh = 3800



Bit	Field	Type	Reset	Description (continued)
10-5	BEMF_THRESHOLD1	R/W	0h	BEMF threshold for integration based commutation during rising
10-3	BEIVII _ ITTICEOTIOED I	1000	011	floating phase voltage
				Oh = 0
				1h = 25
				2h = 50
				3h = 75
				4h = 100
				5h = 125
				6h = 150
				7h = 175
				8h = 200
				9h = 225
				Ah = 250 Bh = 275
				Ch = 300
				Dh = 325
				Eh = 350
				Fh = 375
				10h = 400
				11h = 425
				12h = 450
				13h = 475
				14h = 500 15h = 525
				16h = 550
				17h = 575
				18h = 600
				19h = 625
				1Ah = 650
				1Bh = 675
				1Ch = 700
				1Dh = 725
				1Eh = 750 1Fh = 775
				20h = 800
				21h = 850
				22h = 900
				23h = 950
				24h = 1000
				25h = 1050
				26h = 1100
				27h = 1150
				28h = 1200 29h = 1250
				2911 - 1250 2Ah = 1300
				2Bh = 1350
				2Ch = 1400
				2Dh = 1450
				2Eh = 1500
				2Fh = 1550
				30h = 1600
				31h = 1700 32h = 1800
				33h = 1900
				34h = 2000
				35h = 2100
				36h = 2200
				37h = 2300
				38h = 2400
				39h = 2600
				3Ah = 2800
				3Bh = 3000
				3Ch = 3200 3Dh = 3400
				35h = 3400 3Eh = 3600
				JEII

100

Bit	Field	Туре	Reset	Description
				3Fh = 3800
4	INTEG_ZC_METHOD	R/W	0h	Commutation method select 0h = ZC based 1h = Integration based
3-1	DEGAUSS_MAX_WIN	R/W	Oh	Maximum degauss window 0h = 22.5° 1h = 10° 2h = 15° 3h = 18° 4h = 30° 5h = 37.5° 6h = 45° 7h = 60°
0	DYN_DEGAUSS_EN	R/W	0h	Dynamic degauss detection 0h = Disable 1h = Enable



7.7.1.7 CLOSED_LOOP4 Register (Offset = 8Ch) [Reset = 00000000h]

CLOSED_LOOP4 is shown in 图 7-62 and described in 表 7-18.

Return to the Summary Table.

Register to configure close loop settings4

图 7-62. CLOSED LOOP4 Register

		ببلخا	-UZ. OLOGEL	_LOOI + ixegi	3(6)		
31	30	29	28	27	26	25	24
PARITY				RESERVED			
R/W-0h				R/W-0h			
23	22	21	20	19	18	17	16
	RESE	RVED		WCOMP_BLAN K_EN	FAS	ST_DEC_DUTY_	WIN
	R/W	/-0h		R/W-0h		R/W-0h	
15	14	13	12	11	10	9	8
FAS	ST_DEC_DUTY_T	HR		DYN_BRK_CU	RR_LOW_LIM		DYNAMIC_BRK _CURR
	R/W-0h			R/W	/-0h		R/W-0h
7	6	5	4	3	2	1	0
FAST_DECEL_ EN		FAST_DECE	_CURR_LIM		F	FAST_BRK_DELT	Ā
R/W-0h		R/W	/-0h			R/W-0h	

表 7-18. CLOSED_LOOP4 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-20	RESERVED	R/W	0h	Reserved
19	WCOMP_BLANK_EN	R/W	0h Enable WCOMP blanking during fast deceleration 0h = Disable 1h = Enable	
18-16	FAST_DEC_DUTY_WIN	R/W	0h Fast deceleration duty window 0h = 0 % 1h = 2.5 % 2h = 5 % 3h = 7.5 % 4h = 10 % 5h = 15 % 6h = 20 % 7h = 25 %	
15-13	FAST_DEC_DUTY_THR	R/W	0h	Fast deceleration duty threshold 0h = 100 % 1h = 95 % 2h = 90 % 3h = 85 % 4h = 80 % 5h = 75 % 6h = 70% 7h = 65 %

2 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

D:4				er Field Descriptions (continued)
Bit	Field	Туре	Reset	Description
12-9	DYN_BRK_CURR_LOW_ LIM	R/W	Oh	Fast deceleration dynamic current limit lower threshold (Deceleration current lower threshold (A) = DYN_BRK_CURR_LOW_LIM / CSA_GAIN) 0h = Reserved 1h = 0.1V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V
8	DYNAMIC_BRK_CURR	R/W	0h	Enable dynamic decrease in current limit during fast deceleration 0h = Disable 1h = Enable
7	FAST_DECEL_EN	R/W	0h	Fast deceleration enable 0h = Disable 1h = Enable
6-3	FAST_DECEL_CURR_LI	R/W	Oh	Deceleration current threshold (Fast Deceleration current limit upper threshold (A) = FAST_DECEL_CURR_LIM / CSA_GAIN) 0h = Reserved 1h = 0.1V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V
2-0	FAST_BRK_DELTA	R/W	0h	Fast deceleration exit speed delta 0h = 0.5 % 1h = 1 % 2h = 1.5 % 3h = 2 % 4h = 2.5 % 5h = 3 % 6h = 4 % 7h = 5 %

7.7.1.8 CONST_SPEED Register (Offset = 8Eh) [Reset = 00000000h]

CONST_SPEED is shown in 图 7-63 and described in 表 7-19.

Return to the Summary Table.

Register to configure Constant speed mode settings

图 7-63. CONST SPEED Register

		İZI	7-63. CONST_	OI LLD Kegis	ote:		
31	30	29	28	27	26	25	24
PARITY	RESERVED			SPD_PO\	WER_KP		
R/W-0h	R/W-0h			R/W	/-0h		
23	22	21	20	19	18	17	16
	SPD_PO	WER_KP			SPD_PC	WER_KI	
	R/M	/-0h			R/V	V-0h	
15	14	13	12	11	10	9	8
			SPD_PC	WER_KI			
			R/V	/-0h			
7	6	5	4	3	2	1	0
SPD_POWER_V_MAX				PD_POWER_V_M	IN	CLOSED_L	OOP_MODE
	R/W-0h			R/W-0h		R/V	V-0h

表 7-19. CONST_SPEED Register Field Descriptions

Bit	Field	Туре	Reset	Description		
31	PARITY	R/W	0h	Parity bit		
30	RESERVED	R/W	0h	Reserved		
29-20	SPD_POWER_KP	R/W	0h	Speed/ Power loop Kp (Kp = SPD_LOOP_KP / 10000)		
19-8	SPD_POWER_KI	R/W	0h	Speed/ Power loop Ki (Ki = SPD_LOOP_KI / 1000000)		
7-5	SPD_POWER_V_MAX	R/W	Oh	Upper saturation limit for speed/ power loop 0h = 100 % 1h = 95 % 2h = 90 % 3h = 85 % 4h = 80 % 5h = 75 % 6h = 70% 7h = 65 %		
4-2	SPD_POWER_V_MIN	R/W	Oh	Lower saturation limit for speed/power loop 0h = 0 % 1h = 2.5 % 2h = 5 % 3h = 7.5 % 4h = 10 % 5h = 15 % 6h = 20 % 7h = 25 %		
1-0	CLOSED_LOOP_MODE	R/W	0h	Closed loop mode 0h = Disabled 1h = Speed Loop 2h = Power Loop 3h = Reserved		

Submit Document Feedback 104

Copyright © 2023 Texas Instruments Incorporated

7.7.1.9 CONST_PWR Register (Offset = 90h) [Reset = 00000000h]

CONST_PWR is shown in 图 7-64 and described in 表 7-20.

Return to the Summary Table.

Register to configure Constant power mode settings

图 7-64. CONST PWR Register

		انجا	7-04. 00110	i _r wix ixegisi	loi				
31	30	29	28	27	26	25	24		
PARITY				MAX_SPEED					
R/W-0h				R/W-0h					
23	22	21	20	19	18	17	16		
			MAX_	SPEED					
	R/W-0h								
15	14	13	12	11	10	9	8		
MAX_SPEED	DEADTIME_CO MP_EN			MAX_F	POWER				
R/W-0h	R/W-0h			R/W	V-0h				
7	6	5	4	3	2	1	0		
	MAX_P	OWER		CONST_POWE	R_LIMIT_HYST	CONST_PC	WER_MODE		
	R/W	-0h		R/W	V-0h	R/V	V-0h		

表 7-20. CONST_PWR Register Field Descriptions

* 1 201 001101_1 Tric Regional Florid Booon phone						
Bit	Field	Туре	Reset	Description		
31	PARITY	R/W	0h	Parity bit		
30-15	MAX_SPEED	R/W	0h	Maximum Speed (Maximum Speed (Hz) = MAX_SPEED / 16)		
14	DEADTIME_COMP_EN	R/W	0h	Enable dead time compensation 0h = Disable 1h = Enable		
13-4	MAX_POWER	R/W	0h	Maximum power (Maximum power (W) = MAX_POWER / 4)		
3-2	CONST_POWER_LIMIT_ HYST	R/W	0h	Hysteresis for input power regulation 0h = 5 % 1h = 7.5 % 2h = 10 % 3h = 12.5 %		
1-0	CONST_POWER_MODE	R/W	Oh	Input power regulation mode 0h = Disabled 1h = Closed Loop Power Control 2h = Power Limit Control 3h = Reserved		

7.7.1.10 150_DEG_TWO_PH_PROFILE Register (Offset = 96h) [Reset = 00000000h]

150_DEG_TWO_PH_PROFILE is shown in 图 7-65 and described in 表 7-21.

Return to the Summary Table.

Register to configure 150 degree modulation TWO phase duty

图 7-65. 150 DEG TWO PH PROFILE Register

		国 1-05. IS	0_DEG_1 W O		L itegistei		
31	30	29	28	27	26	25	24
PARITY	TWOPH_STEP0			TWOPH_STEP1			TWOPH_STEP 2
R/W-0h	R/W-0h			R/W-0h			R/W-0h
23	22	21	20	19	18	17	16
TWOPH	_STEP2		TWOPH_STEP3			TWOPH_STEP4	
R/M	/-0h		R/W-0h			R/W-0h	
15	14	13	12	11	10	9	8
	TWOPH_STEP5			TWOPH_STEP6		TWOPH	I_STEP7
	R/W-0h			R/W-0h		R/V	V-0h
7	6	5	4	3	2	1	0
TWOPH_STEP 7				RESERVED			
R/W-0h		·		R/W-0h		·	

表 7-21. 150_DEG_TWO_PH_PROFILE Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-28	TWOPH_STEP0	R/W	Oh	150° modulation , Two ph - step duty - 0 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
27-25	TWOPH_STEP1	R/W	Oh	150° modulation , Two ph - step duty - 1 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
24-22	TWOPH_STEP2	R/W	Oh	150° modulation, Two ph - step duty - 2 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %

106 Submit Document Feedback Copyright © 2023 Texas Instruments Incorporated

表 7-21. 150 DEG TWO PH PROFILE Register Field Descriptions (continued)

表 7-21. 150_DEG_TWO_PH_PROFILE Register Field Descriptions (continued)								
Bit	Field	Туре	Reset	Description				
21-19	TWOPH_STEP3	R/W	Oh	150° modulation, Two ph - step duty - 3 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %				
18-16	TWOPH_STEP4	R/W	Oh	150° modulation, Two ph - step duty - 4 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %				
15-13	TWOPH_STEP5	R/W	Oh	150° modulation, Two ph - step duty - 5 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %				
12-10	TWOPH_STEP6	R/W	Oh	150° modulation, Two ph - step duty - 6 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %				
9-7	TWOPH_STEP7	R/W	Oh	150° modulation, Two ph - step duty - 7 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %				
6-0	RESERVED	R/W	0h	reserved bits for algo parameter update				



7.7.1.11 150_DEG_THREE_PH_PROFILE Register (Offset = 98h) [Reset = 00000000h]

150_DEG_THREE_PH_PROFILE is shown in 图 7-66 and described in 表 7-22.

Return to the Summary Table.

Register to configure 150 degree modulation Three phase duty

图 7-66. 150 DEG THREE PH PROFILE Register

		国 7 00. 100			LL Itegister			
31	30	29	28	27	26	25	24	
PARITY	٦	THREEPH_STEP	0	THREEPH_STEP1			THREEPH_ST EP2	
R/W-0h		R/W-0h		R/W-0h			R/W-0h	
23	22	21	20	19	18	17	16	
THREEPH_STEP2 1			THREEPH_STEP3			THREEPH_STEP4		
R/W-0h			R/W-0h R/W-0h					
15	14	13	12	11	10	9	8	
Т	THREEPH_STEP5			THREEPH_STEP6			THREEPH_STEP7	
R/W-0h			R/W-0h			R/V	R/W-0h	
7	6	5	4	3	2	1	0	
THREEPH_ST EP7	LEAD_ANGLE_150DEG_ADV		RESERVED					
R/W-0h	n R/W-0h		R/W-0h					

表 7-22. 150_DEG_THREE_PH_PROFILE Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-28	THREEPH_STEP0	R/W	Oh	150° modulation, Three ph - step duty - 0 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
27-25	THREEPH_STEP1	R/W	Oh	150° modulation, Three ph - step duty - 1 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
24-22	THREEPH_STEP2	R/W	Oh	150° modulation, Three ph - step duty - 2 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %

108 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

表 7-22. 150_DEG_THREE_PH_PROFILE Register Field Descriptions (continued)

	· 水 1-22. 150_DEG_	5_I HREE_PH_PROFILE Register Field Descriptions (continued)		
Bit	Field	Туре	Reset	Description
21-19	THREEPH_STEP3	R/W	Oh	150° modulation, Three ph - step duty - 3 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
18-16	THREEPH_STEP4	R/W	Oh	150° modulation, Three ph - step duty - 4 0h = 0.0 % 1h = 0.5 % 2h = 0.75 % 3h = 0.8375 % 4h = 0.875 % 5h = 0.9375 % 6h = 0.975 % 7h = 0.99 %
15-13	THREEPH_STEP5	R/W	0h	150° modulation, Three ph - step duty - 5 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
12-10	THREEPH_STEP6	R/W	Oh	150° modulation, Three ph - step duty - 6 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
9-7	THREEPH_STEP7	R/W	Oh	150° modulation, Three ph - step duty - 7 0h = 0% 1h = 50 % 2h = 75 % 3h = 83.75 % 4h = 87.5 % 5h = 93.75 % 6h = 97.5 % 7h = 99 %
6-5	LEAD_ANGLE_150DEG_ ADV	R/W	0h	Angle advance for 150° modulation 0h = 0° 1h = 5° 2h = 10° 3h = 15°
4-0	RESERVED	R/W	0h	Reserved

7.7.1.12 TRAP_CONFIG1 Register (Offset = 9Ah) [Reset = 00000000h]

TRAP_CONFIG1 is shown in 图 7-67 and described in 表 7-23.

Return to the Summary Table.

Register to configure internal Algorithm Variables

图 7-67. TRAP CONFIG1 Register

		باتحا	1-01. IIIAI _O	Oiti io i itogi	J. U.			
31	30	29	28	27	26	25	24	
PARITY	RESE	RVED		RESERVED		RESE	ERVED	
R/W-0h	R/M	/-0h		R/W-0h		R/V	R/W-0h	
23	22	21	20	19	18	17	16	
OL_HANDO	F_CYCLES		RESERVED		AVS	S_NEG_CURR_L	IMIT	
R/W	/-0h		R/W-0h	R/W-0h R/W-0h				
15	14	13	12	11	10	9	8	
AVS_LIMIT_HY ST			ISD_BEMF_THR			ISD_CY	CLE_THR	
R/W-0h			R/W-0h			R/V	V-0h	
7	6	5	4	3	2	1	0	
ISD_CYCLE_T HR	RESERVED	RESE	RVED	ZC_ANGLE	E_OL_THR	FAST_STARTU	IP_DIV_FACTOR	
R/W-0h	R/W-0h	R/V	V-0h	R/W	/-0h	R/V	V-0h	

表 7-23. TRAP_CONFIG1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-29	RESERVED	R/W	0h	Reserved
28-26	RESERVED	R/W	0h	Reserved
25-24	RESERVED	R/W	0h	Reserved
23-22	OL_HANDOFF_CYCLES	R/W	0h	
21-19	RESERVED	R/W	0h	Reserved
18-16	AVS_NEG_CURR_LIMIT	R/W	Oh	AVS negative current limit (AVS negative current limit (A) = (AVS_NEG_CURRENT_LIMIT * 3 /4095) / CSA_GAIN) 0h = 0 1h = -40 2h = -30 3h = -20 4h = -10 5h = 10 6h = 20 7h = 30
15	AVS_LIMIT_HYST	R/W	0h	AVS current hysteresis (AVS positive current limit (A) = ((AVS_LIMIT_HYST + AVS_NEG_CURR_LIMIT) * 3 /4095) / CSA_GAIN) 0h = 20 1h = 10

Submit Document Feedback 110

Copyright © 2023 Texas Instruments Incorporated

表 7-23. TRAP_CONFIG1 Register Field Descriptions (continued)

Bit	Field	Type	Reset	Descriptions (continued)
14-10	ISD_OVCLE_THR	R/W	Oh	ISD BEMF threshold (ISD BEMF threshold = 200 * ISD_BEMF_THR) 0h = 0 1h = 200 2h = 400 3h = 600 4h = 800 5h = 1000 6h = 1200 7h = 1400 8h = 1600 9h = 1800 Ah = 2000 Bh = 2200 Ch = 2400 Dh = 2600 Eh = 2800 Fh = 3000 10h = 3200 11h = 3400 12h = 3600 13h = 3800 14h = 4000 15h = 4200 16h = 4400 17h = 4600 18h = 4800 19h = 5000 1Ah = 5200 1Bh = 5000 1Ch = 5600 1Dh = 5800 1Eh = 6000 1Fh = 6200
9-7	ISD_CYCLE_THR	R/W	Oh	ISD cycle threshold 0h = 2, 1h = 5, 2h = 8, 3h = 11, 4h = 14, 5h = 17, 6h = 20, 7h = 23
6	RESERVED	R/W	0h	Reserved
5-4	RESERVED	R/W	0h	Reserved
3-2	ZC_ANGLE_OL_THR	R/W	0h	Angle above which the ZC detection is done during OL $0h = 5^{\circ}$ $1h = 8^{\circ}$ $2h = 12^{\circ}$ $3h = 15^{\circ}$
1-0	FAST_STARTUP_DIV_FA CTOR	R/W	0h	Dynamic A1, A2 change rate 0h = 1 1h = 2 2h = 4 3h = 8



7.7.1.13 TRAP_CONFIG2 Register (Offset = 9Ch) [Reset = 00200000h]

TRAP_CONFIG2 is shown in 图 7-68 and described in 表 7-24.

Return to the Summary Table.

Register to configure internal Algorithm Variables

图 7-68. TRAP CONFIG2 Register

		الجا	-00. IIVAI _V	JOINT IGE Kegis	oto:		
31	30	29	28	27	26	25	24
PARITY		TBL	ANK			TPWDTH	
R/W-0h		R/W	/-0h		R/W-0h		
23	22	21	20	19	18	17	16
RESERVED	DGS_HIGH_IN D_EN	RESERVED		ALIGN_DUTY		ZERO_D	UTY_HYST
R/W-0h	R/W-0h	R/W-1h	R/W-0h R/V			N-0h	
15	14	13	12	11	10	9	8
			RES	ERVED			
			R/	W-0h			
7	6	5	4	3	2	1	0
			RES	ERVED			
			R/	W-0h			

表 7-24. TRAP_CONFIG2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-27	TBLANK	R/W	Oh	Blanking time after PWM edge $0h = 0 \mu s$ $1h = 1 \mu s$ $2h = 2 \mu s$ $3h = 3 \mu s$ $4h = 4 \mu s$ $5h = 5 \mu s$ $6h = 6 \mu s$ $7h = 7 \mu s$ $8h = 8 \mu s$ $9h = 9 \mu s$ $Ah = 10 \mu s$ $Bh = 11 \mu s$ $Ch = 12 \mu s$ $Ch = 13 \mu s$ $Ch = 14 \mu s$ $Ch = 15 \mu s$
26-24	TPWDTH	R/W	Oh	Comparator deglitch time $0h = 0 \mu s$ $1h = 1 \mu s$ $2h = 2 \mu s$ $3h = 3 \mu s$ $4h = 4 \mu s$ $5h = 5 \mu s$ $6h = 6 \mu s$ $7h = 7 \mu s$
23	RESERVED	R/W	0h	Reserved
22	DGS_HIGH_IND_EN	R/W	Oh	Degauss Filter for High Inductance Enable 0h = Disable 1h = Enable
21	RESERVED	R/W	1h	Reserved

112 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

English Data Sheet: SLLSFP7

表 7-24. TRAP_CONFIG2 Register Field Descriptions (continued)

	T-24. ITAI _OON IOZ Register Field Descriptions (continued)						
Bit	Field	Туре	Reset	Description			
20-18	ALIGN_DUTY	R/W	Oh	Duty cycle limit during align 0h = 10 % 1h = 15 % 2h = 20 % 3h = 25 % 4h = 30 % 5h = 40 % 6h = 50 % 7h = 100 %			
17-16	ZERO_DUTY_HYST	R/W	0h	Duty cycle hysteresis to exit standby $0h = 0 \%$ $1h = 1 \%$ $2h = 2 \%$ $3h = 3 \%$			
15-0	RESERVED	R/W	0h	Reserved			

7.7.2 Fault_Configuration Registers

表 7-25 lists the memory-mapped registers for the Fault_Configuration registers. All register offset addresses not listed in 表 7-25 should be considered as reserved locations and the register contents should not be modified.

表 7-25. FAULT_CONFIGURATION Registers

Offset	Acronym	Register Name	Section
92h	FAULT_CONFIG1	Fault configuration 1	FAULT_CONFIG1 Register (Offset = 92h) [Reset = 00000000h]
94h	FAULT_CONFIG2	Fault configuration 2	FAULT_CONFIG2 Register (Offset = 94h) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-26 shows the codes that are used for access types in this section.

表 7-26. Fault_Configuration Access Type Codes

		<u> </u>				
Access Type	Code	Description				
Read Type						
R	R	Read				
Write Type						
W	W	Write				
Reset or Default	Reset or Default Value					
-n		Value after reset or the default value				

7.7.2.1 FAULT_CONFIG1 Register (Offset = 92h) [Reset = 00000000h]

FAULT_CONFIG1 is shown in 图 7-69 and described in 表 7-27.

Return to the Summary Table.

Register to configure fault settings1

图 7-69. FAULT CONFIG1 Register

		131	-03. I AULI_C	CINFIG I REGI	3161		
31	30	29	28	27	26	25	24
PARITY	RESERVED	N	O_MTR_DEG_TIM	ΜE	(CBC_ILIMIT_MOD	E
R/W-0h	R/W-0h		R/W-0h			R/W-0h	
23	22	21	20	19	18	17	16
CBC_ILIMIT_M ODE		LOCK	_ILIMIT		L	OCK_ILIMIT_MOD	DE
R/W-0h		R/V	V-0h		R/W-0h		
15	14	13	12	11	10	9	8
LOCK_ILIMIT_ MODE		LOCK_IL	MIT_DEG		СВ	C_RETRY_PWM_	CYC
R/W-0h		R/V	V-0h			R/W-0h	
7	6	5	4	3	2	1	0
RESERVED		MTR_LC	K_MODE			LCK_RETRY	
R/W-0h		R/V	V-0h			R/W-0h	

表 7-27. FAULT_CONFIG1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30	RESERVED	R/W	0h	Reserved
29-27	NO_MTR_DEG_TIME	R/W	Oh	No motor detect deglitch time 0h = 1 ms 1h = 10 ms 2h = 25 ms 3h = 50 ms 4h = 100 ms 5h = 250 ms 6h = 500 ms 7h = 1000 ms

Submit Document Feedback

表 7-27. FAULT CONFIG1 Register Field Descriptions (continued)

Bit	Field	Type	Reset	Description (Continued)
26-23	CBC_ILIMIT_MODE	R/W	Oh	Cycle by cycle current limit 0h = Automatic recovery next PWM cycle; nFAULT active; driver is in recirculation mode 1h = Automatic recovery next PWM cycle; nFAULT inactive; driver is in recirculation mode 2h = Automatic recovery if VSOX < CBC_ILIMIT; nFAULT active; driver is in recirculation mode (Only available with high-side modulation) 3h = Automatic recovery if VSOX < CBC_ILIMIT; nFAULT inactive; driver is in recirculation mode (Only available with high-side modulation) 4h = Automatic recovery after CBC_RETRY_PWM_CYC; nFAULT active; driver is in recirculation mode 5h = Automatic recovery after CBC_RETRY_PWM_CYC; nFAULT inactive; driver is in recirculation mode 6h = Automatic recovery after CBC_RETRY_PWM_CYC; nFAULT inactive; driver is in recirculation mode 6h = VSOX > CBC_ILIMIT is report only but no action is taken 7h = Cycle by Cycle limit is disabled 8h = Cycle by Cycle limit is disabled 9h = Cycle by Cycle limit is disabled Ah = Cycle by Cycle limit is disabled Ch = Cycle by Cycle limit is disabled Ch = Cycle by Cycle limit is disabled Ch = Cycle by Cycle limit is disabled Fh = Cycle by Cycle limit is disabled Ch = Cycle by Cycle limit is disabled
22-19	LOCK_ILIMIT	R/W	Oh	Lock detection current limit (Lock detection current limit (A) = LOCK_ILIMIT / CSA_GAIN) 0h = Reserved 1h = 0.1 V 2h = 0.2 V 3h = 0.3 V 4h = 0.4 V 5h = 0.5 V 6h = 0.6 V 7h = 0.7 V 8h = 0.8 V 9h = 0.9 V Ah = 1 V Bh = 1.1 V Ch = 1.2 V Dh = 1.3 V Eh = 1.4 V Fh = 1.5 V



表 7-27. FAULT_CONFIG1 Register Field Descriptions (continued)

Dit		_		er Field Descriptions (continued)
Bit	Field	Туре	Reset	Description
18-15	LOCK_ILIMIT_MODE	R/W	Oh	Lock detection current limit mode 0h = Ilimit lock detection causes latched fault; nFAULT active; Gate driver is tristated 1h = Ilimit lock detection causes latched fault; nFAULT active; Gate driver is in recirculation mode 2h = Ilimit lock detection causes latched fault; nFAULT active; Gate driver is in high-side brake mode (All high-side FETs are turned ON) 3h = Ilimit lock detection causes latched fault; nFAULT active; Gate driver is in low-side brake mode (All low-side FETs are turned ON) 4h = Automatic recovery after tLCK_RETRY; Gate driver is tristated 5h = Automatic recovery after tLCK_RETRY; Gate driver is in recirculation mode 6h = Automatic recovery after tLCK_RETRY; Gate driver is in high- side brake mode (All high-side FETs are turned ON) 7h = Automatic recovery after tLCK_RETRY; Gate driver is in low- side brake mode (All low-side FETs are turned ON) 8h = Ilimit lock detection is in report only but no action is taken 9h = Ilimit lock detection is disabled Ah = Ilimit lock detection is disabled Ch = Ilimit lock detection is disabled
14-11	LOCK_ILIMIT_DEG	R/W	Oh	Lock detection current limit deglitch time 0h = 1 ms 1h = 2 ms 2h = 5 ms 3h = 10 ms 4h = 25 ms 5h = 50 ms 6h = 75 ms 7h = 100 ms 8h = 250 ms 9h = 500 ms Ah = 1 s Bh = 2.5 s Ch = 5 s Dh = 10 s Eh = 25 s Fh = 50 s
10-8	CBC_RETRY_PWM_CYC	R/W	Oh	Number of PWM cycles for CBC current limit to retry 0h = 0 1h = 1 2h = 2 3h = 3 4h = 4 5h = 5 6h = 6 7h = 7
7	RESERVED	R/W	0h	Reserved

表 7-27. FAULT_CONFIG1 Register Field Descriptions (continued)

表 7-27. FAULI_CONFIG1 Register Field Descriptions (continued)							
Bit	Field	Type	Reset	Description			
6-3	MTR_LCK_MODE	R/W	0h	Motor lock mode Oh = Motor lock detection causes latched fault; nFAULT active; Gate driver is tristated 1h = Motor lock detection causes latched fault; nFAULT active; Gate driver is in recirculation mode 2h = Motor lock detection causes latched fault; nFAULT active; Gate driver is in high-side brake mode (All high-side FETs are turned ON) 3h = Motor lock detection causes latched fault; nFAULT active; Gate driver is in low-side brake mode (All low-side FETs are turned ON) 4h = Automatic recovery after tLCK_RETRY; Gate driver is tristated 5h = Automatic recovery after tLCK_RETRY; Gate driver is in recirculation mode 6h = Automatic recovery after tLCK_RETRY; Gate driver is in high-side brake mode (All high-side FETs are turned ON) 7h = Automatic recovery after tLCK_RETRY; Gate driver is in low-side brake mode (All low-side FETs are turned ON) 8h = Motor lock detection is in report only but no action is taken 9h = Motor lock detection is disabled Ch = Motor lock detection is disabled Ch = Motor lock detection is disabled Eh = Motor lock detection is disabled Fh = Motor lock detection is disabled Fh = Motor lock detection is disabled Fh = Motor lock detection is disabled			
2-0	LCK_RETRY	R/W	0h	Lock retry time 0h = 100 ms 1h = 500 ms 2h = 1000 ms 3h = 2000 ms 4h = 3000 ms 5h = 5000 ms 6h = 7500 ms 7h = 10000 ms			

7.7.2.2 FAULT_CONFIG2 Register (Offset = 94h) [Reset = 00000000h]

FAULT_CONFIG2 is shown in 图 7-70 and described in 表 7-28.

Return to the Summary Table.

Register to configure fault settings2

图 7-70. FAULT CONFIG2 Register

		рч -		oru rea ragio			
31	30	29	28	27	26	25	24
PARITY	LOCK1_EN	LOCK2_EN	LOCK3_EN		LOCK_A	BN_SPEED	
R/W-0h	R/W-0h	R/W-0h	R/W-0h		R/\	N-0h	
23	22	21	20	19	18	17	16
LOSS_SYNC_TIMES				NO_MTR_THR		MAX_VM_MOD E	MAX_VM_MOT OR
	R/W-0h			R/W-0h		R/W-0h	R/W-0h
15	14	13	12	11	10	9	8
MAX_VM	MAX_VM_MOTOR MIN_VM_MOD E		MIN_VM_MOTOR			AUTO_RETRY_TIMES	
R/W	/-0h	R/W-0h		R/W-0h		R/V	V-0h
7	6	5	4	3	2	1	0
AUTO_RETRY_ TIMES			O ABN_LOCK_SPD_RATIO		ZERO_DUTY_THR		
R/W-0h		R/W-0h		R/W-	0h	R/V	V-0h

表 7-28. FAULT_CONFIG2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30	LOCK1_EN	R/W	0h	Lock 1 (Abnormal Speed) Enable 0h = Disable 1h = Enable
29	LOCK2_EN	R/W	0h Lock 2 (Loss of Sync) Enable 0h = Disable 1h = Enable	
28	LOCK3_EN	R/W	0h	Lock 3 (No Motor) Enable 0h = Disable 1h = Enable
27-24	LOCK_ABN_SPEED	R/W	Oh	Abnormal speed lock threshold 0h = 250 Hz 1h = 500 Hz 2h = 750 Hz 3h = 1000 Hz 4h = 1250 Hz 5h = 1500 Hz 6h = 1750 Hz 7h = 2000 Hz 8h = 2250 Hz 9h = 2500 Hz Ah = 2750 Hz Bh = 3000 Hz Ch = 3250 Hz Dh = 3500 Hz Eh = 3750 Hz Fh = 4000 Hz

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

English Data Sheet: SLLSFP7

表 7-28. FAULT_CONFIG2 Register Field Descriptions (continued)

		FIG2 Register Field Descriptions (continued)			
Bit	Field	Туре	Reset	Description	
23-21	LOSS_SYNC_TIMES	R/W	Oh	Number of times sync lost for loss of sync lock fault 0h = Trigger after losing sync 2 times 1h = Trigger after losing sync 3 times 2h = Trigger after losing sync 4 times 3h = Trigger after losing sync 5 times 4h = Trigger after losing sync 6 times 5h = Trigger after losing sync 7 times 6h = Trigger after losing sync 8 times 7h = Trigger after losing sync 9 times	
20-18	NO_MTR_THR	R/W	Oh	No motor lock current threshold (No motor lock current threshold (A) = NO_MTR_THR / CSA_GAIN) 0h = 0.005 V 1h = 0.0075 V 2h = 0.010 V 3h = 0.0125 V 4h = 0.020 V 5h = 0.025 V 6h = 0.030 V 7h = 0.04 V	
17	MAX_VM_MODE	R/W	0h	0h = Latch on Overvoltage 1h = Automatic clear if voltage in bounds	
16-14	MAX_VM_MOTOR	R/W	Oh	Maximum voltage for running motor 0h = No Limit 1h = 20.0 V 2h = 25.0 V 3h = 30.0 V 4h = 35.0 V 5h = 40.0 V 6h = Unused 7h = Unused	
13	MIN_VM_MODE	R/W	0h	0h = Latch on Undervoltage 1h = Automatic clear if voltage in bounds	
12-10	MIN_VM_MOTOR	R/W	Oh	Minimum voltage for running motor 0h = No Limit 1h = 6.0 V 2h = 7.0 V 3h = 8.0 V 4h = 9.0 V 5h = 10.0 V 6h = 12.0 V 7h = 15.0 V	
9-7	AUTO_RETRY_TIMES	R/W	Oh	Number of automatic retry attempts 0h = No Limit 1h = 2 2h = 3 3h = 5 4h = 7 5h = 10 6h = 15 7h = 20	
6-4	LOCK_MIN_SPEED	R/W	Oh	Speed below which lock fault is triggered 0h = 0.5 Hz 1h = 1 Hz 2h = 2 Hz 3h = 3 Hz 4h = 5 Hz 5h = 10 Hz 6h = 15 Hz 7h = 25 Hz	



表 7-28. FAULT_CONFIG2 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
3-2	ABN_LOCK_SPD_RATIO	R/W	0h	Ratio of electrical speed between two consecutive cycles above which abnormal speed lock fault is triggered 0h = 2 1h = 4 2h = 6 3h = 8
1-0	ZERO_DUTY_THR	R/W	0h	Duty cycle below which target speed is zero 0h = 1% 1h = 1.5% 2h = 2.0% 3h = 2.5%

7.7.3 Hardware_Configuration Registers

 $\bar{\chi}$ 7-29 lists the memory-mapped registers for the Hardware_Configuration registers. All register offset addresses not listed in $\bar{\chi}$ 7-29 should be considered as reserved locations and the register contents should not be modified.

表 7-29. HARDWARE_CONFIGURATION Registers

Offset	Acronym	Register Name	Section
A4h	PIN_CONFIG1	Hardware pin configuration	PIN_CONFIG1 Register (Offset = A4h) [Reset = 00000000h]
A6h	PIN_CONFIG2	Hardware pin configuration	PIN_CONFIG2 Register (Offset = A6h) [Reset = 00000000h]
A8h	DEVICE_CONFIG	Device configuration	DEVICE_CONFIG Register (Offset = A8h) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-30 shows the codes that are used for access types in this section.

表 7-30. Hardware_Configuration Access Type Codes

30400						
Access Type	Code Description					
Read Type						
R	R	Read				
Write Type						
W	W	Write				
Reset or Default Value						
-n		Value after reset or the default value				

Product Folder Links: MCT8315A

Copyright © 2023 Texas Instruments Incorporated

7.7.3.1 PIN_CONFIG1 Register (Offset = A4h) [Reset = 00000000h]

PIN_CONFIG1 is shown in 图 7-71 and described in 表 7-31.

Return to the Summary Table.

Register to configure hardware pins

图 7-71. PIN CONFIG1 Register

		انجا	<i>1-1</i> 1. 1 11 1_ 00	iti io i itegisi	to:		
31	30	29	28	27	26	25	24
PARITY			DA	COUT1_VAR_AD	DR		
R/W-0h				R/W-0h			
23	22	21	20	19	18	17	16
	DACOUT1_VAR_ADDR DACOUT2_VAR_ADDR						DDR
	R/W-0h R/W-0h						
15	14	13	12	11	10	9	8
			DACOUT2_	VAR_ADDR			
			R/V	V-0h			
7	6	5	4	3	2	1	0
DACOUT2_VA R_ADDR	BRAKE_INPUT		DIR_INPUT		SPD_CTR	L_MODE	ALARM_PIN_E N
R/W-0h	R/M	/-0h	R/W-0h		R/W	'-0h	R/W-0h

表 7-31. PIN_CONFIG1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-19	DACOUT1_VAR_ADDR	R/W	0h	12-bit address of variable to be monitored
18-7	DACOUT2_VAR_ADDR	R/W	0h	12-bit address of variable to be monitored
6-5	BRAKE_INPUT	R/W	Oh	Brake input configuration 0h = Hardware Pin BRAKE 1h = Overwrite Hardware pin with Active Brake 2h = Overwrite Hardware pin with brake functionality disabled 3h = Reserved
4-3	DIR_INPUT	R/W	0h	Direction input configuration 0h = Hardware Pin DIR 1h = Overwrite Hardware pin with clockwise rotation OUTA-OUTB- OUTC 3h = Reserved
2-1	SPD_CTRL_MODE	R/W	0h	Speed input configuration 0h = Analog mode 1h = PWM mode 2h = 0x2 3h = Frequency mode
0	ALARM_PIN_EN	R/W	0h	Alarm Pin GPIO configuration 0h = Disabled (Hi-Z) 1h = Enabled

7.7.3.2 PIN_CONFIG2 Register (Offset = A6h) [Reset = 00000000h]

PIN_CONFIG2 is shown in 图 7-72 and described in 表 7-32.

Return to the Summary Table.

Register to configure hardware pins

图 7-72. PIN CONFIG2 Register

⊠ 1-12. FIN_CONFIG2 Register							
31	30	29	28	27	26	25	24
PARITY	DAC_SOX	_CONFIG	RESERVED	DAC_CONFIG		I2C_TARGET_ADE)R
R/W-0h	R/M	/-0h	R/W-0h	R/W-0h	R/W-0h		
23	22	21	20	19	18	17	16
I2C_TARGET_ADDR				SLEEP	_TIME	EXT_WD_EN	EXT_WD_INPU T
R/W-0h				R/W-0h		R/W-0h	R/W-0h
15	14	13	12	11	10	9	8
EXT_WD_FAUL T	EXT_WD_FAUL EXT_WD_FREQ T			ULT_CONFIG		RESERVED	
R/W-0h	R/M	/-0h	R/V	R/W-0h		R/W-0h	
7	6	5	4	3	2	1	0
RESERVED							
R/W-0h							

表 7-32. PIN_CONFIG2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-29	DAC_SOX_CONFIG	R/W	0h	Pin 36 configuration 0h = DACOUT2 1h = SOA 2h = SOB 3h = SOC
28	RESERVED	R/W	0h	Reserved
27	DAC_CONFIG	R/W	0h	Pin 37 and pin 38 configuration 0h = Reserved 1h = Pin 37 as DACOUT2 and pin 38 as DACOUT1
26-20	I2C_TARGET_ADDR	R/W	0h	I2C target address
19-18	SLEEP_TIME	R/W	0h	Sleep Time 0h = Check low for 50 µs 1h = Check low for 200 µs 2h = Check low for 20 ms 3h = Check low for 200 ms
17	EXT_WD_EN	R/W	0h	Enable external watchdog 0h = Disable 1h = Enable
16	EXT_WD_INPUT	R/W	0h	External watchdog source 0h = I2C 1h = GPIO
15	EXT_WD_FAULT	R/W	0h	External watchdog fault mode 0h = Report only 1h = Latched fault with Hi-Z outputs
14-13	EXT_WD_FREQ	R/W	0h	External watchdog frequency 0h = 10Hz 1h = 5Hz 2h = 2Hz 3h = 1Hz

表 7-32. PIN_CONFIG2 Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
12-11	FG_PIN_FAULT_CONFIG	R/W		Fault on FG Pin Configuration 0h = FG continues to toggle till motor stops 1h = FG in Hi-Z state, pulled up externally 2h = FG pulled Low 3h = Reserved
10-0	RESERVED	R/W	0h	Reserved

English Data Sheet: SLLSFP7

7.7.3.3 DEVICE_CONFIG Register (Offset = A8h) [Reset = 00000000h]

DEVICE_CONFIG is shown in 图 7-73 and described in 表 7-33.

Return to the Summary Table.

Register to configure device

图 7-73. DEVICE CONFIG Register

E 1-13. DE VICE_CONTIO Register								
31	30	29	28	27	26	25	24	
PARITY			INP	UT_MAX_FREQU	ENCY			
R/W-0h		R/W-0h						
23	22	21	20	19	18	17	16	
			INPUT_MAX	FREQUENCY				
R/W-0h								
15	14	13	12	11	10	9	8	
RESERVED	SSM_CONFIG	RESE	RVED	DEV_MODE	SPD_PWM_RA NGE_SELECT	CLK	_SEL	
R/W-0h	R/W-0h	R/V	V-0h	R/W-0h	R/W-0h	RΛ	V-0h	
7	6	5	5 4		2	1	0	
RESERVED	EXT_CLK_EN	E	XT_CLK_CONF	īG	RESERVED			
R/W-0h	R/W-0h		R/W-0h			R/W-0h		

表 7-33. DEVICE_CONFIG Register Field Descriptions

	₹ 1-33. DEVICE_CONTIG Register Field Descriptions							
Bit	Field	Туре	Reset	Description				
31	PARITY	R/W	0h	Parity bit				
30-16	INPUT_MAX_FREQUENC Y	R/W	0h	Maximum frequency (in Hz) for frequency based speed input				
15	RESERVED	R/W	0h	Reserved				
14	SSM_CONFIG	R/W	0h	SSM enable 0h = Enable 1h = Disable				
13-12	RESERVED	R/W	0h	Reserved				
11	DEV_MODE	R/W	Oh	Device mode select 0h = Standby mode 1h = Sleep mode				
10	SPD_PWM_RANGE_SEL ECT	R/W	0h	PWM frequency range select 0h = 325 Hz to 100 kHz speed PWM input 1h = 10 Hz to 325 Hz speed PWM input				
9-8	CLK_SEL	R/W	0h	Clock source 0h = Internal Oscillator 1h = Reserved 2h = Reserved 3h = External Clock input				
7	RESERVED	R/W	0h	Reserved				
6	EXT_CLK_EN	R/W	0h	External clock enable 0h = Disable 1h = Enable				

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

表 7-33. DEVICE_CONFIG Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
5-3	EXT_CLK_CONFIG	R/W	Oh	External clock frequency 0h = 8 kHz 1h = 16 kHz 2h = 32 kHz 3h = 64 kHz 4h = 128 kHz 5h = 256 kHz 6h = 512 kHz 7h = 1024 kHz
2-0	RESERVED	R/W	0h	Reserved

7.7.4 Gate_Driver_Configuration Registers

 $\bar{\chi}$ 7-34 lists the memory-mapped registers for the Gate_Driver_Configuration registers. All register offset addresses not listed in $\bar{\chi}$ 7-34 should be considered as reserved locations and the register contents should not be modified.

表 7-34. GATE_DRIVER_CONFIGURATION Registers

011		B 1 / N	• •
Offset	Acronym	Register Name	Section
ACh	GD_CONFIG1	Gate driver configuration 1	GD_CONFIG1 Register (Offset = ACh) [Reset = 00228000h]
AEh	GD_CONFIG2	Gate driver configuration 2	GD_CONFIG2 Register (Offset = AEh) [Reset = 01200000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-35 shows the codes that are used for access types in this section.

表 7-35. Gate_Driver_Configuration Access Type Codes

Access Type Code		Description					
Read Type							
R	R	Read					
Write Type	Write Type						
W	W	Write					
Reset or Defaul	Reset or Default Value						
-n		Value after reset or the default value					

English Data Sheet: SLLSFP7

7.7.4.1 GD_CONFIG1 Register (Offset = ACh) [Reset = 00228000h]

GD_CONFIG1 is shown in 图 7-74 and described in 表 7-36.

Return to the Summary Table.

Register to configure gated driver settings1

图 7-74. GD CONFIG1 Register

д · · · · ob_oo.							
31	30	29	28	27	26	25	24
PARITY	RESE	RVED	RESERVED	SLEW_RATE		RESERVED	
R/W-0h	R/V	V-0h	R/W-0h	R/W-0h		R/W-0h	
23	22	21	20	19	18	17	16
CLR_FLT	RESERVED	RESERVED	RESERVED	OVP_SEL	OVP_EN	RESERVED	OTW_REP
R/W-0h	R/W-0h	R/W-1h	R/W-0h	R/W-0h	R/W-0h	R/W-1h	R/W-0h
15	14	13	12	11	10	9	8
RESERVED	RESERVED	OCP	_DEG	OCP_RETRY	OCP_LVL	OCP_MODE	
R/W-1h	R/W-0h	R/V	V-0h	R/W-0h	R/W-0h	R/W	/-0h
7	6	5	4	3	2	1	0
BEMF_THR	RESERVED	ADCOMP_TH_ LS	ADCOMP_TH_ HS	EN_ASR	EN_AAR	CSA_	GAIN
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W	/-0h

表 7-36. GD_CONFIG1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30-29	RESERVED	R/W	0h	Reserved
28	RESERVED	R/W	0h	Reserved
27-26	SLEW_RATE	R/W	0h	Slew rate 0h = 25 V/µs 1h = 50 V/µs 2h = 125 V/µs 3h = 200 V/µs
25-24	RESERVED	R/W	0h	Reserved
23	CLR_FLT	R/W	Oh	Clear fault 0h = No clear fault command is issued 1h = To clear the latched fault bits. This bit automatically resets after being written.
22	RESERVED	R/W	0h	Reserved
21	RESERVED	R/W	1h	Reserved
20	RESERVED	R/W	0h	Reserved
19	OVP_SEL	R/W	0h	Overvoltage protection level 0h = VM overvoltage level is 34-V 1h = VM overvoltage level is 22-V
18	OVP_EN	R/W	0h	Overvoltage protection enable 0h = Disable 1h = Enable
17	RESERVED	R/W	1h	Reserved
16	OTW_REP	R/W	0h	Overtemperature warning reporting on nFAULT 0h = Over temperature reporting on nFAULT is disabled 1h = Over temperature reporting on nFAULT is enabled
15	RESERVED	R/W	1h	Reserved
14	RESERVED	R/W	0h	Reserved

126 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

表 7-36. GD_CONFIG1 Register Field Descriptions (continued)

				r Field Descriptions (continued)	
Bit	Field	Туре	Reset	Description	
13-12	OCP_DEG	R/W	0h	OCP deglitch time $0h = 0.2 \mu s$ $1h = 0.6 \mu s$ $2h = 1.2 \mu s$ $3h = 1.6 \mu s$	
11	OCP_RETRY	R/W	Oh	OCP retry time 0h = 5 ms 1h = 500 ms	
10	OCP_LVL	R/W	0h	OCP level 0h = 9 A (Typical) 1h = 13 A (Typical)	
9-8	OCP_MODE	R/W	0h	OCP fault mode 0h = Overcurrent causes a latched fault 1h = Overcurrent causes an automatic retrying fault 2h = Overcurrent is report only but no action is taken 3h = Overcurrent is not reported and no action is taken	
7	BEMF_THR	R/W	0h	BEMF comparator threshold 0h = BEMF comparator threshold is 20 mV 1h = BEMF comparator threshold is 100 mV	
6	RESERVED	R/W	0h	Reserved	
5	ADCOMP_TH_LS	R/W	0h	Active demag comparator threshold for low-side 0h = 100 mA 1h = 150 mA	
4	ADCOMP_TH_HS	R/W	0h	Active demag comparator threshold for high-side 0h = 100 mA 1h = 150 mA	
3	EN_ASR	R/W	Oh	Active synchronous rectification enable 0h = Disable 1h = Enable	
2	EN_AAR	R/W	Oh	Active asynchronous rectification enable 0h = Disable 1h = Enable	
1-0	CSA_GAIN	R/W	Oh	Current Sense Amplifier (CSA) Gain 0h = 0.24 V/A 1h = 0.48 V/A 2h = 0.96 V/A 3h = 1.92 V/A	

7.7.4.2 GD_CONFIG2 Register (Offset = AEh) [Reset = 01200000h]

GD_CONFIG2 is shown in 图 7-75 and described in 表 7-37.

Return to the Summary Table.

Register to configure gated driver settings2

图 7-75. GD CONFIG2 Register

图 7-73. GD_CONTIGE Register									
31	30	29	28	27	26	25	24		
PARITY	DELAY_COMP _EN		TARGET	_DELAY		RESERVED	BUCK_PS_DIS		
R/W-0h	R/W-0h		R/W	/-0h		R/W-0h	R/W-1h		
23	22	21	20	19	18	17	16		
BUCK_CL	BUCK	_SEL	RESERVED		RESE	RVED			
R/W-0h	R/W	'-1h	R/W-0h	R/W-0h			W-0h		
15	14	13	12	11	10	9	8		
			RESE	RVED					
			R/W	<i>l</i> -0h					
7	6	5	4	3	2	1	0		
	RESERVED								
	R/W-0h								

表 7-37. GD_CONFIG2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	PARITY	R/W	0h	Parity bit
30	DELAY_COMP_EN	R/W	0h	Driver delay compensation enable 0h = Disable 1h = Enable
29-26	TARGET_DELAY	R/W	Oh	Target delay $0h = Automatic based on slew rate$ $1h = 0.4 \mu s$ $2h = 0.6 \mu s$ $3h = 0.8 \mu s$ $4h = 1 \mu s$ $5h = 1.2 \mu s$ $6h = 1.4 \mu s$ $7h = 1.6 \mu s$ $8h = 1.8 \mu s$ $9h = 2 \mu s$ $Ah = 2.2 \mu s$ $Bh = 2.4 \mu s$ $Ch = 2.6 \mu s$ $Dh = 2.8 \mu s$ $Eh = 3 \mu s$ $Eh = 3.2 \mu s$
25	RESERVED	R/W	0h	Reserved
24	BUCK_PS_DIS	R/W	1h	Buck power sequencing disable 0h = Buck power sequencing is enabled 1h = Buck power sequencing is disabled
23	BUCK_CL	R/W	Oh	Buck current limit 0h = 600 mA 1h = 150 mA

128 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

English Data Sheet: SLLSFP7

表 7-37. GD_CONFIG2 Register Field Descriptions (continued)

	, , , , , , , , , , , , , , , , , , ,								
Bit	Field	Туре	Reset	Description					
22-21	BUCK_SEL	R/W	1h	Buck voltage selection 0h = Buck voltage is 3.3 V 1h = Buck voltage is 5.0 V 2h = Buck voltage is 4.0 V 3h = Buck voltage is 5.7 V					
20	RESERVED	R/W	0h	Reserved					
19-0	RESERVED	R/W	0h	Reserved					

7.8 RAM (Volatile) Register Map

7.8.1 Fault_Status Registers

 \pm 7-38 lists the memory-mapped registers for the Fault_Status registers. All register offset addresses not listed in \pm 7-38 should be considered as reserved locations and the register contents should not be modified.

表 7-38. FAULT_STATUS Registers

Offset	Acronym	Register Name	Section
E0h	GATE_DRIVER_FAULT_STATUS	Fault Status Register	GATE_DRIVER_FAULT_STATUS Register (Offset = E0h) [Reset = 000000000h]
E2h	CONTROLLER_FAULT_STATUS	Fault Status Register	CONTROLLER_FAULT_STATUS Register (Offset = E2h) [Reset = 000000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-39 shows the codes that are used for access types in this section.

表 7-39. Fault_Status Access Type Codes

	_	y 1
Access Type	Code	Description
Read Type		
R	R	Read
Reset or Default		
-n		Value after reset or the default value

Product Folder Links: MCT8315A

Copyright © 2023 Texas Instruments Incorporated

7.8.1.1 GATE_DRIVER_FAULT_STATUS Register (Offset = E0h) [Reset = 00000000h]

GATE_DRIVER_FAULT_STATUS is shown in 图 7-76 and described in 表 7-40.

Return to the Summary Table.

Status of various faults

图 7-76. GATE_DRIVER_FAULT_STATUS Register

31	30	29	28	27	26	25	24
DRIVER_FAUL T	BK_FLT	RESERVED	OCP	NPOR	OVP	ОТ	RESERVED
R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h
23	22	21	20	19	18	17	16
OTW	TSD	OCP_HC	OCP_LC	OCP_HB	OCP_LB	OCP_HA	OCP_LA
R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h
15	14	13	12	11	10	9	8
RESERVED	OTP_ERR	BUCK_OCP	BUCK_UV	VCP_UV		RESERVED	
R-0h	R-0h	R-0h	R-0h	R-0h		R-0h	
7	6	5	4	3	2	1	0
			RESE	RVED			
	R-0h						

表 7-40. GATE_DRIVER_FAULT_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	DRIVER_FAULT	R	0h	Logic OR of driver fault registers 0h = No Gate Driver fault condition is detected 1h = Gate Driver fault condition is detected
30	BK_FLT	R	0h	Buck fault Oh = No buck regulator fault condition is detected 1h = Buck regulator fault condition is detected
29	RESERVED	R	0h	Reserved
28	OCP	R	0h	Overcurrent protection status 0h = No overcurrent condition is detected 1h = Overcurrent condition is detected
27	NPOR	R	0h	Supply power on reset 0h = Power on reset condition is detected on VM 1h = No power-on-reset condition is detected on VM
26	OVP	R	0h	Supply overvoltage protection status 0h = No overvoltage condition is detected on VM 1h = Overvoltage condition is detected on VM
25	ОТ	R	0h	Overtemperature fault status 0h = No overtemperature warning / shutdown is detected 1h = Overtemperature warning / shutdown is detected
24	RESERVED	R	0h	Reserved
23	отw	R	0h	Overtemperature warning status 0h = No overtemperature warning is detected 1h = Overtemperature warning is detected
22	TSD	R	0h	Overtemperature shutdown status 0h = No overtemperature shutdown is detected 1h = Overtemperature shutdown is detected
21	OCP_HC	R	0h	Overcurrent status on high-side switch of OUTC 0h = No overcurrent detected on high-side switch of OUTC 1h = Overcurrent detected on high-side switch of OUTC



表 7-40. GATE DRIVER FAULT STATUS Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
20	OCP_LC	R	Oh	Overcurrent status on low-side switch of OUTC 0h = No overcurrent detected on low-side switch of OUTC 1h = Overcurrent detected on low-side switch of OUTC
19	OCP_HB	R	Oh	Overcurrent status on high-side switch of OUTB 0h = No overcurrent detected on high-side switch of OUTB 1h = Overcurrent detected on high-side switch of OUTB
18	OCP_LB	R	Oh	Overcurrent status on low-side switch of OUTB 0h = No overcurrent detected on low-side switch of OUTB 1h = Overcurrent detected on low-side switch of OUTB
17	OCP_HA	R	Oh	Overcurrent status on high-side switch of OUTA 0h = No overcurrent detected on high-side switch of OUTA 1h = Overcurrent detected on high-side switch of OUTA
16	OCP_LA	R	Oh	Overcurrent status on low-side switch of OUTA 0h = No overcurrent detected on low-side switch of OUTA 1h = Overcurrent detected on low-side switch of OUTA
15	RESERVED	R	0h	Reserved
14	OTP_ERR	R	Oh	One-time programmable (OTP) error 0h = No OTP error is detected 1h = OTP Error is detected
13	BUCK_OCP	R	Oh	Buck regulator overcurrent status 0h = No buck regulator overcurrent is detected 1h = Buck regulator overcurrent is detected
12	BUCK_UV	R	Oh	Buck regulator undervoltage status 0h = No buck regulator undervoltage is detected 1h = Buck regulator undervoltage is detected
11	VCP_UV	R	Oh	Charge pump undervoltage status 0h = No charge pump undervoltage is detected 1h = Charge pump undervoltage is detected
10-0	RESERVED	R	0h	Reserved

Product Folder Links: MCT8315A

Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

132

7.8.1.2 CONTROLLER_FAULT_STATUS Register (Offset = E2h) [Reset = 00000000h]

CONTROLLER_FAULT_STATUS is shown in 图 7-77 and described in 表 7-41.

Return to the Summary Table.

Status of various faults

图 7-77. CONTROLLER FAULT STATUS Register

				_	o regiote.		
31	30	29	28	27	26	25	24
CONTROLLER _FAULT	RESERVED	IPD_FREQ_FA ULT	IPD_T1_FAULT	IPD_T2_FAULT		RESERVED	
R-0h	R-0h	R-0h	R-0h	R-0h		R-0h	
23	22	21	20	19	18	17	16
ABN_SPEED	LOSS_OF_SYN C	NO_MTR	MTR_LCK	CBC_ILIMIT	LOCK_ILIMIT	MTR_UNDER_ VOLTAGE	MTR_OVER_V OLTAGE
R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h	R-0h
15	14	13	12	11	10	9	8
EXT_WD_TIME OUT				RESERVED			
R-0h				R-0h			
7	6	5	4	3	2	1	0
		RESERVED			STL_EN	STL_STATUS	APP_RESET
		R-0h			R-0h	R-0h	R-0h

表 7-41. CONTROLLER_FAULT_STATUS Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	CONTROLLER_FAULT	R	0h	Logic OR of controller fault registers 0h = No controller fault condition is detected 1h = Controller fault condition is detected
30	RESERVED	R	0h	Reserved
29	IPD_FREQ_FAULT	R	0h	Indicates IPD frequency fault 0h = No IPD frequency fault detected 1h = IPD frequency fault detected
28	IPD_T1_FAULT	R	0h	Indicates IPD T1 fault 0h = No IPD T1 fault detected 1h = IPD T1 fault detected
27	IPD_T2_FAULT	R	0h	Indicates IPD T2 fault 0h = No IPD T2 fault detected 1h = IPD T2 fault detected
26-24	RESERVED	R	0h	Reserved
23	ABN_SPEED	R	0h	Indicates abnormal speed motor lock condition 0h = No abnormal speed fault detected 1h = Abnormal Speed fault detected
22	LOSS_OF_SYNC	R	0h	Indicates sync lost motor lock condition 0h = No sync lost fault detected 1h = Sync lost fault detected
21	NO_MTR	R	0h	Indicates no motor fault 0h = No motor fault not detected 1h = No motor fault detected
20	MTR_LCK	R	0h	Indicates when one of the motor lock is triggered 0h = Motor lock fault not detected 1h = Motor lock fault detected



表 7-41. CONTROLLER FAULT STATUS Register Field Descriptions (continued)

Bit	Field	Туре	Reset	Description Descriptions (continued)
19	CBC_ILIMIT	R	0h	Indicates CBC current limit fault 0h = No CBC fault detected 1h = CBC fault detected
18	LOCK_ILIMIT	R	0h	Indicates lock detection current limit fault Oh = No lock current limit fault detected 1h = Lock current limit fault detected
17	MTR_UNDER_VOLTAGE	R	0h	Indicates motor undervoltage fault Oh = No motor undervoltage detected 1h = Motor undervoltage detected
16	MTR_OVER_VOLTAGE	R	0h	Indicates motor overvoltage fault Oh = No motor overvoltage detected 1h = Motor overvoltage detected
15	EXT_WD_TIMEOUT	R	0h	Indicates external watchdog timeout fault 0h = No external watchdog timeout fault detected 1h = External watchdog timeout fault detected
14-3	RESERVED	R	0h	Reserved
2	STL_EN	R	0h	Indicates STL is enabled in EEPROM 0h = STL Disable 1h = STL Enable
1	STL_STATUS	R	0h	Indicates STL success criteria Pass = 1b; Fail = 0b 0h = STL Fail 1h = STL Pass
0	APP_RESET	R	0h	App reset 0h = App Reset Fail 1h = App Reset Successful

7.8.2 System_Status Registers

表 7-42 lists the memory-mapped registers for the System_Status registers. All register offset addresses not listed in 表 7-42 should be considered as reserved locations and the register contents should not be modified.

表 7-42. SYSTEM_STATUS Registers

Offset	Acronym	Register Name	Section
E4h	SYS_STATUS1	System Status Register1	SYS_STATUS1 Register (Offset = E4h) [Reset = 00000000h]
EAh	SYS_STATUS2	System Status Register2	SYS_STATUS2 Register (Offset = EAh) [Reset = 00000000h]
ECh	SYS_STATUS3	System Status Register3	SYS_STATUS3 Register (Offset = ECh) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. 表 7-43 shows the codes that are used for access types in this section.

表 7-43. System_Status Access Type Codes

Access Type	Code	Description				
Read Type						
R	R	Read				
Reset or Defaul	Reset or Default Value					
-n		Value after reset or the default value				

7.8.2.1 SYS_STATUS1 Register (Offset = E4h) [Reset = 00000000h]

SYS_STATUS1 is shown in 图 7-78 and described in 表 7-44.

Return to the Summary Table.

Status of various system and motor parameters

图 7-78. SYS STATUS1 Register

		İzi	<i>1-1</i> 0. 313_31	Aloo i itogis				
31	30	29	28	27	26	25	24	
			VOLT	_MAG				
	R-0h							
23	22	21	20	19	18	17	16	
			VOLT	_MAG				
			R-	0h				
15	14	13	12	11	10	9	8	
			SPEE	D_CMD				
			R-	0h				
7	6	5	4	3	2	1	0	
			SPEED_CMD				I2C_ENTRY_S TATUS	
	R-0h							

表 7-44. SYS_STATUS1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-16	VOLT_MAG	R	0h	Applied DC input voltage (/10 to get DC input voltage in V)
15-1	SPEED_CMD	R	0h	Decoded speed command in PWM/Analog/Freq. mode (SPEED_CMD (%) = SPEED_CMD/32767 * 100%)
0	I2C_ENTRY_STATUS	R	0h	Indicates if I2C entry has happened 0h = I2C mode not entered through pin sequence 1h = I2C mode entered through pin sequence

7.8.2.2 SYS_STATUS2 Register (Offset = EAh) [Reset = 00000000h]

SYS_STATUS2 is shown in 图 7-79 and described in 表 7-45.

Return to the Summary Table.

Status of various system and motor parameters

图 7-79. SYS STATUS2 Register

		[31	<i>1-13</i> . 313_31	ATUSZ Regis	tei		
31	30	29	28	27	26	25	24
	STA	ATE			RESE	RVED	
	R-	0h			R-	·0h	
23	22	21	20	19	18	17	16
		RESE	RVED			STL_FAULT	RESERVED
		R-	0h			R-0h	R-0h
15	14	13	12	11	10	9	8
			MOTOR	_SPEED			
			R-	·0h			
7	6	5	4	3	2	1	0
			MOTOR	_SPEED			
			R-	·0h			

表 7-45. SYS_STATUS2 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-28	STATE	R	Oh	Current status of state machine; 4-bit value indicating status of state machine 0h = SYSTEM_IDLE 1h = MOTOR_START 2h = MOTOR_RUN 3h = SYSTEM_INIT 4h = MOTOR_IPD 5h = MOTOR_ALIGN 6h = MOTOR_IDLE 7h = MOTOR_STOP 8h = FAULT 9h = MOTOR_DIRECTION Ah = HALL_ALIGN Ch = MOTOR_FREEWHEEL Dh = MOTOR_BRAKE Fh = N/A
27-18	RESERVED	R	0h	Reserved
17	STL_FAULT	R	Oh	STL fault status 0h = Pass 1h = Fail
16	RESERVED	R	0h	Reserved
15-0	MOTOR_SPEED	R	0h	Speed output (/10 to get motor electrical speed in Hz)

eedback Copyright © 2023 Texas Instruments Incorporated

7.8.2.3 SYS_STATUS3 Register (Offset = ECh) [Reset = 00000000h]

SYS_STATUS3 is shown in 图 7-80 and described in 表 7-46.

Return to the Summary Table.

Status of various system and motor parameters

图 7-80. SYS_STATUS3 Register

1 30 29 28 27 26 25 24 23 22 21	1 20 19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DC_BUS_CURR											DC_	BAT	T_P	WO						
R-0h												R-	0h							

表 7-46. SYS_STATUS3 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-16	DC_BUS_CURR	R	0h	DC bus current (/256 to get DC bus current in A)
15-0	DC_BATT_POW	R	0h	Battery (input) power (/64 to get battery power in W)

7.8.3 Algo_Control Registers

表 7-47 lists the memory-mapped registers for the Algo_Control registers. All register offset addresses not listed in 表 7-47 should be considered as reserved locations and the register contents should not be modified.

表 7-47. ALGO_CONTROL Registers

Offset	Acronym	Register Name	Section
E6h	ALGO_CTRL1	Algorithm Control Parameters	ALGO_CTRL1 Register (Offset = E6h) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-48 shows the codes that are used for access types in this section.

表 7-48. Algo Control Access Type Codes

7 7 40. Aigo_control Access Type codes							
Access Type	Code	Description					
Write Type							
W		Write					
Reset or Defaul	Reset or Default Value						
-n		Value after reset or the default value					

English Data Sheet: SLLSFP7

7.8.3.1 ALGO_CTRL1 Register (Offset = E6h) [Reset = 00000000h]

ALGO_CTRL1 is shown in 图 7-81 and described in 表 7-49.

Return to the Summary Table.

Algorithm Control Parameters

图 7-81. ALGO CTRL1 Register

	图 7-01. ALGO_CTRET Register								
31	30	29	28	27	26	25	24		
EEPROM_WRT	EEPROM_REA D	CLR_FLT	CLR_FLT_RET RY_COUNT		EEPROM_WRITE	_ACCESS_KE	Υ		
W-0h	W-0h	W-0h	W-0h		W-	0h			
23	22	21	20	19	18	17	16		
	EEPROM_WRITE	_ACCESS_KEY	,		RESE	RVED			
	W-	0h		W-0h					
15	14	13	12	11	10	9	8		
			RESE	RVED					
			W-	0h					
7	6	5	4	3	2	1	0		
			RESERVED				EXT_WD_STAT US_SET		
			W-0h				W-0h		

表 7-49. ALGO_CTRL1 Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	EEPROM_WRT	W	0h	Write the configuration to EEPROM 1h = Write to the EEPROM registers from shadow registers
30	EEPROM_READ	W	0h	Read the default configuration from EEPROM 1h = Read the EEPROM registers to shadow registers
29	CLR_FLT	W	0h	Clears all faults 1h = Clear all the driver and controller faults
28	CLR_FLT_RETRY_COUN T	W	0h	Clears fault retry count 1h = clear the lock fault retry counts
27-20	EEPROM_WRITE_ACCE SS_KEY	W	0h	EEPROM write access key; 8-bit key to unlock the EEPROM write command
19-1	RESERVED	W	0h	Reserved
0	EXT_WD_STATUS_SET	W	Oh	Watchdog status to be set by external MCU in I2C watchdog mode 0h = Reset automatically by the MCC 1h = To set the EXT_WD_STATUS_SET

7.8.4 Device_Control Registers

表 7-50 lists the memory-mapped registers for the Device_Control registers. All register offset addresses not listed in 表 7-50 should be considered as reserved locations and the register contents should not be modified.

表 7-50. DEVICE_CONTROL Registers

Offset	Acronym	Register Name	Section
E8h	DEVICE_CTRL	Device Control Parameters	DEVICE_CTRL Register (Offset = E8h) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-51 shows the codes that are used for access types in this section.

138 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated

表 7-51. Device_Control Access Type Codes

Access Type	Code	Description				
Read Type						
R	R	Read				
Write Type						
W	W	Write				
Reset or Defaul	t Value					
-n		Value after reset or the default value				

7.8.4.1 DEVICE_CTRL Register (Offset = E8h) [Reset = 00000000h]

DEVICE_CTRL is shown in 图 7-82 and described in 表 7-52.

Return to the Summary Table.

Device Control Parameters

图 7-82. DEVICE CTRL Register

		izi	1-02. DEVICE	_CTAL Regis	te:				
31	30	29	28	27	26	25	24		
RESERVED				SPEED_CTRL					
W-0h		W-0h							
23	22	21	20	19	18	17	16		
	SPEED_CTRL								
W-0h									
15	14	13	12	11	10	9	8		
OVERRIDE				RESERVED					
W-0h				R-0h					
7	6	5	4	3	2	1	0		
			RESE	RVED					
			R-	0h					

表 7-52. DEVICE_CTRL Register Field Descriptions

Bit	Field	Туре	Reset	Description
31	RESERVED	W	0h	Reserved
30-16	SPEED_CTRL	W	0h	Digital speed command (SPEED_CTRL (%) = SPEED_CTRL/32767 * 100%)
15	OVERRIDE	W	0h	Speed input select for I2C vs speed pin 0h = SPEED_CMD using Analog/Freq/PWM mode 1h = SPEED_CMD using SPD_CTRL[14:0]
14-0	RESERVED	R	0h	Reserved

7.8.5 Algorithm_Variables Registers

表 7-53 lists the memory-mapped registers for the Algorithm_Variables registers. All register offset addresses not listed in 表 7-53 should be considered as reserved locations and the register contents should not be modified.

表 7-53. ALGORITHM_VARIABLES Registers

		X / OU. ALGOINITIM_VAINABI	
Offset	Acronym	Register Name	Section
40Ch	INPUT_DUTY	Input Duty Cycle	INPUT_DUTY Register (Offset = 40Ch) [Reset = 00000000h]
4F6h	CURRENT_DUTY	Current Duty Cycle	CURRENT_DUTY Register (Offset = 4F6h) [Reset = 00000000h]
506h	SET_DUTY	Set Duty Cycle	SET_DUTY Register (Offset = 506h) [Reset = 00000000h]
5B2h	MOTOR_SPEED_PU	Motor Speed in PU	MOTOR_SPEED_PU Register (Offset = 5B2h) [Reset = 00000000h]
6F4h	DC_BUS_POWER_PU	DC Bus Power in PU	DC_BUS_POWER_PU Register (Offset = 6F4h) [Reset = 00000000h]

Complex bit access types are encoded to fit into small table cells. $\frac{1}{2}$ 7-54 shows the codes that are used for access types in this section.

140 Submit Document Feedback

Copyright © 2023 Texas Instruments Incorporated



表 7-54. Algorithm_Variables Access Type Codes

Access Type	Code	Description									
Read Type											
R	R	Read									
Reset or Default Value											
-n		Value after reset or the default value									



7.8.5.1 INPUT_DUTY Register (Offset = 40Ch) [Reset = 00000000h]

INPUT_DUTY is shown in 图 7-83 and described in 表 7-55.

Return to the Summary Table.

Input duty cycle from SPEED pin or SPEED_CMD (Input duty cycle(in %) = (Measured voltage on DAC pin) / 3V *100)

图 7-83. INPUT_DUTY Register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	INPUT_DUTY																														
	R-0h																														

表 7-55. INPUT_DUTY Register Field Descriptions

Bit	Field	Туре	Reset	Description							
31-0	INPUT_DUTY	R		32-bit value indicating the duty cycle that the user commands Input duty cycle (in %) = (Input Duty Cycle / 2^{30}) * 100							

Product Folder Links: MCT8315A

English Data Sheet: SLLSFP7

7.8.5.2 CURRENT_DUTY Register (Offset = 4F6h) [Reset = 00000000h]

CURRENT_DUTY is shown in 图 7-84 and described in 表 7-56.

Return to the Summary Table.

Current duty cycle (Current duty cycle(in %) = (Measured voltage on DAC pin) / 3V *100)

图 7-84. CURRENT_DUTY Register

31	31 30 29 28 27 26 25 24 23 22 21 20 19 18 17 16 15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0												
	CURRENT_DUTY												
	R-0h												

表 7-56. CURRENT_DUTY Register Field Descriptions

Bit	Field	Туре	Reset	Description							
31-0	CURRENT_DUTY	R		32-bit value indicating the duty cycle that is currently being applied. Current duty cycle (in %) = (Current Duty Cycle / 2 ³⁰) * 100							



7.8.5.3 SET_DUTY Register (Offset = 506h) [Reset = 00000000h]

SET_DUTY is shown in 图 7-85 and described in 表 7-57.

Return to the Summary Table.

Target duty cycle (Set duty cycle(in %) = (Measured voltage on DAC pin) / 3V *100)

图 7-85. SET_DUTY Register

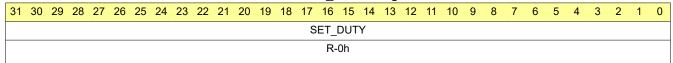


表 7-57. SET_DUTY Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-0	SET_DUTY	R		32-bit value indicating the duty cycle that the FW wants. Set duty cycle (in %) = (Set Duty Cycle / 2^{30}) * 100

7.8.5.4 MOTOR_SPEED_PU Register (Offset = 5B2h) [Reset = 00000000h]

MOTOR_SPEED_PU is shown in 图 7-86 and described in 表 7-58.

Return to the Summary Table.

Motor speed in PU (Motor speed (in Hz) = (Measured voltage on DAC pin) / 3V * Maximum speed (in Hz)) Maximum speed (in Hz) = MAX_SPEED/16

图 7-86. MOTOR_SPEED_PU Register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	MOTOR_SPEED_PU																														
	R-0h																														

表 7-58. MOTOR_SPEED_PU Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-0	MOTOR_SPEED_PU	R		32-bit value indicating the speed of the motor. Motor speed (in Hz) = (Motor Speed in PU / 2 ³⁰) * (MAX_SPEED / 16)



7.8.5.5 DC_BUS_POWER_PU Register (Offset = 6F4h) [Reset = 00000000h]

DC_BUS_POWER_PU is shown in 图 7-87 and described in 表 7-59.

Return to the Summary Table.

DC bus power in PU (DC bus power(in W) = (Measured voltage on DAC pin) / 3V * Maximum power(in W)) Maximum power (in W) = MAX_POWER/4

图 7-87. DC_BUS_POWER_PU Register

31	30	29	28	27	26	25	24	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	DC_BUS_POWER_PU																														
	R-0h																														

表 7-59. DC_BUS_POWER_PU Register Field Descriptions

Bit	Field	Туре	Reset	Description
31-0	DC_BUS_POWER_PU	R		32-bit value indicating the power drawn by the motor. DC Bus Power (in W) = (DC Bus Power in PU / 2^{30}) * (MAX_POWER / 4)

8 Application and Implementation

备注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The MCT8315A device is used in sensorless 3-phase BLDC motor control. The driver provides a high performance, high-reliability, flexible solution for robotic vacuum, fuel pumps, automotive fans and blowers, medical CPAP blowers etc., The following section shows a common application of the MCT8315A device.

8.2 Typical Applications

8-1 shows the typical schematic of MCT8315A.

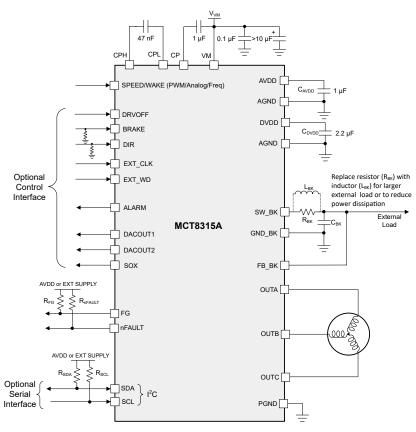


图 8-1. Primary Application Schematic

 ${\color{red}{\,\overline{\!\mathcal{R}}}}$ 8-1 lists the recommended values of the external components for MCT8315A.

表 8-1. MCT8315A External Components

COMPONENTS	PIN 1	PIN 2	RECOMMENDED
C _{VM1}	VM	PGND	X5R or X7R, 0.1-µF, TI recommends a capacitor voltage rating at least twice the normal operating voltage of the device
C _{VM2}	VM	PGND	≥ 10-µF, TI recommends a capacitor voltage rating at least twice the normal operating voltage of the device

Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback

147



表 8-1. MCT8315A External Components (continued)

COMPONENTS	PIN 1	PIN 2	RECOMMENDED
C _{CP}	СР	VM	X5R or X7R, 16-V, 1-μF capacitor
C _{FLY}	СРН	CPL	X5R or X7R, 47-nF, TI recommends a capacitor voltage rating at least twice the normal operating voltage of the pin
C _{AVDD}	AVDD	AGND	X5R or X7R, 1-μF, ≥ 6.3-V. In order for AVDD to accurately regulate output voltage, capacitor should have effective capacitance between 0.7-μF to 1.3-μF at 3.3-V across operating temperature.
C _{DVDD}	DVDD	DGND	X5R or X7R, 2.2-μF, ≥ 6.3-V. In order for DVDD to accurately regulate output voltage, capacitor should have effective capacitance between 1.1-μF to 2.5-μF at 1.5-V across operating temperature.
C _{BK}	FB_BK	GND_BK	X5R or X7R, buck-output rated capacitor
L _{BK}	SW_BK	FB_BK	Buck-output inductor
R _{FG}	1.8 to 5-V Supply	FG	5.1-k Ω , Pull-up resistor
R _{nFAULT}	1.8 to 5-V Supply	nFAULT	5.1-k Ω , Pull-up resistor
R _{SDA}	1.8 to 3.3-V Supply	SDA	5.1-k Ω , Pull-up resistor
R _{SCL}	1.8 to 3.3-V Supply	SCL	5.1-k Ω , Pull-up resistor

Recommended application range for MCT8315A is shown in 表 8-2.

表 8-2. Recommended Application Range

Parameter	Min	Max	Unit
Motor voltage	4.5	35	V
Motor electrical speed	-	3000	Hz
Peak motor phase current	-	4	A

Default EEPROM configuration for MCT8315A is listed in 表 8-3. Default values are chosen for reliable motor start-up and closed loop operation. Refer to MCT8315A tuning guide which provides step by step procedure to tune a 3-phase BLDC motor in closed loop, conform to use-case and explore features in the device.

表 8-3. Recommended Default Values

Address Name	Address	Recommended Value
ISD_CONFIG	0x00000080	0x6EC4C100
MOTOR_STARTUP1	0x00000082	0x2EA610E4
MOTOR_STARTUP2	0x00000084	0x1221109C
CLOSED_LOOP1	0x00000086	0x0C321200
CLOSED_LOOP2	0x00000088	0x024224B0
CLOSED_LOOP3	0x0000008A	0x4CCC03E0
CLOSED_LOOP4	0x0000008C	0x000CE944
CONST_SPEED	0x0000008E	0x00A00510
CONST_PWR	0x00000090	0x5DC04C84
FAULT_CONFIG1	0x00000092	0x60F43025
FAULT_CONFIG2	0x00000094	0x7F87A009
TRAP_CONFIG1	0x0000009A	0x0548A186
TRAP_CONFIG2	0x0000009C	0x3A840000
150_DEG_TWO_PH_PROFILE	0x00000096	0x6ADB44A6
150_DEG_THREE_PH_PROFILE	0x00000098	0x392DFF80
PIN_CONFIG1	0x000000A4	0x2D720600

Submit Document Feedback

表 8-3. Recommended Default Values	(continued)
-----------------------------------	-------------

•••		
PIN_CONFIG2	0x00000A6	0x08000000
DEVICE_CONFIG	0x000000A8	0x7FFF0000
PERIPH_CONFIG	0x000000AA	0x00000000
GD_CONFIG1	0x000000AC	0x1C440000
GD_CONFIG2	0x000000AE	0x0000000

Once the device EEPROM is programmed with the desired configuration, device can be operated stand-alone and I²C serial interface is not required anymore. Speed can be commanded using SPEED pin.

Below are the two essential parameters that are required to spin the motor in closed loop.

- 1. Maximum motor speed.
- 2. Cycle by cycle (CBC) current limit.

8.2.1 Application curves

8.2.1.1 Motor startup

⊗ 8-2 shows the phase current waveforms of various startup methods in MCT8315A such as align, double align, IPD and slow first cycle.

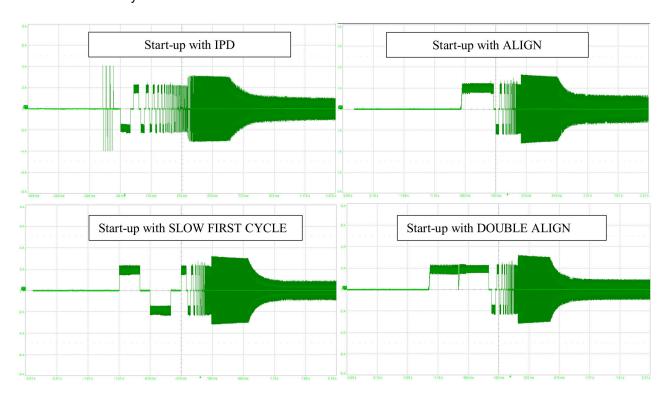


图 8-2. Motor phase current waveforms of all startup methods

8.2.1.2 120° and variable commutation

In 120° commutation scheme, each motor phase is driven for 120° and Hi-Z for 60° within each half electrical cycle, resulting in six different commutation states for a motor.

8-3 shows the phase current and current waveform FFT in 120° commutation mode. In variable commutation scheme, MCT8315A device switches dynamically between 120° and 150° trapezoidal commutation depending on motor speed. The device operates



in 150° mode at lower speeds and moves to 120° mode at higher speeds. ☒ 8-4 shows the phase current and current waveform FFT in 150° commutation.

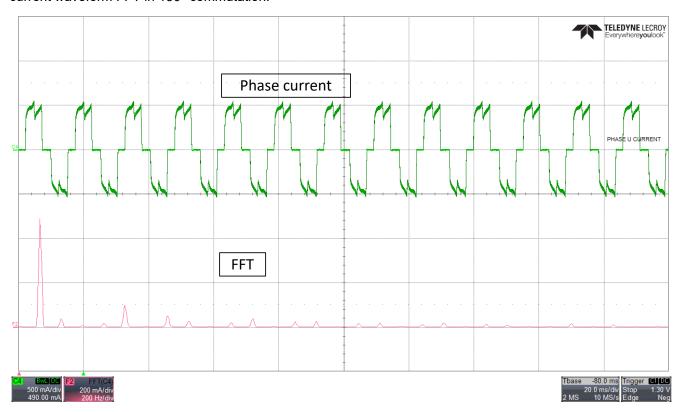


图 8-3. Phase current and FFT - 120 °commutation

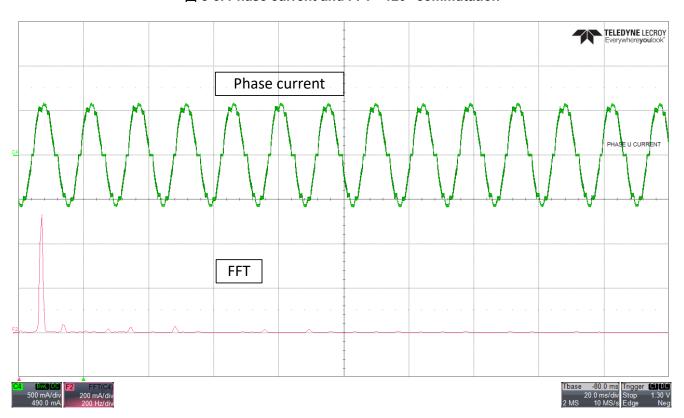


图 8-4. Phase current and FFT - 150°commutation

Product Folder Links: MCT8315A

8.2.1.3 Faster startup time

Startup time is the time taken for the motor to reach the target speed from zero speed. Faster startup time can be achieved in MCT8315A by tuning motor startup, open loop and closed loop settings. 图 8-5 shows FG, phase current and motor electrical speed waveform. Motor takes 50 ms to reach target speed from zero speed.

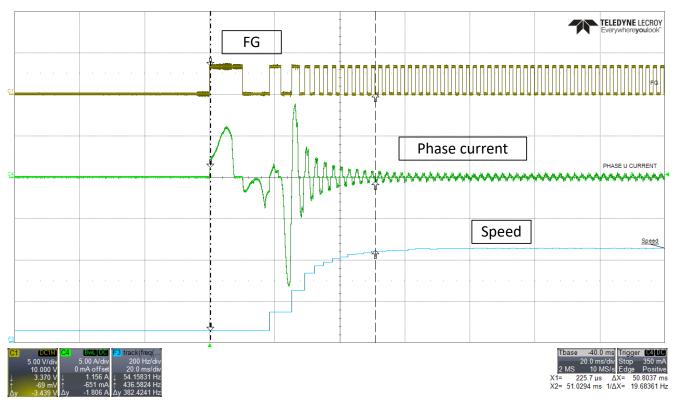


图 8-5. Phase current, FG and motor speed - Faster startup time

8.2.1.4 Setting the BEMF threshold

The BEMF_THRESHOLD1 and BEMF_THRESHOLD2 values used for commutation instant detection in MCT8315A can be computed from the motor phase voltage waveforms during coasting. For example, consider the three-phase voltage waveforms of a BLDC motor while coasting as in ☒ 8-6. The motor phase voltage during coasting is the motor back-EMF.

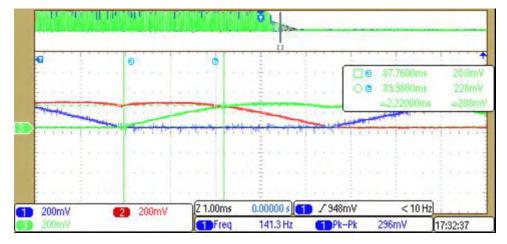


图 8-6. Motor phase voltage during coasting



In 🖺 8-6, one floating phase voltage interval is denoted by the vertical markers on channel 3. The Vpeak (peak-peak back-EMF) on channel 3 is 208-mV and Tc (commutation interval) is 2.22-ms as denoted by the horizontal and vertical markers on channel 3. The digital equivalent counts for Vpeak and Tc are calculated as follows.

In MCT8315A, a 3-V analog input corresponds to 4095 counts(12-bit) and phase voltage is scaled down by 10x factor before ADC input; therfore, Vpeak of 208-mV corresponds to an ADC input of 20.8mV, which in turn equals 29 ADC counts. Assuming the PWM switching frequency is 25-kHz, one back-EMF sample is available every 40- μ s. So, in a time interval of 2.22-ms, a total of 55 back-EMF samples are integrated. Therefore, the BEMF_THRESHOLD1 or BEMF_THRESHOLD2 value calculated as per 方程式 7 is (½) * (29/2) * (55/2) = 199. Hence, in this example, BEMF_THRESHOLD1 and BEMF_THRESHOLD2 are set to 8h (corresponding to 200 which is the closest value to 199) for commutation instant detection using back-EMF integration method during fast start-up. The exact speed at which the Vpeak and Tc values are measured to calculate the BEMF_THRESHOLD1 and BEMF_THRESHOLD2 values is not critical (as long as there is sufficient resolution in digital counts) since the product (Vpeak * Tc) is, largely, a constant for a given BLDC motor.

8.2.1.5 Maximum speed

⊗ 8-7 shows phase current, phase voltage and FG of a motor that spins at maximum electrical speed of 3 kHz.

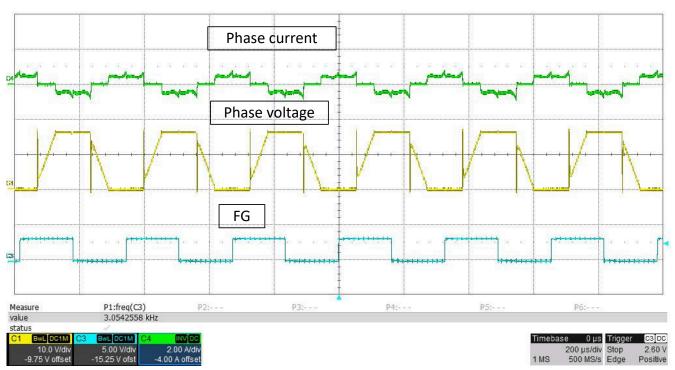


图 8-7. Phase current, Phase voltage and FG at Maximum speed

8.2.1.6 Faster deceleration

MCT8315A has features to decelerate the motor quickly. 8-8 shows phase current and motor electrical speed waveform when the motor decelerates from 100% duty cycle to 10% duty cycle. Time taken for the motor to decelerate from 100% duty cycle to 10% duty cycle when fast deceleration is disabled is around 10 seconds. 8-9 shows phase current and motor electrical speed waveform when the motor decelerates from 100% duty cycle to 10% duty cycle. Time taken for the motor to decelerate from 100% duty cycle to 10% duty cycle when fast deceleration is enabled is around 1.5 seconds.

Product Folder Links: MCT8315A

备注

Please note that when fast deceleration is enabled and anti-voltage surge (AVS) is disabled, there might be voltage spikes seen in supply voltage. Enable AVS to protect the power supply from voltage overshoots during motor deceleration.

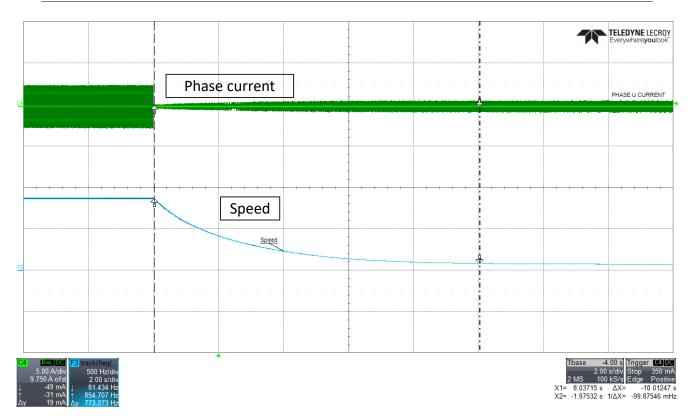


图 8-8. Phase current and motor speed - Faster deceleration disabled



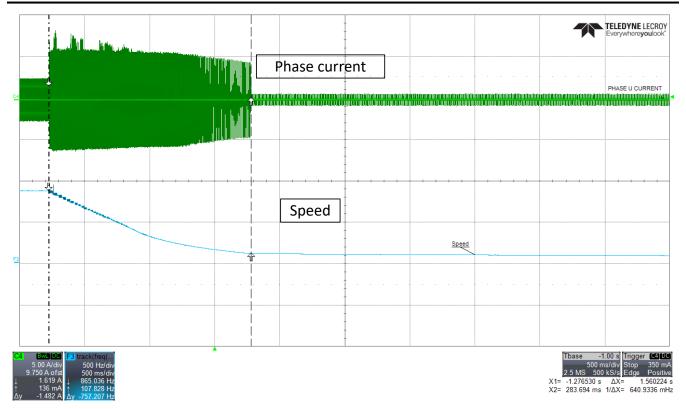


图 8-9. Phase current and motor speed -Faster deceleration enabled

9 Power Supply Recommendations

9.1 Bulk Capacitance

Having an appropriate local bulk capacitance is an important factor in motor drive system design. It is generally beneficial to have more bulk capacitance, while the disadvantages are increased cost and physical size.

The amount of local capacitance needed depends on a variety of factors, including:

- · The highest current required by the motor system
- · The capacitance and current capability of the power supply
- · The amount of parasitic inductance between the power supply and motor system
- The acceptable voltage ripple
- The type of motor used (brushed DC, brushless DC, stepper)
- · The motor braking method

The inductance between the power supply and the motor drive system limits the rate at which current can change from the power supply. If the local bulk capacitance is too small, the system responds to excessive current demands or dumps from the motor with a change in VM voltage. When adequate bulk capacitance is used, the VM voltage remains stable and high current can be quickly supplied.

The data sheet generally provides a recommended value, but system-level testing is required to determine the appropriate bulk capacitor.

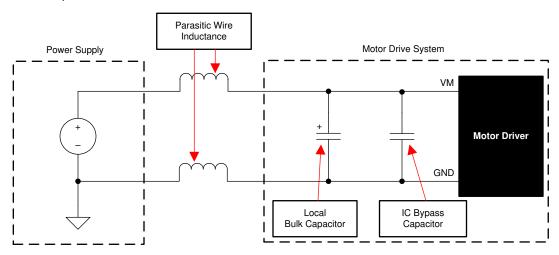


图 9-1. Example Setup of Motor Drive System With External Power Supply

The voltage rating for bulk capacitors should be higher than the operating voltage, to provide margin for cases when the motor transfers energy to the supply.

10 Layout

10.1 Layout Guidelines

The bulk capacitor should be placed to minimize the distance of the high-current path through the motor driver device. The connecting metal trace widths should be as wide as possible, and numerous vias should be used when connecting PCB layers. These practices minimize parasitic inductance and allow the bulk capacitor to deliver high current.

Small-value capacitors should be ceramic, and placed closely to device pins.

The high-current device outputs should use wide metal traces.

To reduce noise coupling and EMI interference from large transient currents into small-current signal paths, grounding should be partitioned between PGND and AGND. TI recommends connecting all non-power stage circuitry (including the thermal pad) to AGND to reduce parasitic effects and improve power dissipation from the device. Optionally, GND_BK can be split. Ensure grounds are connected through net-ties or wide resistors to reduce voltage offsets and maintain gate driver performance.

The device thermal pad should be soldered to the PCB top-layer ground plane. Multiple vias should be used to connect to a large bottom-layer ground plane. The use of large metal planes and multiple vias helps dissipate the $I^2 \times R_{DS(on)}$ heat that is generated in the device.

To improve thermal performance, maximize the ground area that is connected to the thermal pad ground across all possible layers of the PCB. Using thick copper pours can lower the junction-to-air thermal resistance and improve thermal dissipation from the die surface.

Separate the SW_BK and FB_BK traces with ground separation to reduce buck switching from coupling as noise into the buck outer feedback loop. Widen the FB_BK trace as much as possible to allow for faster load switching.

Product Folder Links: MCT8315A

10.2 Layout Example

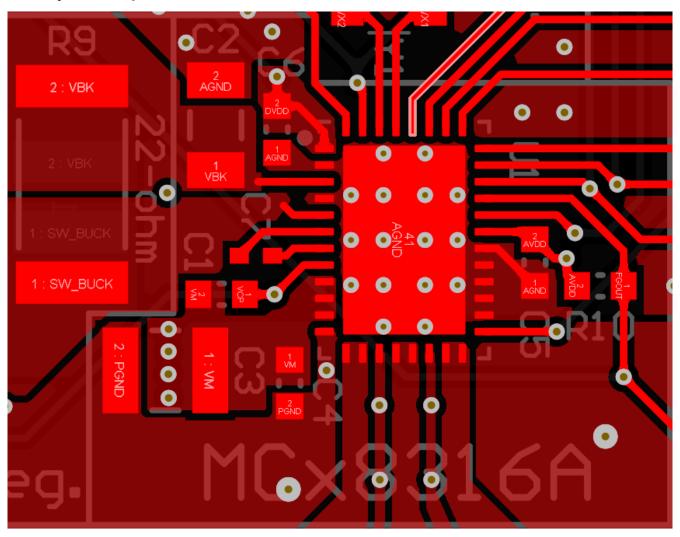


图 10-1. Recommended Layout Example



10.3 Thermal Considerations

The MCT8315A has thermal shutdown (TSD) as previously described. A die temperature in excess of 150°C (minimally) disables the device until the temperature drops to a safe level.

Any tendency of the device to enter thermal shutdown is an indication of excessive power dissipation, insufficient heatsinking, or too high an ambient temperature.

10.3.1 Power Dissipation

The power dissipated in the output FET resistance (R_{DS(on)}) dominates power dissipation in MCT8315A.

At start-up and fault conditions, the FET current is much higher than normal operating FET current; remember to take these peak currents and their duration into consideration.

The total device power dissipation is the power dissipated in each of the three half-bridges added together along with standby power, LDO and buck regulator losses.

The maximum amount of power that the device can dissipate depends on ambient temperature and heatsinking.

Note that $R_{DS(on)}$ increases with temperature, so as the device heats, the power dissipation increases. Take this into consideration when sizing the heatsink.

A summary of equations for calculating each loss is shown below in 表 10-1.

表 10-1. Power Losses for MCT8315A

Loss type	MCT8315A
Standby power	P _{standby} = VM x I _{VM_TA}
LDO	$P_{LDO} = (VM-V_{AVDD}) \times I_{AVDD}$, if BUCK_PS_DIS = 1b $P_{LDO} = (V_{BK}-V_{AVDD}) \times I_{AVDD}$, if BUCK_PS_DIS = 0b
FET conduction	$P_{CON} = 2 \times (I_{RMS(trap)})^2 \times R_{ds,on(TA)}$
FET switching	$P_{SW} = I_{PK(trap)} \times V_{PK(trap)} \times t_{rise/fall} \times f_{PWM}$
Diode	$P_{diode} = I_{PK(trap)} \times V_{diode} \times t_{dead} \times f_{PWM}$
Demagnetization	Without Active Demag: 3 x I _{PK(trap)} x V _{diode} x t _{commutation} x f _{motor_elec} With Active Demag: 3 x (I _{RMS(trap)}) ² x R _{ds,on(TA)} x t _{commutation} x f _{motor_elec}
Buck	P _{BK} = 0.11 x V _{BK} x I _{BK} (η _{BK} = 90%)

Product Folder Links: MCT8315A

11 Device and Documentation Support

11.1 支持资源

TI E2E[™] 支持论坛是工程师的重要参考资料,可直接从专家获得快速、经过验证的解答和设计帮助。搜索现有解答或提出自己的问题可获得所需的快速设计帮助。

链接的内容由各个贡献者"按原样"提供。这些内容并不构成 TI 技术规范,并且不一定反映 TI 的观点;请参阅 TI 的《使用条款》。

11.2 Trademarks

TI E2E[™] is a trademark of Texas Instruments.

所有商标均为其各自所有者的财产。

11.3 静电放电警告



静电放电 (ESD) 会损坏这个集成电路。德州仪器 (TI) 建议通过适当的预防措施处理所有集成电路。如果不遵守正确的处理和安装程序,可能会损坏集成电路。

ESD 的损坏小至导致微小的性能降级,大至整个器件故障。精密的集成电路可能更容易受到损坏,这是因为非常细微的参数更改都可能会导致器件与其发布的规格不相符。

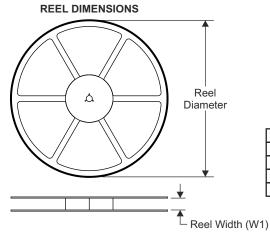
11.4 术语表

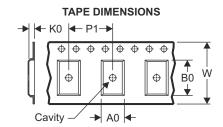
TI术语表本术语表列出并解释了术语、首字母缩略词和定义。

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most-current data available for the designated device. This data is subject to change without notice and without revision of this document. For browser-based versions of this data sheet, see the left-hand navigation pane.

12.1 Tape and Reel Information

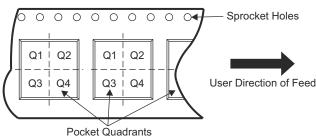




- A0 Dimension designed to accommodate the component width
- B0 Dimension designed to accommodate the component length
- K0 Dimension designed to accommodate the component thickness
- W Overall width of the carrier tape
- P1 Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

Product Folder Links: MCT8315A

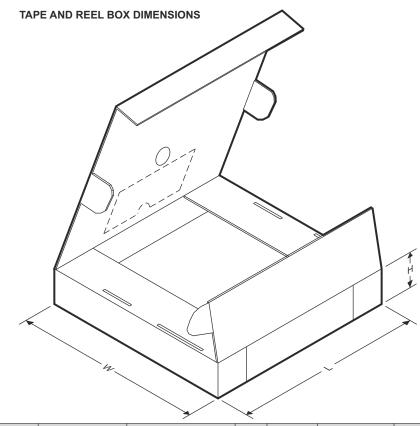


Copyright © 2023 Texas Instruments Incorporated

Submit Document Feedback



Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MCT8315A1VRGFR	VQFN	RGF	40	3000	330.0	16.4	5.25	7.25	1.45	8.0	16.0	Q1



Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
MCT8315A1VRGFR	VQFN	RGF	40	3000	367.0	367.0	38.0

English Data Sheet: SLLSFP7



www.ti.com 22-May-2023

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
MCT8315A1VRGFR	ACTIVE	VQFN	RGF	40	3000	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 125	MCT83 15A1V	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

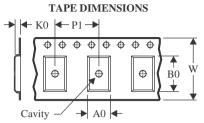
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

www.ti.com 22-May-2023

TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

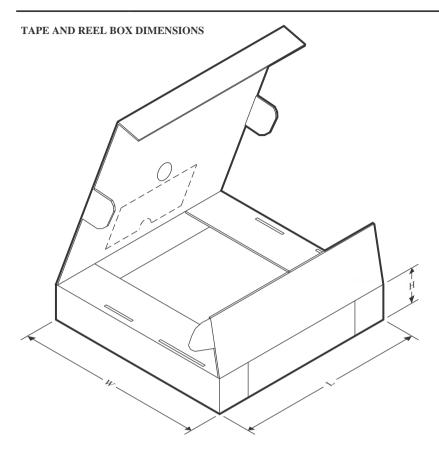
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
MCT8315A1VRGFR	VQFN	RGF	40	3000	330.0	16.4	5.25	7.25	1.45	8.0	16.0	Q1

www.ti.com 22-May-2023



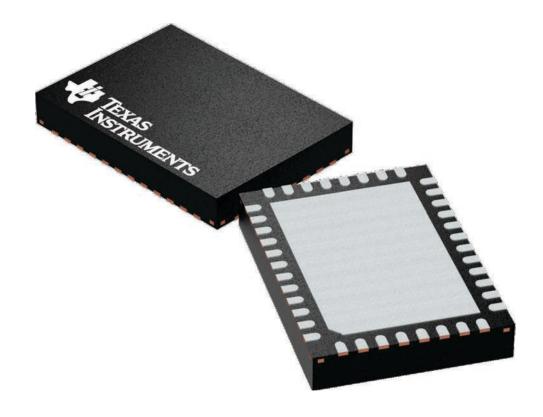
*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	MCT8315A1VRGFR	VQFN	RGF	40	3000	367.0	367.0	35.0	

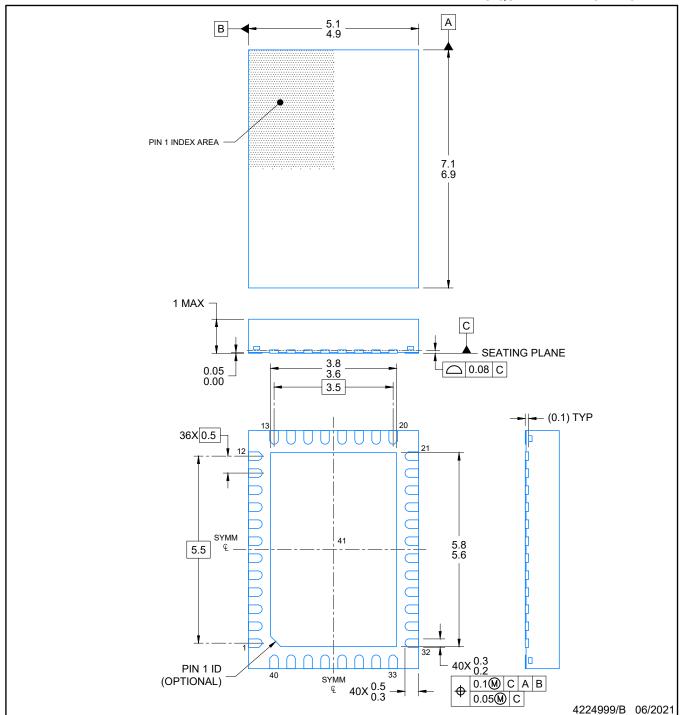
5 x 7, 0.5 mm pitch

PLASTIC QUAD FLAT PACK- NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



PLASTIC QUAD FLAT PACK- NO LEAD

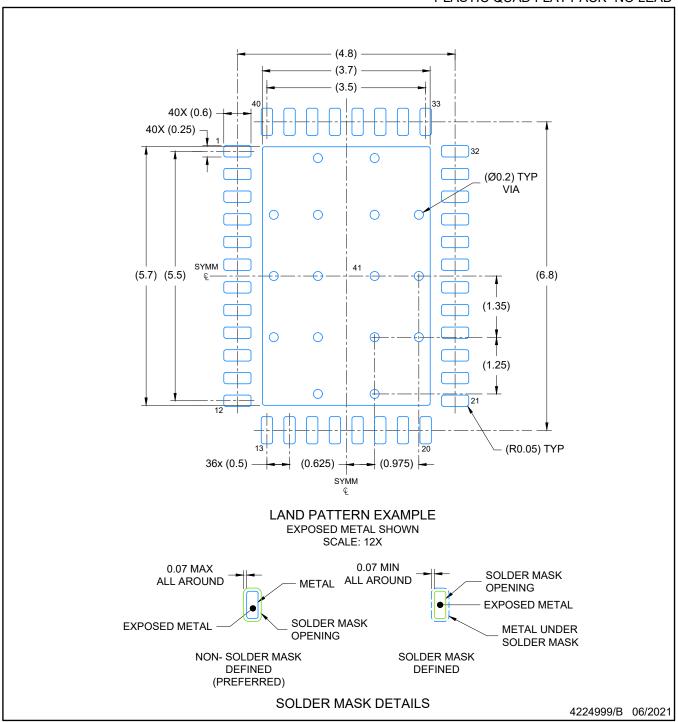


NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.



PLASTIC QUAD FLAT PACK- NO LEAD

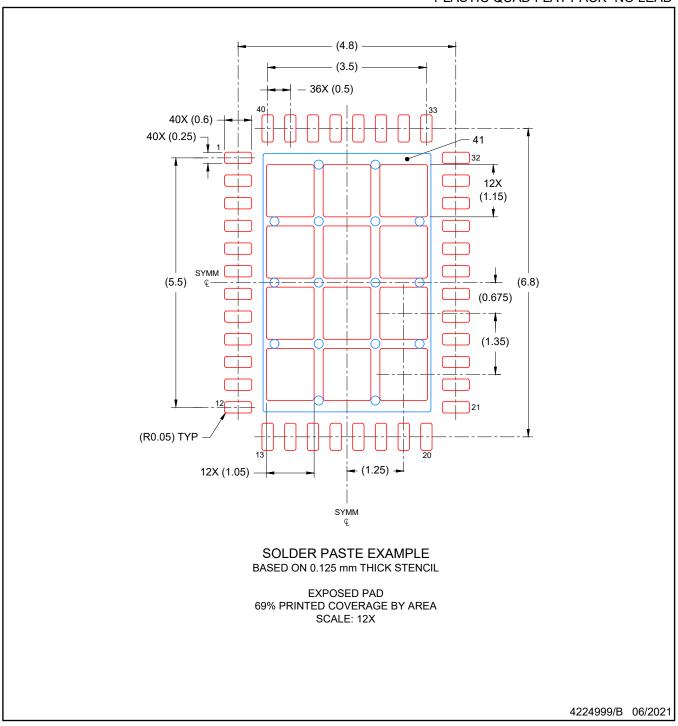


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLAT PACK- NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



重要声明和免责声明

TI"按原样"提供技术和可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源,不保证没有瑕疵且不做出任何明示或暗示的担保,包括但不限于对适销性、某特定用途方面的适用性或不侵犯任何第三方知识产权的暗示担保。

这些资源可供使用 TI 产品进行设计的熟练开发人员使用。您将自行承担以下全部责任:(1) 针对您的应用选择合适的 TI 产品,(2) 设计、验证并测试您的应用,(3) 确保您的应用满足相应标准以及任何其他功能安全、信息安全、监管或其他要求。

这些资源如有变更,恕不另行通知。TI 授权您仅可将这些资源用于研发本资源所述的 TI 产品的应用。严禁对这些资源进行其他复制或展示。您无权使用任何其他 TI 知识产权或任何第三方知识产权。您应全额赔偿因在这些资源的使用中对 TI 及其代表造成的任何索赔、损害、成本、损失和债务,TI 对此概不负责。

TI 提供的产品受 TI 的销售条款或 ti.com 上其他适用条款/TI 产品随附的其他适用条款的约束。TI 提供这些资源并不会扩展或以其他方式更改 TI 针对 TI 产品发布的适用的担保或担保免责声明。

TI 反对并拒绝您可能提出的任何其他或不同的条款。

邮寄地址: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2023,德州仪器 (TI) 公司